

Device TC37xEXT
Marking/Step (E)ES-AB, AB
Package see Data Sheet

10297AERRA

This Errata Sheet describes the deviations from the current user documentation.

Table 1 Current Documentation¹⁾

AURIX™ TC3xx User's Manual	V1.2.0	2019-04
AURIX™ TC37xEXT Appendix to User's Manual	V1.2.0	2019-04
TC37xEXT AB-Step Data Sheet	V1.1	2021-03
TriCore TC1.6.2 Core Architecture Manual:		
- Core Architecture (Vol. 1)	V1.2.2	2020-01-15
- Instruction Set (Vol. 2)	V1.2.2	2020-01-15
AURIX™ TC3xx ED Target Specification ²⁾	V2.8.0	2019-05
AURIX™ TC3xx Safety Manual	V1.05	E10/19

1) Newer versions replace older versions, unless specifically noted otherwise.

2) Distribution under NDA, only relevant for tool development not for application development.

Make sure you always use the corresponding documentation for this device (User's Manual, Data Sheet, Documentation Addendum (if applicable), TriCore Architecture Manual, Errata Sheet) available in category 'Documents' at www.infineon.com/AURIX and www.myInfineon.com.

Conventions used in this document

Each erratum identifier follows the pattern **Module_Arch.TypeNumber**:

- **Module:** subsystem, peripheral, or function affected by the erratum
- **Arch:** microcontroller architecture where the erratum was initially detected
 - **AI:** Architecture Independent
 - **TC:** TriCore
- **Type:** category of deviation
 - **[none]:** Functional Deviation
 - **P:** Parametric Deviation
 - **H:** Application Hint
 - **D:** Documentation Update
- **Number:** ascending sequential number within the three previous fields. As this sequence is used over several derivatives, including already solved deviations, gaps inside this enumeration can occur.

Notes

1. This Errata Sheet applies to all temperature and frequency versions and to all memory size variants, unless explicitly noted otherwise. For a synopsis of the available variants, see the latest Data Sheet/User's Manual and the addendum "AURIX™ TC3x Variants" of the corresponding TC3x device. This Errata Sheet covers several device versions. If an issue is related to a particular module, and this module is not specified for a specific device version, this issue does not apply to this device version.
E.g. issues with identifier "EBU" do not apply to devices where no EBU is specified, and issues with identifier "RIF" only apply to "ADAS" devices.
2. Devices marked with EES or ES are engineering samples which may not be completely tested in all functional and electrical characteristics, therefore they should be used for evaluation only.
The specific test conditions for EES and ES are documented in a separate Status Sheet.
3. Some of the errata have workarounds which are possibly supported by the tool vendors. Some corresponding compiler switches need possibly to be set. Please see the respective documentation of your compiler.
For effects of issues related to the on-chip debug system, see also the documentation of the debug tool vendor.

1 History List / Change Summary

Table 2 History List

Version	Date	Remark
1.0	2019-03-29	This is the first version for TC37xEXT step AB
1.1	2019-07-19	Update: <ul style="list-style-type: none"> • New/updated text modules see column “Change” in tables 4..6 of errata sheet V1.1 • Removed: <ul style="list-style-type: none"> – SRI_TC.H002 (CPU Accesses from PFlash: Stall cycles for local and SRI resources - Documentation update): corrected in table “CPU Accesses: Stall cycles for local and SRI resources” in the CPU chapter of TC3xx User’s Manual V1.1.0 and following
1.2	2019-12-02	Update: <ul style="list-style-type: none"> • New/updated text modules see column “Change” in tables 4..6 of errata sheet V1.2 • Removed: <ul style="list-style-type: none"> – CCU_TC.H013 (Field SHBY in register OSCCON - Documentation Update): updated description of OSCCON.SHBY in TC3xx User’s Manual V1.1.0 and following – CCU_TC.H014 (System Reset value of CCUCON0; Clock Ramp Example - Documentation Updates): updated CCUCON0 description in TC3xx User’s Manual V1.1.0 and following

Table 2 History List (cont'd)

Version	Date	Remark
1.2	...	<p>... continued:</p> <ul style="list-style-type: none"> Removed: <ul style="list-style-type: none"> CPU_TC.H017 (MSUB.Q does not match MUL.Q+SUB.Q - Documentation Update): updated description in TriCore TC1.6.2 Core Architecture Manual V1.1, Vol. 2 Instruction Set FLASH_TC.H017 (UCB_SWAP MARKERHx and CONFIRMATIONHx - Documentation Update): updated description in NVM chapter "UCB_SWAP_ORIG and UCB_SWAP_COPY" of TC3xx User's Manual V1.1.0 and following FLASH_TC.H018 (Sequence for Programming/Erasing - Documentation Update): updated description in DMU chapter "Performing Flash Operations" in TC3xx User's Manual V1.2.0 and following LVDS_TC.H001 (Driver ground potential difference - Additional information): Note included in chapter "High performance LVDS pads" in TC37xEXT AB Data Sheet V1.0 and following STM_TC.H003 (Suspend control for STMx - Documentation Update): updated OCS register description in STM chapter of TC3xx User's Manual V1.2.0 and following

History List / Change Summary
Table 2 History List (cont'd)

Version	Date	Remark
1.3	2020-03-31	Update: <ul style="list-style-type: none"> • New/updated text modules see column “Change” in tables 4..6 of errata sheet V1.3 • Removed: <ul style="list-style-type: none"> – CPU_TC.H016 (List of OS and I/O Privileged Instructions - Documentation Update): updated description in TriCore TC1.6.2 Core Architecture Manual V1.2.1, Vol. 2 Instruction Set, table 14
1.4	2020-07-06	Update: <ul style="list-style-type: none"> • New/updated text modules see column “Change” in tables 4..6 of errata sheet V1.4
1.5	2020-10-23	Update: <ul style="list-style-type: none"> • New/updated text modules see column “Change” in tables 4..6 of errata sheet V1.5 • Text module SCR_TC.022 (Effect of application or system reset and warm PORST on MC77_ECCD and MC78_ECCD for SCR RAMs) moved from chapter “Application Hints” to chapter “Functional Problems”
1.6	2021-01-22	Update: <ul style="list-style-type: none"> • New/updated text modules see column “Change” in tables 4..6 of errata sheet V1.6 • Table 1: reference for Safety Manual changed from V1.06 to V1.05

Table 2 History List (cont'd)

Version	Date	Remark
1.7	2021-04-22	<p>Update:</p> <ul style="list-style-type: none"> • New/updated text modules see column “Change” in tables 4..6 of errata sheet V1.7 <ul style="list-style-type: none"> – Text modules already published in TC3xx Errata Advance Information 2021_02: MCMCAN_AI.022, SMU_TC.H012 – Text modules already published in TC3xx Errata Advance Information 2021_03: EMEM_TC.H007, FlexRay_TC.H004, GETH_TC.H003, HSCT_TC.H010, SCR_TC.023, SENT_TC.H007 • Removed SCU_TC.032, included description in update of SCU_TC.031 (Bits SCU_STSTAT.HWCFGx (x=1-5) could have an unexpected value in application if pins HWCFGx are left unconnected)
1.8	2021-07-23	<p>Update:</p> <ul style="list-style-type: none"> • New/updated text modules see column “Change” in tables 4..6 of errata sheet V1.8 <ul style="list-style-type: none"> – Text modules already published in TC3xx Errata Advance Information 2021_05: GTM_AI.362, GTM_AI.364, GTM_AI.367, GTM_AI.370/371, GTM_AI.374..376 – Text modules already published in TC3xx Errata Advance Information 2021_06: FLASH_TC.055, GTM_AI.H004 (update see this errata sheet), MCMCAN_TC.H008, MTU_TC.018, PMS_TC.015

Table 2 History List (cont'd)

Version	Date	Remark
1.9	2021-11-04	Update: <ul style="list-style-type: none"> New/updated text modules see column "Change" in tables 4..6 <ul style="list-style-type: none"> Text modules already published in TC3xx Errata Advance Information 2021-09: FLASH_TC.056, GTM_AI.358, GTM_AI.387, MCMCAN_AI.023, RESET_TC.H006, SAFETY_TC.023, SAFETY_TC.024 Table 2 (History List) of errata sheet V1.8: corrected "GTM.AI.*" to "GTM_AI.*" Removed <ul style="list-style-type: none"> GTM_AI.H004: replaced by GTM_AI.387 GTM_AI.262, GTM_AI.263: only apply to TC39x step AA

Table 3 Errata fixed in this step¹⁾

Errata	Short Description	Change
BROM_TC.H016	CHSW fails check of PMS_EVR registers after software triggered LBIST	Fixed
PER_PLL_TC.001	Peripheral PLL weakness for 25 MHz input clock when using Divider Bypass	Fixed

1) Reference = TC37xEXT step AA

Note: Changes to the previous errata sheet version are particularly marked in column "Change" in the following tables.

Table 4 Functional Deviations

Functional Deviation	Short Description	Change	Page
ADC_TC.095	Ramp trigger ignored when ramp ends		31
BROM_TC.013	CAN BSL does not send error message if no valid baudrate is detected		31
BROM_TC.014	Lockstep Comparator Alarm for CPU0 after Warm PORST, System or Application Reset if Lockstep is disabled		32
BROM_TC.016	Uncorrectable ECC error in Boot Mode Headers		32
CCU_TC.004	Oscillator supervision – Documentation update for register OSCCON		33
CPU_TC.130	Data Corruption when ST.B to local DSPR coincides with external access to same address		34
CPU_TC.131	Performance issue when MADD/MSUB instruction uses E0/D0 register as accumulator		35
CPU_TC.132	Unexpected PSW values used upon Fast Interrupt entry		36
CPU_TC.133	Test sequence for DTAG single or double bit errors		38
DAP_TC.005	DAP client_read: dirty bit feature of Cerberus' Triggered Transfer Mode		39
DAP_TC.007	Incomplete client_blockread telegram in DXCM mode when using the “read CRCup” option		39
DAP_TC.010	Performance when accessing EMEM in UWM and WM modes		40
DMA_TC.059	ACCEN Protection not implemented for ERRINTRr		40

Table 4 Functional Deviations (cont'd)

Functional Deviation	Short Description	Change	Page
DMA_TC.066	DMA Double Buffering Operations - Update Address Pointer		41
DMA_TC.067	DMA Double Buffering Software Switch Buffer Overflow		41
DMA_TC.068	DMA Double Buffering Lost DMA Request		42
EDSADC_TC.003	Group Delay and Settling Time – Documentation Update		43
EMEM_TC.001	Integrity of EMEM contents when using standby locked mode		44
FLASH_TC.053	Erase Size Limit for PFLASH		46
FLASH_TC.055	Multi-bit errors detected by PFlash are not communicated to SPB masters		46
FLASH_TC.056	Reset value for register HF_ECCC is 0x0000 0000 - Documentation correction	New	48
FlexRay_AI.087	After reception of a valid sync frame followed by a valid non-sync frame in the same static slot the received sync frame may be ignored		48
FlexRay_AI.088	A sequence of received WUS may generate redundant SIR.WUPA/B events		49
FlexRay_AI.089	Rate correction set to zero in case of SyncCalcResult=MISSING_TERM		50
FlexRay_AI.090	Flag SFS.MRCS is set erroneously although at least one valid sync frame pair is received		51
FlexRay_AI.091	Incorrect rate and/or offset correction value if second Secondary Time Reference Point (STRP) coincides with the action point after detection of a valid frame		51

Table 4 Functional Deviations (cont'd)

Functional Deviation	Short Description	Change	Page
FlexRay_AI.092	Initial rate correction value of an integrating node is zero if pMicroInitialOffsetA,B = 0x00		52
FlexRay_AI.093	Acceptance of startup frames received after reception of more than gSyncNodeMax sync frames		53
FlexRay_AI.094	Sync frame overflow flag EIR.SFO may be set if slot counter is greater than 1024		53
FlexRay_AI.095	Register RCV displays wrong value		54
FlexRay_AI.096	Noise following a dynamic frame that delays idle detection may fail to stop slot		55
FlexRay_AI.097	Loop back mode operates only at 10 MBit/s		56
FlexRay_AI.099	Erroneous cycle offset during startup after abort of startup or normal operation		56
FlexRay_AI.100	First WUS following received valid WUP may be ignored		57
FlexRay_AI.101	READY command accepted in READY state		58
FlexRay_AI.102	Slot Status vPOC!SlotMode is reset immediately when entering HALT state		58
FlexRay_AI.103	Received messages not stored in Message RAM when in Loop Back Mode		59
FlexRay_AI.104	Missing startup frame in cycle 0 at coldstart after FREEZE or READY command		59
FlexRay_AI.105	RAM select signals of IBF1/IBF2 and OBF1/OBF2 in RAM test mode		60

Table 4 Functional Deviations (cont'd)

Functional Deviation	Short Description	Change	Page
FlexRay_AI.106	Data transfer overrun for message transfers Message RAM to Output Buffer (OBF) or from Input Buffer (IBF) to Message RAM		61
GETH_AI.001	Packets with Destination Address (DA) mismatch are delayed until EOP is received in threshold (cut-through) mode		64
GETH_AI.008	Application Error Along with Start-of-Packet Can Corrupt the FCS Field of the Previous Frame in the MAC Pipeline		66
GETH_AI.009	Corrupted Rx Descriptor Write Data		66
GETH_AI.010	Fatal Bus Error Interrupt Might Be Generated for Incorrect DMA Channel		67
GETH_AI.011	Receive Queue Overflow at End of Frame Along with SPRAM Read-Write Conflict Can Cause Data Loss		68
GETH_AI.012	Incorrect Flexible PPS Output Interval When Fine Time Correction Method is Used		69
GETH_AI.013	False Dribble and CRC Error Reported in RMII PHY 10Mbps Mode		70
GETH_AI.014	Receive DMA Channel Generates Spurious Receive Watchdog Timeout Interrupt		71
GETH_AI.015	MAC Receive VLAN Tag Hash Filter Always Operates in Default Mode		73
GETH_AI.016	Receive DMA Header Split Function Incorrectly Overruns the Allocated Header Buffer		74

Table 4 Functional Deviations (cont'd)

Functional Deviation	Short Description	Change	Page
GETH_AI.017	Carrier-Sense Signal Not Generated When False Carrier Detected in RGMII 10/100 Mbps Mode		76
GETH_AI.018	Description of the Transmit Checksum Offload Engine - Documentation update		77
GETH_TC.001	Reference clock for Time Stamp Update logic is f_{GETH}		78
GETH_TC.002	Initialization of RGMII interface		78
GTM_AI.254	TIM TDU: TDU_STOP=b101 not functional		79
GTM_AI.304	MCS: Scheduling modes Single Prioritization and Multiple Prioritization are not functional		80
GTM_AI.306	DPLL: DPLL_NUTC.syn_t_old, DPLL_NUSC.syn_s_old not updated according specification		81
GTM_AI.307	IRQ: AEI_IM_ADDR is not set in GTM_IRQ_NOTIFY register if cluster 0 is disabled		82
GTM_AI.308	TIM, ARU: Limitation that back-to-back TIM data transfers at full ARU clock rate cannot be transferred correctly with ARU dynamic routing feature		82
GTM_AI.318	MCS: NARD(I) instruction terminates unexpectedly		83
GTM_AI.319	(A)TOM: Unexpected (A)TOM_CCU1TCx_IRQ in up/down counter mode		84
GTM_AI.320	ATOM: Unexpected restart of a SOMS oneshot cycle while ATOM[i]_CH[x]_CM0 is zero		84

Table 4 Functional Deviations (cont'd)

Functional Deviation	Short Description	Change	Page
GTM_AI.322	DPLL: PSTC, PSSC not updated correctly after fast pulse correction completed (DPLL_CTRL1.PCM1/2 = 0)		85
GTM_AI.323	DPLL: Registers DPLL_NUTC.SYN_T and DPLL_NUSC.SYN_S are updated by the profile (ADT_T.NT/ADT_S.NS) before the DPLL is synchronized (DPLL_STATUS.SYT/S=0)		86
GTM_AI.325	TIM: Bits ACB[2:1] lost on interface to ARU (always zero)		87
GTM_AI.326	TIM: ARU bit ACB[0] (signal level) incorrect in case a second ARU request occurs while the actual request is just acknowledged		89
GTM_AI.329	Interference of MCS to AEI/ADC and CPU to AEI traffic within the same cluster could result in incorrect MCS program execution		90
GTM_AI.331	GTM_TIM[i]_AUX_IN_SRC and GTM_EXT_CAP_EN[i] register: wrong status 2 by AEI write access if cluster 0 is disabled		98
GTM_AI.332	Access to registers GTM_TIM[i]_AUX_IN_SRC and GTM_EXT_CAP_EN[i] via legacy address space: read data always 0 for AEI read access while cluster 0 is disabled		99
GTM_AI.333	MCS bus master interface: a not word aligned address access to DPLL ram region can cause incorrect execution of MCS channel code		100

Table 4 Functional Deviations (cont'd)

Functional Deviation	Short Description	Change	Page
GTM_AI.334	DPLL RAM content of single address can be corrupted after leaving debug mode		100
GTM_AI.335	TOM output signal to SPE not functional if up/down counter mode is configured		101
GTM_AI.336	GTM Bus Bridge: Incorrect AEI access execution in case the previous AEI access was aborted with the access timeout abort function		102
GTM_AI.339	DPLL: Control bits DPLL_CTRL_11.PCMF1 and DPLL_CTRL_11.PCMF2 are not reset to 0 after a pulse correction is completed		103
GTM_AI.340	TOM/ATOM: Generation of TRIG_CCU0/TRIG_CCU1 trigger signals skipped in initial phase of A/TOM SOMP one-shot mode		104
GTM_AI.341	TOM/ATOM: False generation of TRIG_CCU1 trigger signal in SOMP one-shot mode with OSM_TRIG=1 when CM1 is set to value 1		105
GTM_AI.344	DPLL: Incorrect AEI_STATUS on internal MCS2DPLL interface on valid and implemented address accesses		107
GTM_AI.345	SPE: Incorrect behaviour of direction change control via SPE_CMD.SPE_CTRL_CMD bits		108
GTM_AI.346	ATOM SOMS mode: Shift cycle is not executed correctly in case the reload condition is deactivated with ATOM[i]_AGC_GLB_CTRL.UPEN = 0		109

Table 4 Functional Deviations (cont'd)

Functional Deviation	Short Description	Change	Page
GTM_AI.347	TOM/ATOM: Reset of (A)TOM[i]_CH[x]_CN0 with TIM_EXT_CAPTURE are not correctly synchronized to selected CMU_CLK/CMU_FXCLK		110
GTM_AI.348	DPLL: Correction of missing pulses delayed after start of pulse generation		111
GTM_AI.349	TOM-SPE: OSM-Pulse width triggered by SPE_NIPD for selected CMU_FXCLK not correct		113
GTM_AI.350	TOM-SPE: Update of SPE[i]_OUT_CTRL triggered by SPE_NIPD not working for a delay value 1 in TOM[i]_CH[x]_CM1		113
GTM_AI.351	MAP: Disable of input lines by MAP_CTRL register not implemented for input signals TSPP0 TIM0_CHx(48) (x=0..2) and TSPP1 TIM0_CHx(48) (x=3..5)		114
GTM_AI.352	ATOM: No reload of data from ARU in SOMS and SOMP mode if TIM_EXT_CAPTURE(x) or TRIGIN(x) is selected as clock source		115
GTM_AI.353	SPEC-ATOM: Specification of the smallest possible PWM Period in SOMP mode wrong, when ARU_EN=1		117
GTM_AI.354	MCS: Unresolved hazard resulting from RAW (Read After Write) dependency		118
GTM_AI.357	MCS: instructions XCHB, SETB, and CLRB do not suppress register write		119
GTM_AI.358	TOM/ATOM: Synchronous update of working register for RST_CCU0=1 and UDMODE=0b01 not correct	Update	120

Table 4 Functional Deviations (cont'd)

Functional Deviation	Short Description	Change	Page
GTM_AI.359	TOM: Both edges on TOM_OUT_T at unexpected times for RST_CCU0=1 and UDMODE>0		122
GTM_AI.360	SPEC-(A)TOM: PCM mode (BITREV=1) is only available for UDMODE=0		123
GTM_AI.361	IRQ: Missing pulse in single-pulse interrupt mode on simultaneous interrupt and clear event		123
GTM_AI.362	MCS: Using wrong WURM mask during execution of instruction WURMX or WURCX		124
GTM_AI.364	ATOM: ARU read request does not start at expected timepoint in UDMODE=1 and UDMODE=3	Update	125
GTM_AI.367	MCS: Instructions WURMX and WURCX implement invalid extended register set for argument A		127
GTM_AI.370	TOM/ATOM: Unexpected reset of CN0 in up-down counter mode and CM0=2		128
GTM_AI.371	MCS: Instruction MWRIL applies unexpected address offset calculation	Update	129
GTM_AI.374	SPEC-ATOM: Statement on timing of duty cycle output level change not correct for SOMP up/down-counter mode		130
GTM_AI.375	ATOM: Data from ARU are read only once in SOMC mode even though ARU blocking mode is disabled while FREEZE=1 and ENDIS=0	Update	130

Table 4 Functional Deviations (cont'd)

Functional Deviation	Short Description	Change	Page
GTM_AI.376	TOM/ATOM: Interrupt trigger signals CCU0TC_IRQ and CCU1TC_IRQ are delayed by one CMU_CLK period related to the output signals	Update	132
GTM_AI.387	DPLL: Wrong calculation of pulse generator frequency for DPLL_CTRL_0.AMT/S=1 and DPLL_CTRL_11.ADT/S=1 when number of pulses (DPLL_CTRL_0.MLT or DPLL_MLS1/2.MLS1/2) is too small	New	132
GTM_TC.018	DPLL RAM trace data can be wrong		133
GTM_TC.019	ARU can not be traced if GTM cluster 5 is disabled		134
GTM_TC.020	Debug/Normal read access control via bit field ODA.DRAC		134
GTM_TC.021	Registers CANOUTSEL0, CANOUTSEL1 - Documentation update for fields SELx (x = 0, 1)		135
GTM_TC.022	Register ATOMi_AGC_ENDIS_STAT - Documentation Update		138
HSCT_TC.012	HSCT sleep mode not supported		139
HSCT_TC.013	Internal Loopback Mode not reliable		139
MCDS_TC.052	TriCore wrap around write access causes redundant MCDS message		140
MCDS_TC.064	ACCEN0 register write not supervisor protected		140
MCDS_TC.065	Selection of SRI trace sources		141
MCDS_TC.066	Selection of CPU trace sources		141
MCDS_TC.067	MCDS kernel reset shall not be used		142

Table 4 Functional Deviations (cont'd)

Functional Deviation	Short Description	Change	Page
MCMCAN_AI.015	Edge filtering causes mis-synchronization when falling edge at Rx input pin coincides with end of integration phase		142
MCMCAN_AI.017	Retransmission in DAR mode due to lost arbitration at the first two identifier bits		144
MCMCAN_AI.018	Tx FIFO Message Sequence Inversion		145
MCMCAN_AI.019	Unexpected High Priority Message (HPM) interrupt		147
MCMCAN_AI.022	Message order inversion when transmitting from dedicated Tx Buffers configured with same Message ID		149
MCMCAN_AI.023	Incomplete description in section *5.2 “Dedicated Tx Buffers” and *5.4 “Tx Queue” of the M_CAN documentation in the User’s Manual related to transmission from multiple buffers configured with the same Message ID	New	150
MTU_TC.012	Security of CPU Cache Memories During Runtime is Limited		152
MTU_TC.017	Unexpected alarms after application reset		153
MTU_TC.018	Gated SRAM alarms		154
MTU_TC.019	Type properties for reserved bits MCONTROL.R8, R12..R14 - Documentation update		155
PADS_TC.011	Pull-ups activate on specific analog inputs upon PORST		156
PMS_TC.005	Voltage rise at P33 and P34 up to $V_{EVR\overline{S}B}$ during start-up and up to $V_{LVDR\overline{S}T\overline{S}B}$ during power-down		156

Table 4 Functional Deviations (cont'd)

Functional Deviation	Short Description	Change	Page
PMS_TC.006	PORST not released during Cold Power-on Reset until VDDM is available		157
PMS_TC.007	VDDP3 or VDD Overvoltage during start-up may not be detected by PBIST		158
PMS_TC.011	VEXT supplied PU2 and PD2 pads always in tristate after standby entry - Documentation correction	Update	158
PMS_TC.012	Short to Supply and Ground Detection – Documentation update		160
PMS_TC.014	Parasitic coupling on shared ADC pins depending on supply voltages		160
PMS_TC.015	EVRC synchronization – Documentation update for register EVRSDCTRL11 (PMS) and EVRSDCTRL2 (PMSLE)		161
QSPI_TC.006	Baud rate error detection in slave mode (error indication in current frame)		163
QSPI_TC.009	USR Events for PT1=2 (SOF: Start of Frame)		163
QSPI_TC.010	Move Counter Mode - USR Events for PT1=4 (RBF: Receive Buffer Filled)		164
QSPI_TC.013	Slave: No RxFIFO write after transmission upon change of BACON.MSB		164
QSPI_TC.014	Slave: Incorrect parity bit upon TxFIFO underflow		165
QSPI_TC.016	Master: Move Counter Mode - Counter underflows when data is present in the TXFIFO while in the last TRAIL state of the previous transaction		165
QSPI_TC.017	Slave: Reset when receiving an unexpected number of bits		166

Table 4 Functional Deviations (cont'd)

Functional Deviation	Short Description	Change	Page
SAFETY_TC.002	SM[HW]:NVM.PFLASH:FLASHCON_MONITOR – Safe setting - Documentation update		166
SAFETY_TC.004	ESM[HW]:MCU:LBIST_MONITOR - Documentation update to Safety Manual		167
SAFETY_TC.006	SM[HW]:SMU:CCF_MONITOR - Documentation update to Safety Manual		168
SAFETY_TC.007	SM[HW]:PMS:VDDM_MONITOR - Documentation correction		168
SAFETY_TC.021	SM[HW]:LMU:CFG_AS_AP - Documentation correction		169
SAFETY_TC.023	MCU infrastructure Safety Related Function - Documentation Update	New	169
SAFETY_TC.024	Clock alive monitor for f_{SPB} - Documentation update	New	170
SCR_TC.015	Bit SCU_PMCON1.WCAN_DIS does not disable WCAN PCLK input		170
SCR_TC.016	DUT response to first telegram has incorrect C_START value		170
SCR_TC.018	SSC Receive FIFO not working		171
SCR_TC.019	Accessing the XRAM while SCR is in reset state		171
SCR_TC.020	Stored address in mon_RETH may be wrong after a break event		172
SCR_TC.021	RTC not counting after reset if P33.10 is high		172
SCR_TC.022	Effect of application or system reset and warm PORST on MC77_ECCD and MC78_ECCD for SCR RAMs		173

Table 4 Functional Deviations (cont'd)

Functional Deviation	Short Description	Change	Page
SCR_TC.023	External interrupts EXINT0, EXINT1 may get locked		173
SCU_TC.031	Bits SCU_STSTAT.HWCFGx (x=1-5) could have an unexpected value in application if pins HWCFGx are left unconnected		174
SDMMC_AI.001	Timeout Error When BOOT ACK Driven on All Data Lines in SD/eMMC Mode		175
SMU_TC.012	Unexpected alarms when registers FSP or RTC are written		176
SMU_TC.013	Unexpected setting of Alarm Missed Event bit xAEM in Alarm Executed Status register SMU_AEX		177

Table 5 Deviations from Electrical- and Timing Specification

AC/DC/ADC Deviation	Short Description	Change	Page
ADC_TC.P009	Increased TUE for G10 when using Alternate Reference		178
ADC_TC.P014	Equivalent Circuitry for Analog Inputs - Additional information		178
ADC_TC.P015	Increased RMS Noise for TC374* and TC375* devices		179
EDSADC_TC.P002	Parameters Input Current, Gain Error - Additional information		180
FLASH_TC.P003	Program Flash Erase Time per Multi-Sector Command		180

Table 5 Deviations from Electrical- and Timing Specification (cont'd)

AC/DC/ADC Deviation	Short Description	Change	Page
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PADS_TC.P011	High Performance LVDS Pads - Documentation update to Data Sheet		181
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2 Functional Deviations

ADC TC.095 Ramp trigger ignored when ramp ends

The Fast Compare Channels can automatically generate ramps (see section “Ramp Mode” in the EVADC chapter). A ramp can be started by a hardware trigger.

- A trigger that occurs while the ramp is running will restart the ramp from its defined starting level.
- A trigger that occurs exactly at the time when the ramp is completed (corner case) will be ignored and lead to no action.

Workaround

Make sure the ramp trigger is activated while the ramp is not running (this will be the usual case). Avoid trigger intervals with the same duration as the ramp itself.

BROM TC.013 CAN BSL does not send error message if no valid baudrate is detected

If the CAN Bootstrap loader (BSL) is unable to determine the baudrate from the initialization message sent by the host, it does not send the error message as defined in table “Error message (No baudrate detected)” in chapter “AURIX™ TC3xx Platform Firmware”, but enters an endless loop with no activity on external pins.

Workaround

If the external host does not receive Acknowledgment Message 1 from the CAN BSL within the expected time (~5 ms), it should check the integrity of the connection, and then may reset the TC3xx to restart the boot procedure.

BROM_TC.014 Lockstep Comparator Alarm for CPU0 after Warm PORST, System or Application Reset if Lockstep is disabled

Lockstep monitoring may be disabled in the Boot Mode Header structure (BMHD) for each CPUx with lockstep functionality (including CPU0). The startup software (SSW) will initially re-enable lockstep upon the next reset trigger.

If lockstep is disabled for CPU0, and the next reset is a warm PORST, System or Application reset, a lockstep comparator alarm will be raised for CPU0.

Note: This effect does not occur for CPUx, x>0.

Workaround

Do not disable lockstep for CPU0, always keep lockstep on CPU0 enabled.

Non-safety applications may ignore the lockstep comparator alarm for CPU0.

BROM_TC.016 Uncorrectable ECC error in Boot Mode Headers

If one or more boot mode headers UCB_BMHDx_ORIG or UCB_BMHDx_COPY contain an uncorrectable ECC error (4-bit error) in the BMI, BMHDID, STAD, CRCBMHD or CRCBMHD_N fields, firmware will end up in an irrecoverable state resulting in a device not being able to boot anymore.

This may happen in the following scenarios:

- Power-loss during BMHD reprogramming or erase
- Over-programming of complete BMHD contents.

Workaround

- Ensure continuous power-supply during BMHD reprogramming and erase using power monitoring including appropriate configuration.
- Avoid over-programming of BMHD contents.
- Ensure that also in any BMHDx_ORIG or _COPY unused in the application, the above fields are in a defined ECC-error free state (e.g. clear them to 0).

CCU_TC.004 Oscillator supervision – Documentation update for register OSCCON

The formulas for the threshold frequencies f_{LV} , f_{HV} that are documented in the description of bits PLLLV and PLLHV in register OSCCON in the current version of the TC3xx User's Manual are not correctly representing the actual device behavior. The formulas shall be updated as listed below.

In addition, the note listed below on the range of the reference frequency f_{OSC} supervised by the oscillator watchdog shall be added to the description of field OSCVAL.

Table 7 Register OSCCON - Documentation updates¹⁾

Field	Bits	Type	Description
PLLLV	1	rh	Oscillator for PLL Valid Low Status Bit ... By using the crystal's nominal frequency (f_{oscnom}), the lower threshold frequency f_{LV} calculates as follows: <ul style="list-style-type: none"> $f_{LV} = f_{oscnom} * 0.75$ - 0.31 MHz (typical case for back-up clock after trimming) $f_{LV} = f_{oscnom} * 0.53$ - 0.39 MHz (lower boundary for back-up clock before trimming) ...

Table 7 Register OSCCON - Documentation updates¹⁾ (cont'd)

Field	Bits	Type	Description
PLLHV	8	rh	Oscillator for PLL Valid High Status Bit ... By using the crystal's nominal frequency (f_{oscnom}), the upper threshold frequency f_{HV} calculates as follows: <ul style="list-style-type: none"> $f_{\text{HV}} = f_{\text{oscnom}} * \mathbf{1.46} + 0.29 \text{ MHz}$ (typical case for back-up clock after trimming) $f_{\text{HV}} = f_{\text{oscnom}} * 1.86 + 0.21 \text{ MHz}$ (higher boundary for back-up clock before trimming) ...
OSCVAL	20:16	rw	OSC Frequency Value ... The reference frequency calculates as follows: $f_{\text{OSC}} = (\text{OSCCON.OSCVAL} - 1 + 16) \text{ MHz}$ Note: Valid range for f_{OSC} is from 16 MHz - 40 MHz. For any other value set outside this range, the status of flags PLLHV and PLLLV is undefined.

- 1) Only the direct context of the updated text is shown here, with most significant modifications to present text in bold. For the other parts see the description of register OSCCON in the TC3xx User's Manual.

CPU TC.130 Data Corruption when ST.B to local DSPR coincides with external access to same address

Under certain conditions, when a CPU accesses it's local DSPR using "store byte" (ST.B) instructions, coincident with stores from another bus master (remote CPU, DMA etc.) to addresses containing the same byte, the result is the corruption of data in the adjacent byte in the same halfword.

All the following conditions must be met for the issue to be triggered:

- CPU A executes a ST.B targeting its local DSPR

Functional Deviations

- Remote bus master performs a write of 16-bit or greater targeting CPU A DSPR
- Both internal and external accesses target the same byte without synchronization.

Note that although single 8-bit write accesses by the remote bus master do not trigger the problem, 16-bit bus writes from a remote CPU could occur from a sequence of two 8-bit writes merged by the store buffers into one 16-bit access. When the above conditions occur, the value written by the external master to the adjacent byte (to that written by CPU A) is lost, and the prior value is retained.

Workarounds**Workaround 1**

Ensure mutually exclusive accesses to the memory location. A semaphore or mutex can be put in place in order to ensure that Core A and other bus masters have exclusive access to the targeted DSPR location.

Workaround 2

When sharing objects without synchronization between multiple cores, use objects of at least halfword in size.

Workaround 3

When two objects, being shared without synchronization between multiple cores, are of byte granularity, locate these objects in a memory which is not a local DSPR to either of the masters (LMU, PSPR, other DSPR etc.).

CPU TC.131 Performance issue when MADD/MSUB instruction uses E0/D0 register as accumulator

Under certain conditions, when a Multiply (MULx.y) or Multiply-Accumulate (MAC) instruction is followed by a MAC instruction which uses the result of the first instruction as its accumulator input, a performance reduction may occur if

Functional Deviations

the accumulator uses the E0/D0 register. The accumulator input is that to which the multiplication result is added to / subtracted from in a MAC instruction.

All MAC instructions MADDx.y, MSUBx.y are affected except those that operate on Floating-Point operands (MADD.F, MSUB.F).

The problem occurs where there is a single cycle bubble, or an instruction not writing a result, between these dependent instructions in the Integer Pipeline (IP). When this problem occurs the dependent MAC instruction will take 1 additional cycle to complete execution. If this sequence is in a loop, the additional cycle will be added to every iteration of the loop.

Example:

```
maddm.h e0, e0, d3, d5ul ; MUL/MAC writing E0 as result
ld.d    e8, [a5]        ; Load instruction causing IP bubble
maddm.h e0, e0, d6, d8ul ; MAC using E0 as accumulator.
                        ; Should be delayed by 1 cycle due to
                        ; dependency to result of previous LD.D,
                        ; but is delayed for 2 cycles
```

Note that if there are 2 or more IP instructions, or a single IP instruction writing a result, between the MAC and the previous MUL/MAC, then this issue does not occur.

Workaround

Since the issue only affects D0 / E0, it is recommended that to ensure the best performance of an affected sequence as the above example, D0 / E0 is replaced with another register (D1-D15 / E2-E14).

CPU_TC.132 Unexpected PSW values used upon Fast Interrupt entry

Under certain conditions, unexpected PSW values may be used during the first instructions of an interrupt handler, if the interrupt has been taken as a fast interrupt. For a description of fast interrupts, see the “CPU Implementation-Specific Features” section of the relevant User’s Manual.

When the problem occurs, the first instructions of the interrupt handler may be executed using the PSW state from the end of the previous exception handler,

rather than that which is being loaded by the fast interrupt entry sequence. The TC1.6E, TC1.6P and TC1.6.2P processors are all affected by this problem as follows:

- TC1.6E (in TC21x..TC27x): Only the first instruction of the ISR is affected.
- TC1.6P (in TC26x..TC29x), TC1.6.2P (in TC3xx): Up to 4 instructions at the start of the ISR may be affected. However, if the following precondition is not met, then there is no issue for these processor variants:
 - A11 must point to the first instruction of the fast interrupt handler at the end of the previous exception handler, i.e. the return value from the previous exception must be pointing to the very first instruction of the new interrupt handler. Note that this case should not occur normally, unless software updates the A11 register to a value corresponding to the start of an interrupt handler.

Workarounds

Workaround 1

When the PSW fields PSW.PRS, PSW.S, PSW.IO or PSW.GW need to be changed in an exception handler, the change should be wrapped in a function call.

```
_exception_handler:
    CALL _common_handler
    RFE

_common_handler:
    MOV.U d0, #0x0380
    MTCR #(PSW), d0    // PSW.IO updated to User-0 mode
    ...
    RET
```

Note that this workaround assumes SYSCON.TS == SYSCON.IS such that the workaround functions correctly for both traps and interrupts. If this is not the case it is possible for bus accesses to use an incorrect master Tag ID, potentially resulting in an access to be incorrectly allowed, or an unexpected alarm to be generated. In this case it should be ensured that for all interrupt handlers the potentially affected instructions do not produce bus accesses.

Workaround 2

Do not use any instructions dependent upon PSW settings (e.g. BISR or ENABLE, dependent on PSW.IO) as the first instruction of an ISR in TC1.6E, or as one of the first 4 instructions in an ISR for TC1.6P or TC1.6.2P.

Note: The workarounds need to be applied in TC1.6P and TC1.6.2P only in case software modifies the A11 register in an exception handler, as described in the preconditions above.

CPU TC.133 Test sequence for DTAG single or double bit errors

The error injection method described in the section “13.5.2.1.4 Error injection and Alarm Triggering” in the MTU chapter of the TC3xx User’s Manual using the ECCMAP method is not sufficient to trigger alarms pertaining to the DTAG RAM of each CPU. In the case of DTAG RAM, an alternate method relying on the Read Data and Bit Flip register (RDBFL) must be used instead.

When using the ECCMAP, the DTAG ECC error detection is disabled when the DTAG memory is mapped in the system address map.

This limitation only affects the testing using ECCMAP for DTAG RAM.

During normal operation, where DTAG is used as part of the CPU data cache operation, the ECC error detection functions as intended.

During SSH test mode (used for MBIST) the ECC error detection also operates as intended.

Workaround

A correct test sequence for DTAG single and double bit error injection must therefore use the RDBFL register without mapping the RAM to the system address space.

DTAG SRAM test sequence

In order to test the DTAG error injection the following test sequence should be followed:

1. Read an DTAG SRAM location into RDBFL register
(see section 13.3.5.1.6 “Reading a Single Memory Location”).

2. Flip some bit in RDBFL[0].
3. Writeback the content of the RDBFL into the DTAG SRAM (see section 13.3.5.1.7 “Writing a Single Memory Location”).
4. Read the DTAG SRAM location again.

Depending on the number of bits flipped the CE or UCE alarms will be triggered.

Note: Absolute chapter numbers in the text above refer to MTU chapter version V7.4.12 included in the TC3xx User's Manual V1.6.0. They may change if used in other versions of this document.

DAP_TC.005 DAP client_read: dirty bit feature of Cerberus' Triggered Transfer Mode

Note: This problem is only relevant for tool development, not for application development.

The DAP telegram client_read reads a certain number of bits from an IOclient (e.g. Cerberus). The parameter k can be selected to be zero, which is supposed to activate reading of 32 bits plus dirty bit.

However, in the current implementation, the dirty bit feature does not work correctly.

It is recommended not to use this dirty bit feature, meaning the number k should not evaluate to “0”.

DAP_TC.007 Incomplete client_blockread telegram in DXCM mode when using the “read CRCup” option

In DXCM (DAP over CAN Messages) mode, the last parcel containing the CRC32 might be skipped in a client_blockread telegram using the “read CRCup” option.

Workaround

Do not use CRCup option with client_blockread telegrams in DXCM mode.

Instead the CRCup can be read by a dedicated getCRCup telegram.

DAP_TC.010 Performance when accessing EMEM in UWM and WM modes

Note: This problem is only relevant for development tools and their device connection.

The read bandwidth of DAP for accessing EMEM is about 25 Mbyte/s in Unidirectional Wide Mode (UWM) and Wide Mode (WM) if the DAP is clocked at 160 MHz. This is lower than the target value of 30 Mbyte/s. The bandwidth is limited by the long path from DAP to EMEM.

If the DAP frequency is below 125 MHz, this effect is hidden behind other delays. Therefore below this frequency the bandwidth will be proportional to the DAP frequency. At 125 MHz a bandwidth of 23.5 Mbyte/s was measured in simulation.

The details of WM and UWM are described in the section “DAP Modes and Options” in the OCDS chapter of the device documentation.

Note: The bandwidth measurement is conducted with the BBB frequency of 150 MHz.

DMA_TC.059 ACCEN Protection not implemented for ERRINTRr

In the current documentation, the debug feature Error Interrupt Set Register ERRINTRr for Resource Partition r ($r = 0..3$) is specified as access enable protected (symbol “Pr” in column Access Mode/Write) in table “Register Overview” of the DMA chapter.

However, in this design step, register ERRINTRr ($r = 0..3$) is not implemented as access enable protected.

Workaround

None.

DMA_TC.066 DMA Double Buffering Operations - Update Address Pointer

Software may configure a DMA channel for one of the DMA double buffering operations:

- DMA Double Source Buffering Software Switch Only
 - (DMA channel DMA_ADICRz.SHCT = 1000_B),
- DMA Double Source Buffering Automatic Hardware and Software Switch
 - (DMA channel DMA_ADICRz.SHCT = 1001_B),
- DMA Double Destination Buffering Software Switch Only
 - (DMA channel DMA_ADICRz.SHCT = 1010_B),
- DMA Double Destination Buffering Automatic Hardware and Software Switch
 - (DMA channel DMA_ADICRz.SHCT = 1011_B).

If the software updates a buffer address pointer by BYTE or HALF-WORD writes, the resulting value of the address pointer is corrupted.

Workaround

If the software updates a buffer address pointer, the software should only use a 32-bit WORD access.

DMA_TC.067 DMA Double Buffering Software Switch Buffer Overflow

If a DMA channel is configured for DMA Double Buffering Software Switch Only and the active buffer is emptied or filled, the DMA does not stop. A bug results in the DMA evaluating the state of the FROZEN bit (DMA channel CHCSR.FROZEN). If the FROZEN bit is not set, the DMA continues to service DMA requests in the current buffer. The DMA may perform DMA write moves outside of the address range of the buffer potentially trashing other data.

Workaround

Implement one or more of the following to minimize the impact of the bug:

1. Configure access protection across the whole memory map to prevent the trashing data by the DMA channel configured for DMA double buffering. A DMA

resource partition may be used to assign a unique master tag identifier to the DMA channel.

2. The address generation of the DMA channel configured for DMA double buffering should use a circular buffer aligned to the size of the buffer to prevent the DMA from writing outside the address range of the buffer.

DMA_TC.068 DMA Double Buffering Lost DMA Request

If a DMA channel is configured for DMA Double Buffering and a buffer switch is performed, no DMA requests shall be lost by the DMA and there shall be no loss, duplication or split of data across two buffers.

A bug results in a software switch clearing a pending DMA request. As a result a DMA transfer is lost without the recording of a TRL event so violating the aforementioned top-level requirements of DMA double buffering.

Workaround

The system must ensure that a software switch does not collide with a DMA request. A user program must execute the following steps to switch the buffer:

1. Software must disable the servicing of interrupt service requests by the DMA channel by disabling the corresponding Interrupt Router (IR) Service Request Node (SRN).
 - a) Software shall write $IR_SRCi.SRE = 0_B$
2. Software must halt the DMA channel configured for DMA double buffering.
 - a) Software shall write DMA channel $TSRc.HLTREQ = 1_B$
 - b) Software shall monitor DMA channel $TSRc.HLTACK = 1_B$
3. Software must monitor the DMA Channel Transaction Request State
 - a) Software shall read DMA channel $TSRc.CH$ and store the value in a variable `SAVED_CH`
4. Software must switch the source or destination buffer
 - a) Software shall write DMA channel $CHCSRc.SWB = 1_B$
 - b) Software shall monitor the DMA channel frozen bit $CHCSRc.FROZEN$
5. When the DMA channel has switched buffers (DMA channel $CHCSRc.FROZEN = 1_B$)

- a) If (SAVED_CH==1), software shall trigger a DMA software request by writing DMA channel CHCSRc.SCH = 1_B to restore DMA channel TSRc.CH to the state before the buffer switch.
6. Software must unhalt the DMA channel.
 - a) Software shall write DMA channel TSRc.HLTCLR = 1_B
7. Software must enable the servicing of interrupt service requests by the DMA channel.
 - a) Software shall write IR_SRCi.SRE = 1_B

The software must include an error routine.

1. Software must monitor for interrupt overflows (IR_SRCi.IOV = 1_B) and lost DMA requests (TSRc.TRL = 1_B).
2. If software detects an overflow or lost DMA request, the software must execute an error routine and take the appropriate reaction consistent with the application.

EDSADC TC.003 Group Delay and Settling Time – Documentation Update

Note: This problem is related to the EDSADC chapter in TC3xx User's Manual versions up to (and including) V1.5. It is corrected in TC3xx User's Manual V1.6.

Starting with TC3xx User's Manual V1.3, chapter "Group Delay" has been revised to chapter "Group Delay and Settling Time", and table "Settling Time Summary" has been added. This table includes the following incorrect formula in column "Setting Time [t_D]" for Filter Chain Element FIR1:

- $t_{[D]} = 28 / 2^{FCFGMx.FIR1DEC} + 1$

Documentation Update

The correct formula in column "Settling Time [t]" for Filter Chain Element FIR1 is

- $t_{[D]} = 28 / 2^{1-FCFGMx.FIR1DEC} + 1$

A copy of table "Settling Time Summary" from TC3xx User's Manual V1.6 is shown below:

Table 288 Settling Time Summary

Filter Chain Element	Settling Time [t_p]	Notes
CIC3	3 + 1	Settling time is defined by 3rd order of the CIC filter
FIR0	8 / 2 + 1	Settling time is defined by the 8 taps of FIR0 and the decimation of 2
FIR1	$28 / 2^{1-FCFGMx.FIR1DEC} + 1$	Settling time is defined by the 28 taps of FIR1 and the configurable decimation (FCFGMx.FIR1DEC)
Offset correction/compensation	$1 / (5 \times f_{3dB})$	Cutoff frequency (f_{3dB}) can be configured by bit-field FCFGMx.OCEN
Integrator	1 + 2	Mathematically, the integrator behave like a 1st order CIC filter

Figure 1 Settling Time Summary

See chapter “Group Delay and Settling Time” in TC3xx User’s Manual V1.6 for the full description.

EMEM_TC.001 Integrity of EMEM contents when using standby locked mode

Note: This problem is only relevant if any data has to be retained in EMEM standby locked mode; otherwise there is no issue.

If the EMEM is supplied by V_{DDSB} during standby locked mode while the other parts of the device are unsupplied, at some EMEM addresses the previous content might not be reliable anymore after powering up the device again.

The root cause of this problem is that redundancy information is cleared upon cold PORST.

Workaround

For applications that use the standby locked mode of EMEM it is possible to reliably restore the previous contents of the respective EMEM locations via software.

This reliable proven workaround sequence must be executed as soon as standby locked mode is exited (before using the EMEM data in the application or for debug/ calibration purpose).

For each MCx (x = 44,45,46,47 in TC39x, x = 44,45,46 in TC37xEXT):

- Enter MEMTEST mode
- Disable all error notifications in ALMSRCS and ECCS except ECE i.e. only single bit error **correction** is enabled by setting ECE = 1, rest of error notifications (CENE;UCENE;MENE) are disabled.
=>> This is to prevent additional errors in ECCD or ERRINFO due to the test sequence.
- Copy the RANGE register to a temporary variable, so that its default value can be restored at the end of the sequence.
- Read 8 x 16-bit words from addresses MCx_BASE + 0x20 + 2*i //(i=0-7).
//for x=44-47 (TC39x), x=44-46 (TC37xEXT), for i=0-7
uint32 addr_tmpi = (MCx_BASE + 0x20 + 2*i)
tmp_uint16i = *(volatile uint16*)(addr_tmpi);
- If bit 15 = 1:
if (tmp_uint16i & 0x8000)
//NOTE: if bit 15 is 0, then nothing to do

- Clear the value:

```
*(volatile uint16*)(addr_tmpi) = tmp_uint16i & 0x7FFF;
```

Note: should be in SV mode with Safety Endinit disabled, ACCEN allowing the master to write to SSH registers; and the access should be a 16-bit write.

- Perform a single read to memory location as explained in the MTU chapter "Reading a Single Memory Location" in the TC3xx User's Manual:

```
MCx_RANGE.ADDR = tmp_uint16i & 0x7FFF;
```

Note: The RANGE.ADDR field to be used for this READ operation should be taken from bits 0-14 of the read value.

The RDBFL registers are updated. Don't modify the contents since they are used in the later step.

- Set the bit-15 back:

```
*(volatile uint16*)(addr_tmpi) = tmp_uint16i | 0x8000;
```

Note: should be in SV mode with Safety Endinit disabled, ACCEN allowing the master to write to SSH registers; and the access should be a 16-bit write.

- Perform a single write to memory location as explained in the MTU chapter “Writing to a Single Memory Location” in the TC3xx User’s Manual **without modifying the RDBFL register contents and RANGE.ADDR.**

- Restore RANGE register from the temporary variable saved above.
- Restore the alarm /error notifications in ECCS and ALMSRCS.
- Exit MEMTEST mode.

FLASH_TC.053 Erase Size Limit for PFLASH

The device may fail to start up after a primary voltage monitor triggered (cold) PORST if all of the following four conditions are fulfilled at the same time:

- Erase operation is ongoing in PFLASH, AND
- PORST is triggered by one of the primary voltage monitors, AND
- Ambient temperature $T_A > 60^{\circ}\text{C}$ OR junction temperature $T_J > 70^{\circ}\text{C}$, AND
- Size of logical sectors > 256 Kbyte is specified in “Erase Logical Sector Range” command

Workaround

If it cannot be excluded that all four conditions listed above may occur at the same time:

- Limit the maximum logical sector erase size to 256 Kbyte in the “Erase Logical Sector Range” command.

FLASH_TC.055 Multi-bit errors detected by PFlash are not communicated to SPB masters

Problem

Section “PFLASH ECC” in the NVM chapter of the TC3xx User Manual states in bullet points

- “Multi-bit error and not All-0 error” and
- “Multi-bit error and All-0 error”

that a bus error is returned to the reading master.

The same statement is repeated in section “Program Side Memories” in the CPU chapter under the headline “Local Pflash Bank (LPB)” and in the HSM Target Specification.

Effectively the processing of such errors depends on the type of transaction (burst or single) and the path the read transaction takes through the on-chip connectivity with the result that an SPB master (like HSM) gets no information about the detected error as detailed below:

When a CPU reads its local PFlash bank using direct access through its DPI (also called “Fast Path”) such errors are directly translated into a PIE trap for instruction fetch and a DIE trap for data read. No bus error is generated as no bus communication is involved.

When any master reads PFlash through the SRI (this includes CPUs reading the PFlash located at another CPU or its local bank with disabled Fast Path) a single transfer with multi-bit error returns a bus error but a burst read is reporting this error using a forced “Transaction ID Error” (concept described in “On-Chip System Connectivity {and Bridges}”). The bus error is always communicated back to the master. The handling of the Transaction ID Error however is master specific.

When a CPU receives the SRI transaction ID error it handles it as bus error and triggers a PSE trap for instruction fetch and a DSE trap for data read.

Also the DMA handles the Transaction ID Error like a bus error, sets the corresponding error flags and triggers the source error interrupt request.

When an SPB master like HSM performs a burst read from a PFlash bank this SRI Transaction ID Error terminates at the SFI_F2S bridge. The SPB master does not receive a bus error and continues operation with wrong data. The SFI_F2S bridge signals the error to the XBar for alarm generation.

The SPB master Cerberus acting on behalf of a debug tool issues only single transfers and is therefore correctly informed by a bus-error.

Workaround

Such multi-bit errors are added to the MBAB error buffer in the PFI (documented in the NVM chapter). Filling the MBAB results in sending an alarm

Functional Deviations

“Safety Mechanism: PFlash ECC; Alarm: Multiple Bit Error Detection Tracking Buffer Full” to the SMU.

As described above also SFI_F2S bridge informs the XBar to generate an alarm “Safety Mechanism: Built-in SRI Error Detection; Alarm: XBAR0 Bus Error Event” to the SMU. With HSM as requesting master the XBAR0 just captures the occurrence of this error but doesn't capture address or other transaction data in its Error Capture registers.

The application has to take care that the SMU alarm handler informs the SPB master.

FLASH_TC.056 Reset value for register HF_ECCC is 0x0000 0000 - Documentation correction

In the register description for register HF_ECCC (DF0 ECC Control Register) in the TC3xx User's Manual, the application reset value is documented as 0xC000 0000.

However, this register is cleared by the startup software SSW, and the user software will read the reset value of 0x0000 0000.

Documentation correction

- The application reset value for register HF_ECCC is 0x0000 0000.

Note: The user must consider that field HF_ECCC.TRAPDIS is 00_B after reset, which means a bus error trap is generated if an uncorrectable ECC error occurs upon read from DF0, or read from DF1 when DF1 is configured as not HSM_exclusive.

FlexRay_AI.087 After reception of a valid sync frame followed by a valid non-sync frame in the same static slot the received sync frame may be ignored

Description:

If in a static slot of an even cycle a valid sync frame followed by a valid non-sync frame is received, and the frame valid detection (prt_frame_decoded_on_X) of the DEC process occurs one sclk after valid frame detection of FSP process

Functional Deviations

(fsp_val_syncfr_chx), the sync frame is not taken into account by the CSP process (devte_xxs_reg).

Scope:

The erratum is limited to the case where more than one valid frame is received in a static slot of an even cycle.

Effects:

In the described case the sync frame is not considered by the CSP process. This may lead to a SyncCalcResult of MISSIMG_TERM (error flag SFS.MRCS set). As a result the POC state may switch to NORMAL_PASSIVE or HALT or the Startup procedure is aborted.

Workaround

Avoid static slot configurations long enough to receive two valid frames.

FlexRay AI.088 A sequence of received WUS may generate redundant SIR.WUPA/B events**Description:**

If a sequence of wakeup symbols (WUS) is received, all separated by appropriate idle phases, a valid wakeup pattern (WUP) should be detected after every second WUS. The E-Ray detects a valid wakeup pattern after the second WUS and then after each following WUS.

Scope:

The erratum is limited to the case where the application program frequently resets the appropriate SIR.WUPA/B bits.

Effects:

In the described case there are more SIR.WUPA/B events seen than expected.

Workaround

Ignore redundant `SIR.WUPA/B` events.

FlexRay AI.089 Rate correction set to zero in case of SyncCalcResult=MISSING_TERM**Description:**

In case a node receives too few sync frames for rate correction calculation and signals a SyncCalcResult of MISSING_TERM, the rate correction value is set to zero instead to the last calculated value.

Scope:

The erratum is limited to the case of receiving too few sync frames for rate correction calculation (SyncCalcResult=MISSING_TERM in an odd cycle).

Effects:

In the described case a rate correction value of zero is applied in NORMAL_ACTIVE / NORMAL_PASSIVE state instead of the last rate correction value calculated in NORMAL_ACTIVE state. This may lead to a desynchronisation of the node although it may stay in NORMAL_ACTIVE state (depending on gMaxWithoutClockCorrectionPassive) and decreases the probability to re-enter NORMAL_ACTIVE state if it has switched to NORMAL_PASSIVE (pAllowHaltDueToClock=false).

Workaround

It is recommended to set gMaxWithoutClockCorrectionPassive to 1. If missing sync frames cause the node to enter NORMAL_PASSIVE state, use higher level application software to leave this state and to initiate a re-integration into the cluster. HALT state can also be used instead of NORMAL_PASSIVE state by setting pAllowHaltDueToClock to true.

FlexRay AI.090 Flag `SFS.MRCS` is set erroneously although at least one valid sync frame pair is received

Description:

If in an odd cycle $2c+1$ after reception of a sync frame in slot n the total number of different sync frames per double cycle has exceeded `gSyncNodeMax` and the node receives in slot $n+1$ a sync frame that matches with a sync frame received in the even cycle $2c$, the sync frame pair is not taken into account by CSP process. This may cause the flags `SFS.MRCS` and `EIR.CCF` to be set erroneously.

Scope:

The erratum is limited to the case of a faulty cluster configuration where different sets of sync frames are transmitted in even and odd cycles and the total number of different sync frames is greater than `gSyncNodeMax`.

Effects:

In the described case the error interrupt flag `EIR.CCF` is set and the node may enter either the POC state `NORMAL_PASSIVE` or `HALT`.

Workaround

Correct configuration of `gSyncNodeMax`.

FlexRay AI.091 Incorrect rate and/or offset correction value if second Secondary Time Reference Point (STRP) coincides with the action point after detection of a valid frame

Description:

If a valid sync frame is received before the action point and additionally noise or a second frame leads to a STRP coinciding with the action point, an incorrect deviation value of zero is used for further calculations of rate and/or offset correction values.

Scope:

The erratum is limited to configurations with an action point offset greater than static frame length.

Effects:

In the described case a deviation value of zero is used for further calculations of rate and/or offset correction values. This may lead to an incorrect rate and/or offset correction of the node.

Workaround

Configure action point offset smaller than static frame length.

FlexRay AI.092 Initial rate correction value of an integrating node is zero if pMicroInitialOffsetA,B = 0x00**Description:**

The initial rate correction value as calculated in figure 8-8 of protocol spec v2.1 is zero if parameter pMicroInitialOffsetA,B was configured to be zero.

Scope:

The erratum is limited to the case where pMicroInitialOffsetA,B is configured to zero.

Effects:

Starting with an initial rate correction value of zero leads to an adjustment of the rate correction earliest 3 cycles later (see figure 7-10 of protocol spec v2.1). In a worst case scenario, if the whole cluster is drifting away too fast, the integrating node would not be able to follow and therefore abort integration.

Workaround

Avoid configurations with pMicroInitialOffsetA,B equal to zero. If the related configuration constraint of the protocol specification results in

pMicroInitialOffsetA,B equal to zero, configure it to one instead. This will lead to a correct initial rate correction value, it will delay the startup of the node by only one microtick.

FlexRay AI.093 Acceptance of startup frames received after reception of more than gSyncNodeMax sync frames

Description:

If a node receives in an even cycle a startup frame after it has received more than gSyncNodeMax sync frames, this startup frame is added erroneously by process CSP to the number of valid startup frames (zStartupNodes). The faulty number of startup frames is delivered to the process POC. As a consequence this node may integrate erroneously to the running cluster because it assumes that it has received the required number of startup frames.

Scope:

The erratum is limited to the case of more than gSyncNodeMax sync frames.

Effects:

In the described case a node may erroneously integrate successfully into a running cluster.

Workaround

Use frame schedules where all startup frames are placed in the first static slots. gSyncNodeMax should be configured to be greater than or equal to the number of sync frames in the cluster.

FlexRay AI.094 Sync frame overflow flag `EIR.SFO` may be set if slot counter is greater than 1024

Description:

If in the static segment the number of transmitted and received sync frames reaches gSyncNodeMax and the slot counter in the dynamic segment reaches

Functional Deviations

the value $cStaticSlotIDMax + gSyncNodeMax = 1023 + gSyncNodeMax$, the sync frame overflow flag `EIR.SFO` is set erroneously.

Scope:

The erratum is limited to configurations where the number of transmitted and received sync frames equals to `gSyncNodeMax` and the number of static slots plus the number of dynamic slots is greater or equal than $1023 + gSyncNodeMax$.

Effects:

In the described case the sync frame overflow flag `EIR.SFO` is set erroneously. This has no effect to the POC state.

Workaround

Configure `gSyncNodeMax` to number of transmitted and received sync frames plus one or avoid configurations where the total of static and dynamic slots is greater than `cStaticSlotIDMax`.

FlexRay_AI.095 Register RCV displays wrong value**Description:**

If the calculated rate correction value is in the range of $[-pClusterDriftDamping .. +pClusterDriftDamping]$, `vRateCorrection` of the CSP process is set to zero. In this case register `RCV` should be updated with this value. Erroneously `RCV.RCV[11:0]` holds the calculated value in the range $[-pClusterDriftDamping .. +pClusterDriftDamping]$ instead of zero.

Scope:

The erratum is limited to the case where the calculated rate correction value is in the range of $[-pClusterDriftDamping .. +pClusterDriftDamping]$.

Effects:

Functional Deviations

The displayed rate correction value `RCV.RCV[11:0]` is in the range of `[-pClusterDriftDamping .. +pClusterDriftDamping]` instead of zero. The error of the displayed value is limited to the range of `[-pClusterDriftDamping .. +pClusterDriftDamping]`. For rate correction in the next double cycle always the correct value of zero is used.

Workaround

A value of `RCV.RCV[11:0]` in the range of `[-pClusterDriftDamping .. +pClusterDriftDamping]` has to be interpreted as zero.

FlexRay AI.096 Noise following a dynamic frame that delays idle detection may fail to stop slot**Description:**

If (in case of noise) the time between 'potential idle start on X' and 'CHIRP on X' (see Protocol Spec. v2.1, Figure 5-21) is greater than `gdDynamicSlotIdlePhase`, the E-Ray will not remain for the remainder of the current dynamic segment in the state 'wait for the end of dynamic slot rx'. Instead, the E-Ray continues slot counting. This may enable the node to further transmissions in the current dynamic segment.

Scope:

The erratum is limited to noise that is seen only locally and that is detected in the time window between the end of a dynamic frame's DTS and idle detection ('CHIRP on X').

Effects:

In the described case the faulty node may not stop slot counting and may continue to transmit dynamic frames. This may lead to a frame collision in the current dynamic segment.

Workaround

None.

FlexRay AI.097 Loop back mode operates only at 10 MBit/s

Description:

The looped back data is falsified at the two lower baud rates of 5 and 2.5 MBit/s.

Scope:

The erratum is limited to test cases where loop back is used with the baud rate prescaler (`PRTC1.BRP[1:0]`) configured to 5 or 2.5 MBit/s.

Effects:

The loop back self test is only possible at the highest baud rate.

Workaround

Run loop back tests with 10 MBit/s (`PRTC1.BRP[1:0] = 00B`).

FlexRay AI.099 Erroneous cycle offset during startup after abort of start-up or normal operation

Description:

An abort of startup or normal operation by a READY command near the macotick border may lead to the effect that the state INITIALIZE_SCHEDULE is one macrotick too short during the first following integration attempt. This leads to an early cycle start in state INTEGRATION_COLDSTART_CHECK or INTEGRATION_CONSISTENCY_CHECK.

As a result the integrating node calculates a cycle offset of one macrotick at the end of the first even/odd cycle pair in the states INTEGRATION_COLDSTART_CHECK or INTEGRATION_CONSISTENCY_CHECK and tries to correct this offset.

If the node is able to correct the offset of one macrotick (`pOffsetCorrectionOut >> gdMacrotick`), the node enters NORMAL_ACTIVE with the first startup attempt.

If the node is not able to correct the offset error because `pOffsetCorrectionOut ≤ gdMacrotick`, the node enters

ABORT_STARTUP and is ready to try startup again. The next (second) startup attempt is not effected by this erratum.

Scope:

The erratum is limited to applications where READY command is used to leave STARTUP, NORMAL_ACTIVE, or NORMAL_PASSIVE state.

Effects:

In the described case the integrating node tries to correct an erroneous cycle offset of one macrotick during startup.

Workaround

With a configuration of `pOffsetCorrectionOut >> gdMacroTick • (1+cClockDeviationMax)` the node will be able to correct the offset and therefore also be able to successfully integrate.

FlexRay AI.100 First WUS following received valid WUP may be ignored

Description:

When the protocol engine is in state WAKEUP_LISTEN and receives a valid wakeup pattern (WUP), it transfers into state READY and updates the wakeup status vector `CCSV.WSV[2:0]` as well as the status interrupt flags `SIR.WST` and `SIR.WUPA/B`. If the received wakeup pattern continues, the protocol engine may ignore the first wakeup symbol (WUS) following the state transition and signals the next `SIR.WUPA/B` at the third instead of the second WUS.

Scope:

The erratum is limited to the reception of redundant wakeup patterns.

Effects:

Delayed setting of status interrupt flags `SIR.WUPA/B` for redundant wakeup patterns.

Workaround

None.

FlexRay_AI.101 READY command accepted in READY state

Description:

The E-Ray module does not ignore a READY command while in READY state.

Scope:

The erratum is limited to the READY state.

Effects:

Flag `CCSV.CSI` is set. Cold starting needs to be enabled by POC command `ALLOW_COLDSTART (SUCC1.CMD = 1001B)`.

Workaround

None.

FlexRay_AI.102 Slot Status vPOC!SlotMode is reset immediately when entering HALT state

Description:

When the protocol engine is in the states `NORMAL_ACTIVE` or `NORMAL_PASSIVE`, a HALT or FREEZE command issued by the Host resets vPOC!SlotMode immediately to SINGLE slot mode (`CCSV.SLM[1:0] = 00B`). According to the FlexRay protocol specification, the slot mode should not be reset to SINGLE slot mode before the following state transition from HALT to `DEFAULT_CONFIG` state.

Scope:

The erratum is limited to the HALT state.

Effects:

The slot status vPOCISlotMode is reset to SINGLE when entering HALT state.

Workaround

None.

FlexRay AI.103 Received messages not stored in Message RAM when in Loop Back Mode

After a FREEZE or HALT command has been asserted in NORMAL_ACTIVE state, and if state LOOP_BACK is then entered by transition from HALT state via DEF_CONFIG and CONFIG, it may happen that acceptance filtering for received messages is not started, and therefore these messages are not stored in the respective receive buffer in the Message RAM.

Scope:

The erratum is limited to the case where Loop Back Mode is entered after NORMAL_ACTIVE state was left by FREEZE or HALT command.

Effects:

Received messages are not stored in Message RAM because acceptance filtering is not started.

Workaround

Leave HALT state by hardware reset.

FlexRay AI.104 Missing startup frame in cycle 0 at coldstart after FREEZE or READY command

When the E-Ray is restarted as leading coldstarter after it has been stopped by FREEZE or READY command, it may happen, depending on the internal state of the module, that the E-Ray does not transmit its startup frame in cycle 0. Only E-Ray configurations with startup frames configured for slots 1 to 7 are affected by this behaviour.

Scope:

The erratum is limited to the case when a coldstart is initialized after the E-Ray has been stopped by FREEZE or READY command. Coldstart after hardware reset is not affected.

Effects:

During coldstart it may happen that no startup frame is sent in cycle 0 after entering COLDSTART_COLLISION_RESOLUTION state from COLDSTART_LISTEN state.

Severity:

Low, as the next coldstart attempt is no longer affected. Coldstart sequence is lengthened but coldstart of FlexRay system is not prohibited by this behaviour.

Workaround

Use a static slot greater or equal 8 for the startup / sync message.

FlexRay AI.105 RAM select signals of IBF1/IBF2 and OBF1/OBF2 in RAM test mode

When accessing Input Buffer RAM 1,2 (IBF1,2) or Output Buffer RAM 1,2 (OBF1,2) in RAM test mode, the following behaviour can be observed when entering RAM test mode after hardware reset.

- Read or write access to IBF2:
 - In this case also IBF1 RAM select **eray_ibf1_cen** is activated initiating a read access of the addressed IBF1 RAM word. The data read from IBF1 is evaluated by the respective parity checker.
- Read or write access to OBF1:
 - In this case also OBF2 RAM select **eray_obf2_cen** is activated initiating a read access of the addressed OBF2 RAM word. The data read from OBF2 is evaluated by the respective parity checker.

If the parity logic of the erroneously selected IBF1 resp. OBF2 detects a parity error, bit **MHDS.PIBF** resp. **MHDS.POBF** in the E-Ray Message Handler Status register is set although the addressed IBF2 resp. OBF1 had not error. The logic for setting **MHDS.PIBF** / **MHDS.POBF** does not distinguish between set conditions from IBF1 or IBF2 resp. OBF1 or OBF2.

Due to the IBF / OBF swap mechanism as described in section 5.11.2 in the E-Ray Specification, the inverted behaviour with respect to IBF1,2 and OBF1,2 can be observed depending on the IBF / OBF access history.

Scope:

The erratum is limited to the case when IBF1,2 or OBF1,2 are accessed in RAM test mode. The problem does not occur when the E-Ray is in normal operation mode.

Effects:

When reading or writing IBF1,2 / OBF1,2 in RAM test mode, it may happen, that the parity logic of IBF1,2 / OBF1,2 signals a parity error.

Severity:

Low, workaround available.

Workaround

For RAM testing after hardware reset, the Input / Output Buffer RAMs have to be first written and then read in the following order: IBF1 before IBF2 and OBF2 before OBF1

FlexRay AI.106 Data transfer overrun for message transfers Message RAM to Output Buffer (OBF) or from Input Buffer (IBF) to Message RAM

The problem occurs under the following conditions:

- 1) A received message is transferred from the Transient Buffer RAM (TBF) to the message buffer that has its data pointer pointing to the first word of the Message RAM's Data Partition located directly after the last header word of the Header Partition of the Last Configured Buffer as defined by **MRC.LCB**.
- 2) The Host triggers a transfer from / to the Last Configured Buffer in the Message RAM with a specific time relation to the start of the TBF transfer described under 1).

Under these conditions the following transfers triggered by the Host may be affected:

a) Message buffer transfer from Message RAM to OBF

When the message buffer has its payload configured to maximum length (PLC = 127), the OBF word on address 00h (payload data bytes 0 to 3) is overwritten with unexpected data at the end of the transfer.

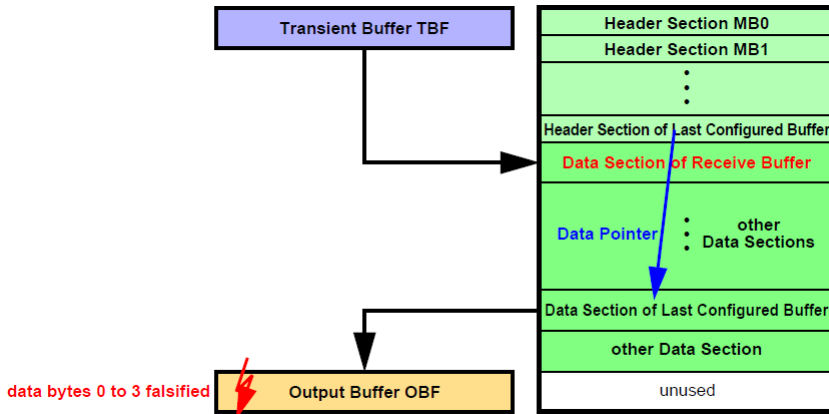


Figure 2 Message buffer transfer from Message RAM to OBF

b) Message buffer transfer from IBF to Message RAM

After the Data Section of the selected message buffer in the Message RAM has been written, one additional write access overwrites the following word in the Message RAM which might be the first word of the next Data Section.

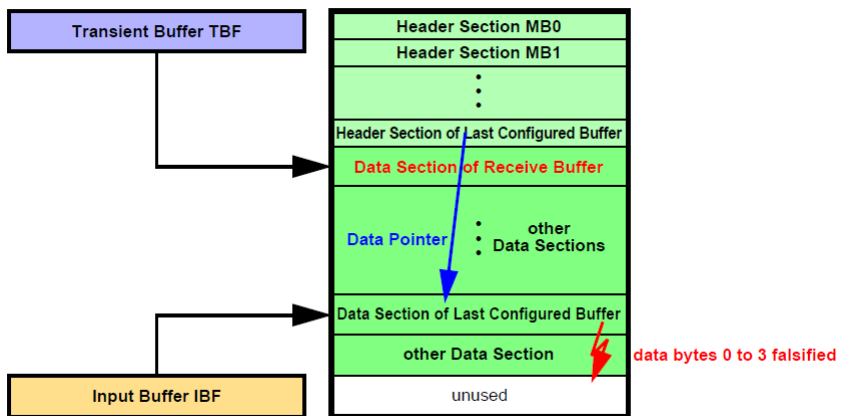


Figure 3 Message buffer transfer from IBF to Message RAM

Scope:

The erratum is limited to the case when (see [Figure 4 “Bad Case”](#)):

- 1) The first Data Section in the Data Partition is assigned to a receive buffer (incl. FIFO buffers)

AND

- 2) The Data Partition in the Message RAM starts directly after the Header Partition (no unused Message RAM word in between)

Effects:

- a) When a message is transferred from the Last Configured Buffer in the Message RAM to the OBF and **PLC** = 127 it may happen, that at the end of the transfer the OBF word on address 00h (payload data bytes 0 to 3) is overwritten with unexpected data (see [Figure 2](#)).
- b) When a message is transferred from IBF to the Last Configured Buffer in the Message RAM, it may happen, that at the end of the transfer of the Data Section one additional write access overwrites the following word, which may be the first word of another message's Data Section in the Message RAM (see [Figure 3](#)).

Severity:

Medium, workaround available, check of configuration necessary.

Workaround

1) Leave at least one unused word in the Message RAM between Header Section and Data Section.

OR

2) Ensure that the Data Section directly following the Header Partition is assigned to a transmit buffer.

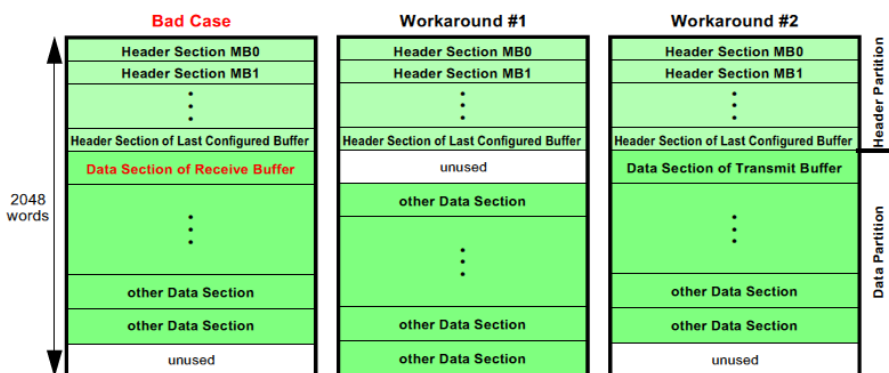


Figure 4 Message RAM Configurations

GETH AI.001 Packets with Destination Address (DA) mismatch are delayed until EOP is received in threshold (cut-through) mode

For each received packet, Header status is created by the MAC receiver based on the parsing of the Ethernet/VLAN/IP Header fields and forwarded to the DMA. This header status includes information about the size of the L2/L3/L4 header data (SPLIT_HDR_EN configurations) and/or the DMA Channel (NUM_DMA_RX_CH>1 configuration) which will forward the packet to host memory. The DA match result would provide DMA channel information based on the DCS field in the corresponding MAC Address Register that matched the DA field.

Functional Deviations

Due to this defect, instead of waiting for the DA match operation to complete, the design was waiting for a successful DA match to happen. If a DA match did not happen, the Header Status was being generated at the time of receiving the End of Packet (EoP).

The MTL Rx Queue controller waits for the Header status, stores it before it forwards the packet to target Rx DMA. Since the packets without a successful DA match were not getting the header status until the EoP, MTL Rx Queue controller forwards the packet only after the EoP is received in cut through mode.

Impacted Use Cases:

The DA mismatch packets will be forwarded only when Receive All or Promiscuous mode is set. In other use-cases, packets with DA mismatch will get dropped by the MTL Rx Queue controller and never reach the RxDMA.

Consequence:

Additional/un-necessary latency is introduced in the transfer of received packets with DA mismatch in the MTL Rx Queue operating in threshold (cut-through) mode. Effectively, it operates in store and forward mode for such packets.

Method of Reproducing:

1. Enable Receive All or Promiscuous mode for the receiver by programming MAC_Packet_Filter register.
2. Enable Threshold (Cut-through) mode and program the threshold value by writing to RSF and RTC fields of MTL_RxQ<n>_Operation_Mode.
3. When a packet with a packet length greater than threshold value is received, and a DA match does not happen, the packet will be read out of MTL Rx FIFO only after the EoP is received, while the expected behavior would have been to read the packet after the threshold is crossed.

Workaround:

None.

GETH_AI.008 Application Error Along with Start-of-Packet Can Corrupt the FCS Field of the Previous Frame in the MAC Pipeline

On the MAC Transmit Interface (MTI) if an application error indication is asserted along with the Start of Packet of a new packet while the MAC is transmitting a packet, the error indication can corrupt the FCS field of the packet being transmitted. This defect manifests because the error indication is inadvertently passed to the MAC transmitter logic directly when sampled along with the Start of Packet indication.

The scenario that causes the problem is:

- Bus error on the first beat of frame data read from the application.

Impacted Use Cases:

This issue occurs when Bus Error is received from the system along with the first beat of new packet data, manifesting as error indication and Start of Packet indication asserted simultaneously during an ongoing packet transmission.

Consequence:

The packet in transmission is sent with corrupted FCS and therefore the remote end discards it.

Workaround:

Discard pending data on bus error and re-init the GETH.

GETH_AI.009 Corrupted Rx Descriptor Write Data

Packets received by `DWC_ether_qos` are transferred to the system memory address space as specified in the receive descriptor prepared by the software. After transferring the packet to the system memory, `DWC_ether_qos` updates the descriptor with the packet status.

However, due to a defect in the design, the Rx packet status gets corrupted when the MTL Rx FIFO status becomes empty during the packet status read. This can happen only when the MTL Rx FIFO is in Threshold (cut through) mode and Frame based arbitration is enabled on the receive.

Impacted Use Cases:

The defect is applicable when the Rx FIFO is in Threshold (Cut-through) mode and Frame based arbitration is enabled in the RxFIFO.

MTL Rx FIFO working in cut-through mode (bit[5], RSF in MTL_RxQ[n]_Operation_Mode register is set to 0, the default value) and

MTL Rx FIFO is enabled to work in Frame Based Arbitration (bit[3], RXQ_FRM_ARBIT in MTL_RxQn_Control register is set to 1).

Consequence:

The Rx packet status written into the descriptor for the affected packet is corrupt. All subsequent frames are processed as expected.

Workaround:

Do not use cut through OR/AND do not use RX arbitration.

GETH_AI.010 Fatal Bus Error Interrupt Might Be Generated for Incorrect DMA Channel

When a bus error occurs, the status reflects the associated RX DMA channel number.

When the current burst or packet transfer is about to end, the MTL arbiter might grant access to another Rx DMA channel for the next burst or packet transfer (with ari_chnum signal indicating the channel number of Rx DMA that is granted latest access).

However due this defect, when bus error occurs towards end of current burst, the DMA might associate it with Rx DMA channel of next burst (based on the ari_chnum) and provide the incorrect Rx DMA channel number in the status register.

Impacted Use Cases:

Cases where the MTL arbiter has already granted access to another Rx DMA channel for next burst transfer and bus error occurs for current burst.

Consequence:

A wrong Rx DMA channel number is reported for the Fatal Bus Error interrupt.

Workaround:

Discard pending data on bus error and re-init the GETH. Debugger can not rely on DMA Status register after bus error of a RX Burst.

GETH AI.011 Receive Queue Overflow at End of Frame Along with SPRAM Read-Write Conflict Can Cause Data Loss

Read and write operations can conflict, based on the address being read and written. During a conflict in the MTL Receive FIFO, the read operation gets priority and the write operation is retried in the subsequent cycle.

When End of Frame (EoF) is received, the MTL Receiver computes FIFO overflow condition based on the anticipated space needed to write End of Frame (EoF) and RxStatus. When EoF is received on MRI interface and a read-write conflict occurs in the SPRAM for the EoF write along with a FIFO overflow computation, it causes the MTL Receive FSM to malfunction.

Impacted Use Cases:

This issue occurs when the MTL Receive FIFO has a read-write conflict and the Rx FIFO computes an overflow condition upon receiving EoF in the MRI interface.

Consequence:

The packet that causes MTL FIFO overflow is handled correctly. However due to the malfunctioning of MTL receive FSM, the subsequent packet loses a part of the data at the beginning of the frame.

Workaround:

Discard pending data on bus error and re-init the GETH.

GETH_AI.012 Incorrect Flexible PPS Output Interval When Fine Time Correction Method is Used

The MAC provides programmable option, fine and coarse, for correcting the IEEE 1588 internal time reference.

When coarse correction method is used, the correction is applied in one shot and does not affect the flexible PPS output.

When fine correction method is used, the correction is applied uniformly and continuously to the IEEE 1588 internal time reference as well as to the flexible PPS output.

However, due to this defect, when fine correction method is used and the drift in the frequency of the clock that drives the IEEE 1588 internal time reference is large (when compared with the grandmaster source clock), the flexible PPS output interval is incorrect. This does not impact the IEEE 1588 internal time reference updates.

The internal PPS counter used for generating the PPS interval is incorrectly reset earlier than expected, resulting in the next PPS cycle starting incorrectly, earlier than expected.

Impacted Use Cases:

The Flexible PPS Output feature is used in Pulse Train mode and the Fine Correction method is used for correcting the IEEE 1588 internal time reference due to drift in the frequency of the clock that drives it.

Consequence:

The incorrect Flexible PPS Output Interval from the MAC can cause the external devices, that are synchronized with flexible PPS trigger outputs, to go out of synchronization.

Workaround:

The application can use coarse method for correcting the IEEE 1588 internal time reference. Because, in the coarse correction method, as the time correction is applied in a single shot, timestamp captured for at the most one packet is impacted. This might be the case when current cycle of time-synchronization related packet-exchanges coincides with the coarse time

correction of previous cycle. This discrepancy is corrected in the next time-synchronization correction cycle.

GETH_AI.013 False Dribble and CRC Error Reported in RMII PHY 10Mbps Mode

The MAC receiver clock is derived synchronously from RMII REF_CLK, the frequency is 2.5MHz in 10Mbps speed mode and 25MHz in 100Mbps speed mode. In 10 Mbps mode, the 2-bit RMII data is captured every 10 cycles of RMII REF_CLK, combined and provided as 4-bit data on the MAC receiver clock. As per RMII protocol, the RMII CRS_DV is asserted asynchronously with RMII REF_CLK, which also implies that it is asynchronous to the MAC receiver clock. The MAC correctly captures the received packet irrespective of the phase relation between RMII CRS_DV assertion and MAC receiver clock.

However due to this defect, in the 10Mbps speed mode, when the RMII CRS_DV is asserted two RMII REF_CLK rising edges ahead of MAC receiver clock, the MAC reports false dribble and CRC error in the Receive status. The dribble error is reported when MAC receives odd number of nibbles (4-bit words) and CRC error is additionally reported. In this case the additional nibble captured is a repetition of the last valid nibble. The MAC forwards only the data received on byte boundaries to the software and ignores the extra nibble. Therefore, there is no data loss or corruption of packet forwarded to the software. However, if error-packet drop is enabled (FEP bit in MTL_RxQ(#i)_Operation_Mode register is set to 0), MAC drops the packets, causing packet loss and impacts the performance.

Impacted Use Cases:

The RMII PHY interface is enabled for 10Mbps operation and RMII CRS_DV is asserted two RMII REF_CLK rising edges ahead of MAC receiver clock.

Consequence:

The MAC reports false dribble and CRC error in Receive status. If error-packet drop is enabled, (FEP bit in MTL_RxQ(#i)_Operation_Mode register is set to 0), MAC drops the packets causing packet loss and impacts the performance. If the error-packet drop is disabled (FEP bit in MTL_RxQ(#i)_Operation_Mode

register is set to 1), MAC forwards the packet to the software, up to the byte boundary, and there is no data loss or corruption.

Workaround:

If error-packet drop is enabled (FEP bit in MTL_RxQ(#i)_Operation_Mode register is set to 0), software can disable it and take the dropping decision based on the Rx status. If the dropping of error packets is disabled (FEP bit in MTL_RxQ(#i)_Operation_Mode register is set to 1), software can ignore the dribble and CRC error and accept packets that have both these errors together. The occurrence of real dribble error is rare and happens when there are synchronization issues due to faulty clock recovery.

GETH_AI.014 Receive DMA Channel Generates Spurious Receive Watchdog Timeout Interrupt

Programming the RWT field in DMA_CH(#i)_Rx_Interrupt_Watchdog_Timer register to a non-zero value enables the Receive DMA for generating the Receive Watchdog Timeout Interrupt. The RWTU field in the same register is used for selecting the units (in terms of number of system clock cycles) for the value programmed in the RWT field. The Receive Watchdog timer starts when the RWT field is programmed to a non-zero value, and if the Receive descriptors corresponding to the packet does not have the completion interrupt enabled. When the timer equals the programmed number of system clock cycles, Receive DMA sets the Receive Interrupt status (RI bit in DMA_CH(#i)_Status register). The interrupt is generated on `sbd_intr_o` or `sbd_perch_rx_intr_o[i]` based on the INTM field in DMA_Mode register, when both RIE and NIE bits in DMA_CH(#i)_Interrupt_Enable register are set to 1.

However due to the defect, when the non-zero value programmed in the RWTU field (timer programmed to count in units of 512, 1024, or 2048 system clock cycles) reaches the timer logic earlier than the value programmed in RWT field, a spurious Receive Watchdog Timeout Interrupt is generated. This is because the logic incorrectly checks for concatenation of RWTU and RWT fields to be non-zero instead of checking only the RWT field; this triggers the comparison of RWT field with timer bits shifted left by the value in the RWTU field. As the timer has not started, its initial value of zero matches the default value of zero

Functional Deviations

of the RTW field, which incorrectly sets the Receive Interrupt status (RI bit in DMA_CH(#i)_Status register). The interrupt is generated on `sbd_intr_o` or `sbd_perch_rx_intr_o[i]` based on INTM field in DMA_Mode register when both RIE and NIE bits in DMA_CH(#i)_Interrupt_Enable register are set to 1.

The delay in the programmed value of RWT field reaching the timer logic with respect to programmed value in RWTU field can be due to following reasons:

1. The software performs a byte-wide write with byte containing RWTU field written first.
2. The software performs a 32-bit wide write access, but two separate writes are performed, first one to program RWTU field and second one to program RWT field. This may not be an efficient use case and is not widely used.
3. The software performs a 32-bit wide write access and writes both RWTU and RWT fields together, but there is different synchronization delay from CSR clock domain to system clock domain on both these paths (the configurations in which `DWC_EQOS_CSR_SLV_CLK` is selected).

The issue is not observed when:

1. A zero value is written in RWTU field (timer programmed to count in units of 256 system clock cycles) and non-zero value is written in RWT field.
2. A single write access with non-zero value written in RWTU field (timer programmed to count in units of 256 system clock cycles) and non-zero value written in RWT field.

This issue does not have any functional impact; on receiving the spurious Receive Watchdog Timeout Interrupt the software triggers processing of received packets, it does not find any Receive descriptor closed by the Receive DMA and exits the Interrupt Service Routine (ISR). This has a very insignificant impact on the software performance.

Impacted Use Cases:

The completion interrupt is not enabled in Receive Descriptors and periodic Receive Watchdog Timeout Interrupt is enabled (timer programmed to count in units of 512, 1024, or 2048 system clock cycles) by software for bulk processing of the received packets.

Consequence:

The software enters the Interrupt Service Routine (ISR) to process the received packets. But it does not find any received packet to process and exits, which has very insignificant impact on the software performance.

Workaround:

1. When the software performs a byte-wide write, the byte containing RWT field must be written prior to the byte containing RWTU field.
2. When the software performs a 32-bit wide write access, but two separate writes are performed to program RWTU field and RWT field, the RWT field must be written prior to the RWTU field.
3. When the software performs a 32-bit wide write access and writes both RWTU and RWT fields together, two separate writes must be performed; RWT field must be written prior to the RWTU field.

GETH_AI.015 MAC Receive VLAN Tag Hash Filter Always Operates in Default Mode

The ETV, DOVLTC, and ERSVLM bits of the MAC_VLAN_Tag (Extended Receive VLAN filtering is not selected) or MAC_VLAN_Tag_Ctrl (Extended Receive VLAN filtering is selected) register are used to program the mode of operation of the Receive VLAN Hash Filtering. The ETV bit is used to enable computation of Hash for only 12 bits of VLAN Tag. The DOVLTC bit is used to disable VLAN Type Check for VLAN Hash filtering. The ERSVLM bit is used to enable VLAN Hash filtering for S-VLAN Type.

However, due to this defect, the Receive VLAN Hash filter always operates in default mode, that is, VLAN Hash is computed for 16-bits (ETV=0) of C-VLAN Tag (DOVLTC=0 and ERSVLM=0). Therefore, programming of ETV, DOVLTC, or ERSVLM bits to 1 do not take effect because these bits have incorrect read-only attribute.

As a result, unintended packets might be forwarded to the application due to incorrect filter pass or bypass results/status. Also, packets might be dropped in the MAC due to incorrect filter fail result.

Impacted Use Cases:

The defect is applicable when non-default VLAN Hash filtering modes are programmed, that is, one or more of ETV, DOVLTC, and ERSVLM bits are set to 1.

Consequence:

Forwarding unintended packets to the application can lead to performance degradation in the software stack due to additional processing overhead. Dropping unintended packets results in packet loss requiring retransmission, which never succeeds. This again leads to performance degradation. This is a static issue and the software can avoid it by following the procedure mentioned in the Workaround section.

Workaround:

The software should disable the Receive VLAN Hash filtering by setting the VTHM bit of the MAC_VLAN_Tag_Ctrl register to 0 (when non-default VLAN Hash filtering mode is required) and use the alternative filtering methods available in the hardware (perfect or inverse VLAN filtering) or perform filtering in software.

GETH_AI.016 Receive DMA Header Split Function Incorrectly Overruns the Allocated Header Buffer

When the Header Split function is enabled, the DWC_ether_qos identifies the boundary between Header (L2 layer Header or TCP/IP Header) and the payload and stores the header and payload data in separate buffers in the host memory. The size of the allocated Header buffer depends on the HDSMS field in the MAC_Ext_Configuration register expressed in terms of Data-width. When the buffer address start address is not aligned to the Data-width, the Receive DMA writes that many lesser bytes in the allocated Header buffer. If the Header cannot be accommodated in allocated Header buffer, the Receive DMA indicates in the status that the packet data is not split into header and payload buffer.

Functional Deviations

However, due to this defect, when the Header buffer start address is not aligned to the Data-width the Receive DMA Header Split function incorrectly overruns the allocated Header buffer. The overrun happens only when the Header size in the received packet is equal or less (by up to the number of bytes which could not be written due to buffer start offset) than the HDSMS field in MAC_Ext_Configuration register.

Impacted Use Cases:

The Header Split function is enabled and the Header buffer start address is not aligned to the Data-width.

Consequence:

The bytes written beyond the allocated buffer corrupts the data at that location in memory.

Method of Reproducing:

Program the SPH bit in DMA_CH(#i)_Control register to 1, to enable the Split Header function in Receive DMA.

Program the HDSMS field in MAC_Ext_Configuration register to 0, to enable splitting of headers up to 64 bytes.

Set up Receive descriptor with Header buffer start address offset of 1.

Generate and send receive packet with a header size of 64 bytes.

Observe that the last byte of the header is written beyond allocated Header buffer.

Workaround:

The software should always allocate header buffers with start address aligned to Data-width (64 bit) or the HDSMS field in MAC_Ext_Configuration register should be programmed to a value larger than the largest expected Header size in receive packet by a number of bytes equal or more than one Data-width (aligned to 64 bit).

GETH_AI.017 Carrier-Sense Signal Not Generated When False Carrier Detected in RGMII 10/100 Mbps Mode

The RGMII PHY interface generates the carrier-sense signal (CRS) when a packet is transmitted, or when a packet, carrier extension, carrier extend error, carrier sense, or false carrier is received. The CRS is used for generating the COL (Collision) signal in half-duplex mode, when transmission and reception occur simultaneously, or for deferring the transmission.

However, due to the defect, when false carrier is detected in RGMII 10/100Mbps mode, CRS is not generated. This is because the logic incorrectly checks for alternate 0xE and 0x0 pattern as expected in 1000 Mbps mode instead of the expected continuous 0xE pattern in 10/100 Mbps mode.

Impacted Use Cases:

The RGMII PHY interface is enabled and operated in 10/100 Mbps speed mode.

Consequence:

In Full-Duplex mode, when ECRSFD bit of the MAC_Configuration register is programmed to 1, MAC does not defer the transmit packet when false carrier is received. This can result in loss of transmitted packet, requiring retransmission.

In Half-Duplex mode, the MAC does not defer the transmit packet because CRS is not generated when false carrier is received. This results in collision; as COL signal is not generated, the MAC transmitter incorrectly considers successful transmission of the packet. The corresponding MMC counters are incorrectly updated in configurations where MMC counters are selected.

Method of Reproducing:

Enable RGMII PHY interface (GPCTL.EPR = 001_B).

Enable 100 Mbps mode by programming both PS and FES bits of the MAC_Configuration register to 1'b1.

In Full-Duplex transmission mode, enable Carrier Sense by programming ECRSFD field of the MAC_Configuration register to 1'b1.

Generate and send multiple back-to-back packets from MAC transmitter.

Send false carrier (0xE) pattern to the MAC receiver while packet transmission is in progress.

Observe that the MAC transmitter does not defer the packet transmission when false carrier pattern is received.

Workaround:

None required; false carrier error occurs rarely. The application layer detects the loss of packet and triggers retransmission.

GETH_AI.018 Description of the Transmit Checksum Offload Engine - Documentation update

In GETH chapter “Description of the Transmit Checksum Offload Engine” in the TC3xx User’s Manual, the text and formula shall be replaced by the updated description below.

Update to chapter “Description of the Transmit Checksum Offload Engine”

The checksum offload engine module supports two types of checksum calculation and insertion. The checksum engine can be controlled for each packet by setting the CIC bits (TDES3 Bits[17:16]).

The checksum for TCP, UDP, or ICMP is calculated over a complete packet, and then inserted into its corresponding header field. Because of this requirement, when this function is enabled, the Tx FIFO automatically operates in the store-and-forward mode even if the DWC_ether_qos is configured for Threshold (cut-through) mode.

You must make sure that the Tx FIFO is deep enough to store a complete packet before that packet is transferred to the MAC transmitter. The reason being that when space is not available to accept the programmed burst length of data, then the MTL Tx FIFO starts reading to avoid dead-lock. In such a case, the COE fails as the start of the packet header is read out before the payload checksum can be calculated and inserted. Therefore, you must enable the checksum insertion only in the packets that are less than the number of bytes, given by the following equation:

- Packet size < TxQiSize - ((DMA_CHi_TX_Control.TxPBL + 7) * 4),
 - where TxQiSize is configured using MTL_TxQi_Operation_Mode.TQS

GETH_TC.001 Reference clock for Time Stamp Update logic is f_{GETH}

When using PTP (Precision Time Protocol), take into account the following specification delta:

- Unlike described in table “Clock Lines of Ethernet MAC” in the Appendix to the TC3xx User’s Manual, the PTP reference clock clk_ptp_ref_i (Reference Clock for the Time Stamp Update Logic) is **not** connected to f_{SRI} .
- Instead clk_ptp_ref_i is connected to f_{GETH} :
 - $clk_ptp_ref_i = f_{GETH} =$ AHB master interface clock.

As this results in a different reference frequency, clock dividers for the PTP time stamp engine and the achievable time stamp precision need to be calculated on the basis of f_{GETH} .

GETH_TC.002 Initialization of RGMII interface

If RGMII mode (GETH_GPCTL.EPR = 001) is configured and GREFCLK (Gigabit Reference Clock) is running during initialization (including a kernel reset), a persistent communication failure may occur due to an internal synchronization issue, resulting in a phase shift of the Transmit Clock TXCLK relative to TXD/TXCTL of $\pm 180^\circ$ (@1000Mbit/s), or $\pm 36^\circ$ (@100Mbit/s), or $\pm 3.6^\circ$ (@10Mbit/s).

Note: For MII and RMII see Application Hint GETH_AI.H001.

Workaround

After the required I/O settings have been configured (see also section “IO Interfaces” in the GETH chapter of the TC3xx User’s Manual) and the module clock is enabled and GREFCLK and RXCLK are running, follow the initialization sequence listed below:

- Finish active transfers and make sure that transmitters and receivers are set to stopped state:

- Check the RPSx and TPSx status bit fields in register DMA_DEBUG_STATUS0/1.
- Check that MTL_RXQ0_DEBUG, MTL_RXQi_DEBUG, MTL_TXQ0_DEBUG and MTL_TXQi_DEBUG register content is equal to zero.
Note: it may be required to wait $70 f_{SPB}$ cycles after the last reset before checking if RXQSTS in MTL_RXQ0_DEBUG and MTL_RXQi_DEBUG are zero.
- Wait until a currently running interrupt is finished and globally disable GETH interrupts.
- Ensure GETH_GPCTL.EPR = 000_B .
- Ensure GETH_SKEWCTL = $0x0$.
- Apply a kernel reset to the GETH module:
 - Deactivate Endinit protection, as registers KRST0/1 and KRSTCLR can only be written in Supervisor Mode and when Endinit protection is not active.
Write to corresponding RST bits of KRST0/1 registers to request a kernel reset. The reset status flag KRST0.RSTSTAT may be cleared afterwards by writing to bit CLR in the KRSTCLR register.
Re-activate Endinit protection.
 - Wait $35 f_{SPB}$ cycles.
- Set GETH_GPCTL.EPR = 001_B (RGMII).
- Setup GETH_SKEWCTL if required.
- Perform a software reset by writing to the DMA_MODE.SWR bit.
Wait $4 f_{SPB}$ cycles, then check if DMA_MODE.SWR = 0_B .
- Configure remaining GMAC registers according to application requirements.

GTM_AI.254 TIM TDU: TDU_STOP=b101 not functional

Stop counting of register TO_CNT on an tdu_word_event or stop counting of TO_CNT1 on a tdu_frame_event is not possible.

Scope

TIM

Effects

TO_CNT1, TO_CNT can not be stopped counting.

Workaround

No workaround available.

GTM AI.304 MCS: Scheduling modes Single Prioritization and Multiple Prioritization are not functional

If an MCS instance is configured with the Single or Multiple Prioritization Scheduling mode and the last non-suspended and prioritized MCS channel (CLP) is entering its suspended state (which means that the MCS starts scheduling the remaining non-prioritized channels with accelerated scheduling scheme) and if the suspended state of CLP is resumed five clock cycles after it was entering the suspended state the MCS channel CLP is not executing the instruction that is following the suspending instruction.

Scope

MCS

Effects

The program execution of a prioritized MCS channel can skip an instruction that is directly following a suspending instruction.

Workaround

Add an additional NOP instruction after all suspending instructions (WURM, WURMX, WURCX, WUCE, ARD, ARDI, NARD, NARDI, AWR, AWRI, BRD, BRDI, BWR, and BWRI) in a prioritized MCS program.

GTM_AI.306 DPLL: DPLL_NUTC.syn_t_old, DPLL_NUSC.syn_s_old not updated according specification

The DPLL specification defines for DPLL_NUTC.WSYN=1 that an update of register DPLL_NUTC allows writing of the bits DPLL_NUTC.syn_t while DPLL_NUTC.syn_t_old inherits the previous value of DPLL_NUTC.syn_t.

Differing from the specified behavior the actual hardware does not update the value of DPLL_NUTC.syn_t_old with the previous value of DPLL_NUTC.syn_t but instead updates DPLL_NUTC.syn_t_old according to the corresponding bits of the write operation executed by the CPU.

The DPLL specification defines for DPLL_NUTC.WSYN=1 that an update of register DPLL_NUSC allows writing of the bits DPLL_NUSC.syn_s while DPLL_NUSC.syn_s_old inherits the previous value of DPLL_NUSC.syn_s.

Differing from the specified behavior the actual hardware does not update the value of DPLL_NUSC.syn_s_old with the previous value of DPLL_NUSC.syn_s but instead updates DPLL_NUSC.syn_s_old according to the corresponding bits of the write operation executed by the CPU.

Scope

DPLL

Effects

The registers bits DPLL_NUTC.syn_t_old are not updated with the previous value of DPLL_NUTC.syn_t but by the bits of the input data word.

The registers bits DPLL_NUSC.syn_s_old are not updated with the previous value of DPLL_NUSC.syn_s but by the bits of the input data word.

Workaround

If the update of syn_t/s_old shall be done like described in the specification the register DPLL_NU(T/S)C.syn_t/s must be read first, then the DPLL_NU(T/S)C.syn_(t/s) can be used to modify the bits which are written to DPLL_NU(T/S)C.syn_(t/s)_old.

As the current behavior of DPLL_NUT/SC.syn_s/t_old is in use by and can be advantageous for certain applications, there is no intend to change the current

hardware behavior at this point in time. Instead a specification update to align the specification with the current hardware behavior is planned for future GTM generations.

GTM_AI.307 IRQ: AEI_IM_ADDR is not set in GTM_IRQ_NOTIFY register if cluster 0 is disabled

Bit 2 - AEI_IM_ADDR - in register GTM_IRQ_NOTIFY is not set and the related error interrupt (if enabled) does not occur if cluster 0 is disabled and

- an FPI read or write access to a cluster 0 register
OR
- an illegal FPI write access to any enabled cluster is done.

In case BRIDGE_MODE.MSK_WR_RSP = 0x0 (not recommended) an FPI bus error is issued for all write accesses.

Scope

IRQ

Effects

See description above.

Workaround

- a) Do not disable cluster 0.
- b) If cluster 0 is disabled: after each WRITE access check register GTM_AEI_STA_XPT; if the read value is >0, it signs an access error.
- c) If cluster 0 is disabled: do not read from cluster 0 register or any other disabled cluster register.

GTM_AI.308 TIM, ARU: Limitation that back-to-back TIM data transfers at full ARU clock rate cannot be transferred correctly with ARU dynamic routing feature

If TIM input signals with signal changes faster or equal than ARU clock rate are processed with the TIM and the results are routed via ARU in dynamic routing

mode, it is likely that there is a data loss and only each second data can be transferred.

Scope

ARU Routing, DEBUG signal interface

Effects

- a) If the ARU CADDR is kept stable and data is transferred back-to-back for 2 or more consecutive aru clock cycles while operating in ARU dynamic routing mode, then every second data provided by the TIM module gets lost.
- b) Debugging of an ARU data transfer not completely correct. Every second GTM_DBG_ARU_DATAi_val signal missing.

Workaround

Do not use the dynamic routing feature of ARU in the manner that the same ARU caddr is served for multiple cycles with back-to-back data transfers.

Ensure that every ARU clock cycle the CADDR address will change.

GTM_AI.318 MCS: NARD(I) instruction terminates unexpectedly

If the bit field CFG_CLK_RATE of register CCM[i]_HW_CONF is set and an MCS runs on a cluster i while bit field CLSc_CLK_DIV of register GTM_CLS_CLK_CFG is set to 1, the execution of a NARD or NARDI instruction might signalize an unsuccessful data transfer (bit field SAT of internal MCS register STA is cleared) although the data source has data available for sending. The unexpected behavior depends on the current state of the internal ARU counter.

Scope

MCS

Effects

The available data from the ARU source is not sent via ARU.

Workaround

None. However, typical applications that are polling data sources with the NARD or NARDI instruction do not have to concern about this errata since the polling loop just requires more iterations.

GTM_AI.319 (A)TOM: Unexpected (A)TOM_CCU1TCx_IRQ in up/down counter mode

If the up-down counter mode is activated (bit field UDMODE of register (A)TOM[i]_CH[x]_CTRL is set to a value greater than zero) and the interrupt (A)TOM_CCU1TCx_IRQ is enabled (bit field CCU1TC_IRQ_EN of register (A)TOM[i]_CH[x]_IRQ_EN is set), the interrupt signal (A)TOM_CCU1TCx_IRQ will be set unexpectedly directly after the interrupt (A)TOM_CCU0TCx_IRQ was set and indicates that the counter (A)TOM[i]_CH[x]_CN0 reaches (A)TOM[i]_CH[x]_CM0.

Scope

TOM/ATOM

Effects

Interrupt signal (A)TOM_CCU1TCx_IRQ is set unexpectedly.

Workaround

If the interrupt (A)TOM_CCU1TCx_IRQ is needed, it can be disabled by the first occurrence of itself and enabled again with the interrupt (A)TOM_CCU0TCx_IRQ. With the following occurrence of the interrupt (A)TOM_CCU1TCx_IRQ it will be disabled again and so on.

GTM_AI.320 ATOM: Unexpected restart of a SOMS oneshot cycle while ATOM[i]_CH[x]_CM0 is zero

If ATOM is set to SOMS oneshot mode (bit field MODE of ATOM[i]_CH[x]_CTRL is set to 0b11 and bit field OSM in register ATOM[i]_CH[x]_CTRL is set) a oneshot cycle is started immediately by writing

Functional Deviations

a value unequal to zero to ATOM[i]_CH[x]_SR0 register while the value of ATOM[i]_CH[x]_CM0 register is zero.

Scope

ATOM

Effects

Restarting of a oneshot cycle starts immediately while ATOM[i]_CH[x]_CM0 is zero and a write access to ATOM[i]_CH[x]_SR0 is executed with a value unequal to zero.

Workaround

Avoid value 0 in ATOM[i]_CH[x]_CM0 register if SOMS oneshot mode is enabled (bit field OSM in register ATOM[i]_CH[x]_CTRL).

GTM_AI.322 DPLL: PSTC, PSSC not updated correctly after fast pulse correction completed (DPLL_CTRL1.PCM1/2 = 0)

When additional pulses are requested using DPLL_CTRL_11.PCMF1/2=1 AND PCMF1/2_INCCNT_B=0 the PSTC/PSSC parameters as well as NMB_T/S_TAR are not updated correctly, because either the amount of additional pulses (MPVAL1/2) are not incremented or NMB_T/S_TAR is set to a wrong value.

Scope

DPLL

Effects

After the pulse correction is performed the fields NMB_T/S_TAR are set to wrong values such that after a new input event the parameters PSTC/PSSC are not updated correctly.

Incorrect PSTC/PSSC values are ending up in wrong NA[i] parameters. These wrong NA[i] values are leading to incorrect PMT calculations.

The pulse generation itself (register DPLL_INC_CNT1/2 and the status of the angle clocks TBU_TS1/2) is correct and not affected by this issue.

Workaround

Implement the workaround in the TISI interrupt, i.e. start the workaround at the arrival of inactive edge. This ensures that swon_t/swon_s is stable and the incorrect nmb_t_tar/nmb_s_tar has already been generated. This is to ensure the following:

- Start the workaround after the incorrect nmb_t_tar/nmb_s_tar has been generated and swon_t/swon_s is not toggling anymore
- Workaround should be finished before the arrival of next active edge.

Workaround steps are as follows:

1. Check swon_t/swon_s,
 - If swon_t/swon_s = 1, save & use nmb_t_tar/nmb_s_tar for further corrections
 - Else save & use nmb_t_tar_old/nmb_s_tar_old for further corrections.
2. Set PCM1=1 to trigger the fast pulse correction with PCMF1 already set to 1
3. Wait for PCM1 to reset to 0
4. Overwrite the nmb_t_tar/nmb_s_tar or nmb_t_tar_old/nmb_s_tar_old with the correct value based on swon_t/swon_s, similarly based on the choice in step 1.

After the next active edge, the PSTC/PSSC values are corrected.

GTM AI.323 DPLL: Registers DPLL_NUTC.SYN_T and DPLL_NUSC.SYN_S are updated by the profile (ADT_T.NT/ADT_S.NS) before the DPLL is synchronized (DPLL_STATUS.SYT/S=0)

The registers DPLL_NUTC.SYN_T and DPLL_NUSC.SYN_S as well as the corresponding *_OLD registers are updated unexpectedly by the profile (ADT_T.NT/ADT_S.NS) before the DPLL is synchronized (DPLL_STATUS.SYT/S=0).

This is not a problem for the calculation of the number of pulses (nmb_t/s,...), due to the fact that the correct value of SYN_T/S for the internal use is

determined by the signal DPLL_STATUS.SYT/S. The microtick generation of the DPLL is not affected by this bug.

This problem is only relevant if the SYN_T/S values are read from other consumers than the DPLL.

Scope

DPLL

Effects

When the DPLL is enabled and before the DPLL is synchronized (by writing to the relevant pointers (DPLL_APT_2c/DPLL_APS_1C3) the DPLL_NUTC.SYN_T/DPLL_NUSC.SYN_S registers are unexpectedly updated by the profile.

Because the SYN_T_OLD and SYN_S_OLD registers are updated by SYN_T, SYN_S they are affected as well.

The DPLL internal processes of calculation of the number of microticks for the next increment is not affected by that bug.

Workaround

When DPLL_NUTC.SYN_T/_OLD, DPLL_NUSC_SYN_S/_OLD values are needed outside the DPLL it must be checked that the DPLL is already synchronized (DPLL_STATUS.SYT/SYS). When the relevant DPLL channel (TRIGGER/STATE) is not synchronized yet the SYN_T/S values should be taken into account as "1".

GTM_AI.325 TIM: Bits ACB[2:1] lost on interface to ARU (always zero)

In case of CFG_CLOCK_RATE=1 (see register CCM[i]_HW_CONF) some cluster can be configured to run with fast clock frequency (200 MHz) while the ARU always runs with slow clock frequency (100 MHz).

For this configuration of a cluster running with fast clock frequency (200 MHz) also the TIM module in this cluster is running with fast clock frequency (200 MHz).

Functional Deviations

In this case and if a TIM channel is configured to send data to ARU (ARU_EN bit in TIM[i]_CH[x]_CTRL register), the bits ACB[2:1] will not be transferred with any ARU transfer request, they are always 0.

Due to this any master receiving ARU data is not able to use the ACB bit information received from a fast running TIM.

- ACB[1]: additional ARU request event received while actual request not finished
- ACB[2]: Timeout event occurred

Scope

TIM, ARU transfers

Effects

ARU bits ACB[2:1] sent by TIM are always zero.

Workaround 1

For applications running within a single cluster, use AEI communication (MCS-TIM) instead of ARU communication.

Workaround 2

Use half clock rate for the cluster that contains the TIM module read out via ARU.

Workaround 3

If the data from TIM channel should be routed over the ARU to the MCS module, then the MCS can read the information (TIM[i]_CH[x]_IRQ_NOTIFY[4:3]) directly over the AEI bus master interface instead of routing it through the ARU.

Hint: For this workaround the TIM channel and the MCS channel have to be in the same cluster.

Workaround 4

If the data from TIM channel should be routed over the ARU to the FIFO or BRC module, then the MCS can read the information

Functional Deviations

(TIM[i]_CH[x]_IRQ_NOTIFY[4:3]) directly over the AEI bus master interface and forward the data via its ARU interface to FIFO or BRC.

Hint: For this workaround the TIM channel and the MCS channel have to be in the same cluster.

Workaround 5

Depending on the application it might be possible by comparing the actual ARU data with the previous received ARU data to “reconstruct” the ACB bits [2:1].

GTM_AI.326 TIM: ARU bit ACB[0] (signal level) incorrect in case a second ARU request occurs while the actual request is just acknowledged

An issued ARU request will be served at least after the ARU round trip time.

If one GTM clock cycle before the ARU request is acknowledged a new capture event occurs (overflow condition due to e.g. input change) the bit ACB[0] will not show the new value.

The overflow bit ACB[1] and the ARU data words selected by (E)GPRy_SEL) will show the correct behavior, only the ACB[0] will show the previous state.

Scope

TIM, ARU transfers

Effects

ARU bit ACB[0] not consistent with data transferred in ARU data words.

Workaround 1

Ensure that events which trigger a ARU request occur with a greater timely distance than the ARU round trip time.

Workaround 2

Use the signal level information embedded in the ARU data words (selectable by ECNT/TIM_INP_VAL).

This data will show the correct signal level.

GTM_AI.329 Interference of MCS to AEI/ADC and CPU to AEI traffic within the same cluster could result in incorrect MCS program execution**Scope**

Usage of MCS AEI master port (AEI and ADC communication from MCS); MCS channel code execution; Dynamic usage of GTM_MCS_AEM_DIS.

Effects

Incorrect MCS channel code execution (skipping execution of instructions or repetitive execution of instructions) or processing of incorrect read data from AEI or ADC interface by MCS channel code.

Description

Operations of the MCS via its AEI master port on the AEI bus can be categorized into 3 different types of operations based on the response time required by an addressed resource to complete the operation on the bus. As operations from MCS to ADC are also handled via the MCS AEI master port, ADC operations are also relevant regarding the bus traffic scenarios.

The vast majority of register accesses via AEI as well as ADC reads complete with zero wait states ($N=0$) on the AEI bus and fall into the first category. The second category is defined by register operations to a small set of special registers that require 1 wait cycle ($N=1$) on the AEI interface to complete while the third category covers AEI accesses to memories (e.g. DPLL memory, MCS memory or FIFO memory) as well as 2 special registers in MCS that require multiple wait cycles ($N>1$) on the AEI interface to complete.

Certain interferences between accesses from MCS to the AEI/ADC interface and AEI accesses from CPU within the same cluster can result in bus traffic situations that impact the correct program execution of MCS channels. These rare but critical traffic conditions must be avoided to ensure the correct execution of MCS code.

Further the dynamic usage of GTM_MCS_AEM_DIS to temporarily disable a MCS AEI master port (AEI and ADC communication path) must be avoided. This switch can only be used for the permanent disablement of the MCS AEI master port.

Functional Deviations

MCS AEI master port usage scenarios proven to avoid the problematic traffic conditions under all circumstances include the usage scenarios described in the workaround section of this erratum. Usage of MCS to AEI or ADC communication not covered by tested scenarios must be avoided.

Communication from MCS to any GTM resource via ARU is not impacted and has no influence on the problems and scenarios described within this erratum.

- GTM resources with 1 AEI wait cycle (N=1):

Table 8 Memory locations critical from MCS (N=1 wait cycle)

Register name or memory location
GTM_RST
GTM_CLS_CLK_CFG
BRC_RST
TIM[i]_RST
TOM[i]_TGC0_GLB_CTRL
TOM[i]_TGC1_GLB_CTRL
DPLL_CTRL_1
ATOM[i]AGC_GLB_CTRL

- GTM resources with more than 1 AEI wait cycle (N>1):

Table 9 Memory locations critical from CPU/DMA and MCS (N>1 wait cycles)

Register name or memory location	Type	Comment
AFD[i]_ [0-7]_BUFF_ACC		
FIFO[i]_MEMORY	RAM address space	Not accessible from MCS
DPLL_RAM1A	RAM address space	
DPLL_RAM1B	RAM address space	
DPLL_RAM1C	RAM address space	

Table 9 Memory locations critical from CPU/DMA and MCS (N>1 wait cycles) (cont'd)

Register name or memory location	Type	Comment
DPLL_RAM2	RAM address space	
MCS[i]_MEMORY	RAM address space	Not accessible from MCS
MCS[i]_CTRG		
MCS[i]_STRG		

Technical Background

AEI bus access to all modules within a given cluster is granted by the AEIMux which arbitrates between accesses from the external CPU and accesses from MCS (via AEIM – “AEI master of MCS”). By default AEI access requests from MCS have higher priority than access requests from the external CPU to ensure the determinism of MCS code execution.

Depending on the addressed target of an AEI bus access, the access will complete either within one bus cycle (N=0 wait cycle), within 2 bus cycles (N=1 wait cycle) or multiple bus cycles (N>1 wait cycles). The vast majority of AEI accessible resources will respond with N=0 wait cycles. For a list of resources with N=1 or N>1 see [Table 8](#) and [Table 9](#) above.

As an AEI bus access of a given MCS thread can be delayed either due to an ongoing AEI bus access from CPU or a multi cycle AEI access from another MCS thread, the AEIM contains buffers to store MCS bus accesses to AEI that cannot be served immediately.

As accesses to ADC from MCS point of view are not different from AEI bus accesses, these ADC accesses are forwarded to the AEIM in the same way and on the same interfaces as MCS accesses to the AEI bus. The AEIM will identify the ADC accesses by their targeted address space and forward them to the GTM external ADC. As ADC accesses will always be served with zero wait time, these ADC accesses are not routed through the AEIM buffers.

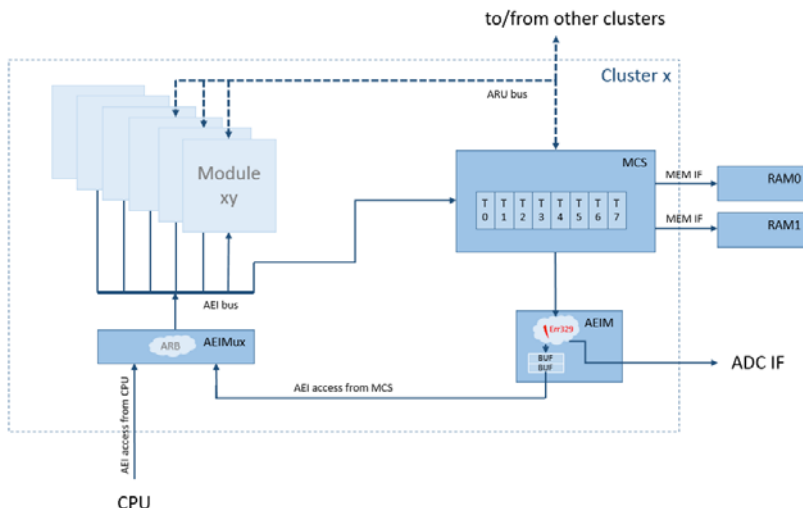


Figure 5 Cluster-internal AEI network

Problem GTM_AI.329 is related to a potential incorrect handling of MCS access requests to the AEI bus at the AEIM entry stage in case that one AEIM buffer is already filled. If in such a case a new access request from MCS enters the AEIM logic during a very specific time window (related to progress on the AEI bus), the AEIM logic might signalize incorrect parameters back to MCS that could result in incorrect data, the loss of data or a repetitive execution of MCS accesses to AEI.

To avoid the potential occurrence of problem GTM_AI.329 it has to be ensured that not more than 1 AEIM buffer gets filled due to backpressure in the AEI bus system.

Figure 6 shows an uncritical traffic situation. Here an access of a MCS thread to the AEI bus (green access path) is temporary delayed due to an ongoing AEI bus access from the CPU (red access path). The MCS access to the AEI bus will be safely buffered at the AEIM (green buffer). As soon as the CPU access to the AEI bus completes, the buffered AEI bus access from MCS will be executed.

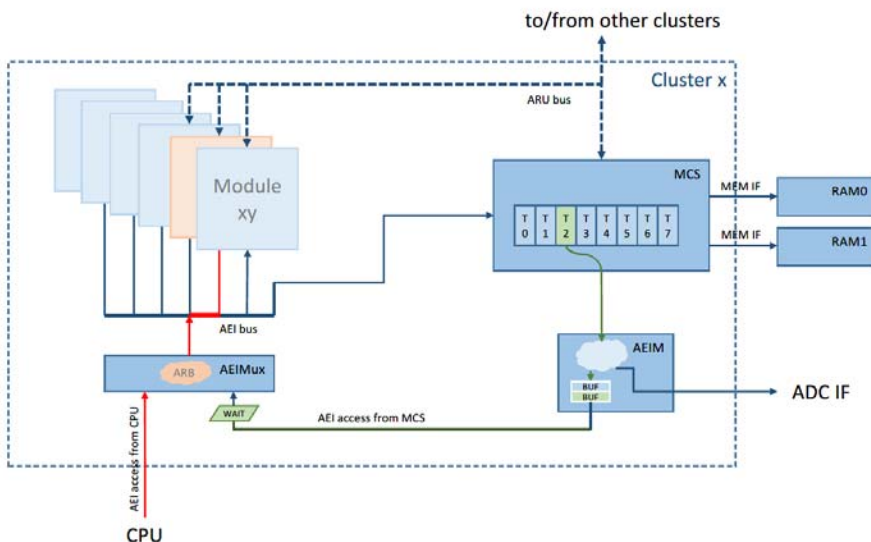


Figure 6 MCS AEI master access path

In [Figure 7](#), a potential risk for the occurrence of problem GTM_AI.329 is illustrated. Here the first buffer of the AEIM (green) is still waiting for the access to the AEI bus while a second AEI bus access from MCS arrives at the AEIM (yellow access path). Under certain, but for the user unpredictable timing conditions, this second AEI bus access arriving at the AEIM can trigger the misbehavior described in problem GTM_AI.329.

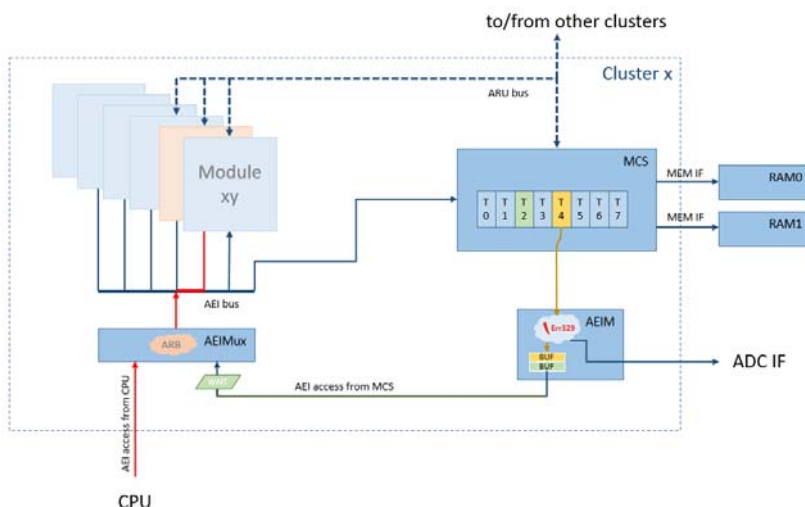


Figure 7 Critical MCS AEI master scenario

The workarounds described in the following section will ensure that not more than one AEIM buffer will be filled and therefore the occurrence of problem GTM_AI.329 is avoided. All workarounds have been tested and proven correct.

Workaround

To ensure that a correct execution of MCS channel code is not influenced by certain traffic scenarios on the MCS AEI/ADC bus master interface, only proven usage scenarios are allowed for MCS to AEI/ADC communication. The most common usage scenarios tested to be safe include:

Option 1:

Limit the usage of the MCS AEI master port (ADC and AEI communication) to one MCS channel per MCS at a time. ARU communication is available for all MCS channels and there are no limitations for the CPU access path in this usage model.

In case multiple MCS channels want to use the AEI master port for AEI or ADC communication, establish a mechanism that ensures that only one channel uses the AEI master at a time (e.g. exchange a token between channels or use trigger registers to hand over the AEI master port ownership between MCS channels).

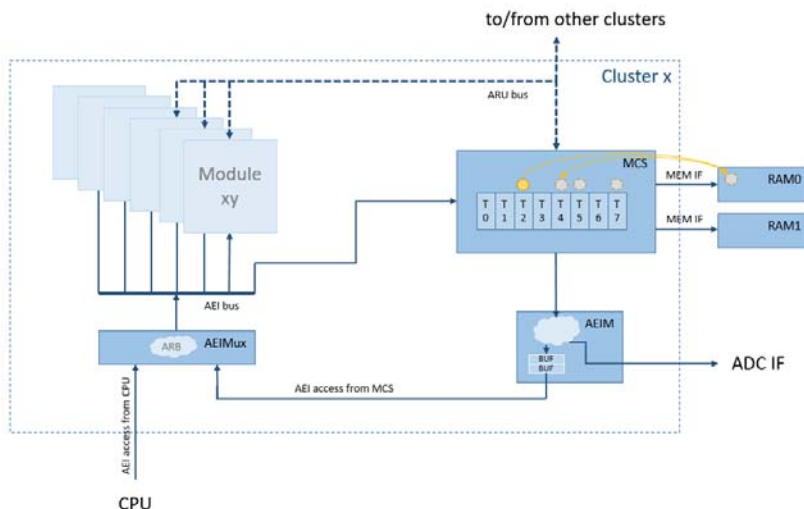


Figure 8 MCS token mechanism

An application note (AN020 – MCS Mutex implementation) describing a token exchange mechanism between MCS threads is available at Bosch. Such a token mechanism allows multiple MCS threads to safely access the AEI bus system by exchanging an AEI bus access token via MCS memory.

If multiple MCS threads have the need to access the AEI bus, only the MCS thread that currently owns the token is allowed to access the AEI bus via AEIM. The token must not be returned before the AEI bus access completed. This will ensure that not more than one AEI bus access is active at the same time.

Option 2:

Limit the usage of the MCS AEI master port to ADC communication only. The usage of the MCS AEI master port for AEI communication must be avoided for all channels. ARU communication is available for all MCS channels and there are no limitations for the CPU access path in this usage model.

Option 3:

Limit the usage of the MCS AEI master port to ADC as well as AEI communication with zero wait cycles ($N=0$) only. AEI communication from MCS to resources with $N>0$ must be avoided.

Further the access from CPU to this cluster has to be limited to accesses with zero or one wait cycle ($N=0$ and $N=1$) only. Memories or registers with $N>1$ within the given clusters cannot be accessed by the CPU in this usage model.

If the CPU has to access these resources in this cluster, the number of MCS threads using the MCS AEI master port to access AEI or ADC temporarily has to be limited to one thread while all other MCS threads accessing AEI or ADC have to be suspended while the CPU accesses $N>1$ resources.

Table 10 Summary of problem GTM_AI.329

MCS			Access from CPU cluster		
MCS AEI Master Port	Channels active performing BRD/BWR all at the same time	Wait cycles	No access	Wait cycles $N \leq 1$	Wait cycles $N > 1$
AEI or ADC	>1	N=0	Erratum does not apply	Erratum does not apply	Erratum applies; No issue if all channels issuing BRD/BWR instructions except one MCS channel are in suspend state (disabled) while the CPU/DMA access is active
		N>0	Erratum does not apply	Erratum applies	Erratum applies
ADC only	≥ 1	N=0	Erratum does not apply	Erratum does not apply	Erratum does not apply

GTM_AI.331 GTM_TIM[i]_AUX_IN_SRC and GTM_EXT_CAP_EN_[i] register: wrong status 2 by AEI write access if cluster 0 is disabled

AEI write access to the register GTM_TIM[i]_AUX_IN_SRC and GTM_EXT_CAP_EN_[i] via the legacy address space responds with status 2 even though the write operation is correctly executed and the register contains the correct new value.

Scope

Register access via legacy address.

Effects

If status 2 is responded an interrupt bit in GTM_IRQ_NOTIFY is set and the write address will be caught in register GTM_AEI_STA_XPT.

Any further AEI access with responded status >0 will not be caught in GTM_AEI_STA_XPT until GTM_AEI_STA_XPT is reset by AEI read to GTM_AEI_STA_XPT.

Workaround

Do not use the legacy addresses of the listed registers while cluster 0 is disabled.

GTM_AI.332 Access to registers GTM_TIM[i]_AUX_IN_SRC and GTM_EXT_CAP_EN_[i] via legacy address space: read data always 0 for AEI read access while cluster 0 is disabled

AEI read access to registers via legacy address space which are not in any cluster will respond always with read value 0 if cluster 0 is disabled.

- Impacted registers are:
 - GTM_TIM[i]_AUX_IN_SRC
 - GTM_EXT_CAP_EN_[i]

Scope

Register access via legacy address.

Effects

If cluster 0 is disabled, register data unequal to 0 would not be read from any register which is not part of a cluster (see list of impacted register sections) via its legacy address.

Workaround

Do not access the impacted registers via their legacy address while cluster 0 is disabled.

GTM_AI.333 MCS bus master interface: a not word aligned address access to DPLL ram region can cause incorrect execution of MCS channel code

MCS accesses to the DPLL ram regions with not correctly aligned address while concurrently CPU accesses to the same cluster occur could result in incorrect execution of MCS channel code.

Scope

MCS bus interface; MCS program execution.

Effects

MCS channel program execution incorrect. Instructions might be executed multiple times or might be skipped. MCS BRD* instruction reads wrong data.

Workaround

Ensure that address used in BWR* /BRD* instructions is correctly aligned.

Note: If the bus master addresses as provided in table “MCS Master Interface Address Map” are used along with BWR /BRD* then this issue will not occur.*

GTM_AI.334 DPLL RAM content of single address can be corrupted after leaving debug mode

Assume a MCS RAM write access to DPLL RAM address x in RAM1a, RAM1bc or RAM2 is executed at the point in time when the GTM is switched to debug mode (gtm_halt_req=1). Any following write access to DPLL address space while in debug mode will corrupt the data in memory location x when the restore operation which is executed while leaving debug mode (gtm_halt_req=0) is processed.

Read operations to DPLL address space while in debug mode will not corrupt the DPLL memory content.

Scope

GTM Debug

Effects

Data in RAM might be corrupted

Workaround

If only READ accesses to DPLL address space are performed while in debug mode the described effect will never occur.

When write accesses to DPLL address space are performed while in debug mode the following workaround has to be considered:

1. Determine with the debugger whether a BWR instruction to DPLL RAM was executed just before the HALT occurred.
2. The active address and the data of this instruction has to be written again with a debug access directly before leaving debug mode.

GTM_AI.335 TOM output signal to SPE not functional if up/down counter mode is configured

TOM output signal TOM[i]_CH[x]_SOUR to SPE not functional if up/down counter mode is configured by setting of TOM[i]_CH[x]_CTRL.UDMODE > 0.

Scope

TOM - SPE interface

Effects

TOM output signal TOM[i]_CH[x]_SOUR to SPE not functional.

Workaround

No workaround available.

Don't use up/down counter mode together with SPE interface.

GTM_AI.336 GTM Bus Bridge: Incorrect AEI access execution in case the previous AEI access was aborted with the access timeout abort function

In case the GTM internal AEI access timeout abort function is in use (GTM_CTRL.TO_VAL != 0 and GTM_CTRL.TO_MODE=1), a following AEI access can be corrupted:

- a) A write access might not be executed (register/ memory not written to the specified value)
- b) A read access can return random data (read value does not reflect the content of the addressed register / memory).

Hint: As a timeout based abort of a GTM register access is assumed to be an error scenario, the internal state of the GTM might be exposed. To ensure the proper behavior after such a severe incident, the GTM IP should be re-initialized as part of a recovery action on system level.

Scope

CPU interface accesses

Effects

Read access returns random data.

Write access does not change the content of the target address.

Workaround

Do not use the AEI access abort mode, use the observe mode instead (Set GTM_CTRL.TO_MODE=0).

Enable additionally the timeout observe IRQ by setting GTM_IRQ_EN.AEI_TO_XPT_IRQ=1 to invoke higher level recovery mechanisms for GTM re-initialization.

(e.g. abort the pending access to the GTM and re-initialize the GTM_IP from hardware reset).

GTM_AI.339 DPLL: Control bits DPLL_CTRL_11.PCMF1 and DPLL_CTRL_11.PCMF2 are not reset to 0 after a pulse correction is completed

In DPLL specification it is written in the description of field PCMF1 in register DPLL_CTRL_11: “When taken the MPVAL1 value to RPCUx and INC_CNT1 the PCM1 bit is reset immediately and after that also the PCMF1 bit.”

The implemented behavior of the DPLL is that the PCMF1 bit is not reset after the PCM1 bit is reset to 0. In mode DPLL_CTRL_1.SMC=1, the same is true for the signal DPLL_CTRL_11.PCMF2.

Scope

DPLL

Effects

After a pulse correction is executed by writing to DPLL_CTRL_1.PCM1=1 and this signal is reset to 0 again, the signal DPLL_CTRL_11.PCMF1 is not reset back to 0.

After a pulse correction is executed by writing to DPLL_CTRL_1.PCM2=1 and this signal is reset to 0 again, the signal DPLL_CTRL_11.PCMF2 is not reset back to 0.

Workaround

Before a following pulse correction is executed this signal must be set to 0 again if needed. When a sequence of pulse corrections with the same configuration of DPLL_CTRL_11.PCMF1 or DPLL_CTRL_11.PCMF2 is executed no modification of DPLL_CTRL_11.PCMF1 or DPLL_CTRL_11.PCMF2 is necessary.

When reset of DPLL_CTRL_11.PCMF1 or DPLL_CTRL_11.PCMF2 is needed this can be done by writing to register DPLL_CTRL_11.PCMF1/2.

GTM_AI.340 TOM/ATOM: Generation of TRIG_CCU0/TRIG_CCU1 trigger signals skipped in initial phase of A/TOM SOMP one-shot mode**Configuration in use:**

- A/TOM[i]_CH[x]_CTRL.OSM=1
- A/TOM[i]_CH[x]_CTRL.OSM_TRIG=0
- A/TOM[i]_CH[x]_CTRL.UDMODE=00
- ATOM[i]_CH[x]_CTRL.MODE=10

Expected behavior:

The generation of one-shot pulses in A/TOM can be initiated by a write to CN0. In this case the pulse generation comprises of an initial phase where the signal level at A/TOM output is inactive followed by a pulse. The duration of the initial phase can be controlled by the written value of CN0, where the duration is defined by CM0-CN0. After the counter CN0 reaches the value of CM0-1, the pulse starts with its active edge, CN0 is reset, and starts counting again. When CN0 reaches CM1-1, the inactive edge of the pulse occurs. Due to the fact, that the capture compare units CCU0 and CCU1 compare also in the initial phase of the pulse generation, the trigger conditions for these comparators apply also in this initial phase. Thus, the TRIG_CCU0 and TRIG_CCU1 signals also occur in the initial phase of the one-shot pulse. When these trigger signals are enabled in the A/TOM[i]_CH[x]_IRQ_EN, an interrupt signal is generated by A/TOM on the CCU0TC and CCU1TC trigger conditions and the corresponding A/TOM[i]_CH[x]_IRQ_NOTIFY bits are set.

Observed behavior:

For certain start values of CN0 and dependent on the history of pulse generation, the trigger signals TRIG_CCU0 and TRIG_CCU1 are skipped. As a consequence, this can led to missing interrupts CCU0TC and CCU1TC on behalf of their missing trigger signals TRIG_CCU0 and TRIG_CCU1.

For the first pulse generation after enabling the channel, all trigger signals TRIG_CCU0 and TRIG_CCU1 appear as expected and described in the section expected behavior. If the channel stays enabled and a new value CN0 is written to trigger a subsequent one-shot pulse, the TRIG_CCU0/TRIG_CCU1

Functional Deviations

triggers in the initial phases of subsequent one-shot pulses are skipped under the following conditions:

- For TRIG_CCU0 trigger: if the one-shot pulse is started by writing a value to CN0 greater or equal to CM0-1.
- For TRIG_CCU1 trigger: if the one-shot pulse is started by writing a value to CN0 greater or equal to CM1-1.

Scope

TOM/ATOM

Effects

Missing TRIG_CCU0 and TRIG_CCU1 trigger signals in initial phase of subsequent pulses in A/TOM one-shot mode, when one shot-mode is started with writing to CN0 values greater equal CM0-1 or CM1-1.

Workaround 1

Disabling, resetting (channel reset), re-enabling and initializing of the channel between each one-shot pulse will ensure the correct behavior of CCU0TC and CCU1TC interrupt source.

Workaround 2

Starting a new one-shot pulse by writing twice the counter CN0 whereas the first value, which is written to CN0 should be zero followed by the value which defines the length of the initial phase.

Be aware that in this case, the total length of the initial phase until the pulse is started, is influenced by the time between the two write accesses to CN0.

GTM_AI.341 TOM/ATOM: False generation of TRIG_CCU1 trigger signal in SOMP one-shot mode with OSM_TRIG=1 when CM1 is set to value 1

Configuration in use:

- A/TOM[i]_CH[x]_CTRL.OSM=1
- A/TOM[i]_CH[x]_CTRL.OSM_TRIG=1

- A/TOM[i]_CH[x]_CTRL.UDMODE=00
- ATOM[i]_CH[x]_CTRL.MODE=10

Expected behavior:

The generation of one-shot pulses in A/TOM can be initiated by the trigger event TRIG_[x-1] from trigger chain or by TIM_EXT_CAPTURE(x) trigger event from TIM, whereas the counter CN0 is reset to zero and starts counting. In this case the pulse generation comprises of an initial phase where the signal level at A/TOM output is inactive followed by a pulse. The duration of the initial phase is always as long until the counter CN0 reaches CM0-1.

After the counter CN0 reaches the value of CM0-1, the pulse starts with its active edge, CN0 is reset, and starts counting again. When CN0 reaches CM1-1, the inactive edge of the pulse occurs. Due to the fact, that the capture compare units CCU0 and CCU1 compare also in the initial phase of the pulse generation, the trigger conditions for these comparators apply also in this initial phase. Thus, the TRIG_CCU0 and TRIG_CCU1 signals also occur in the initial phase of the one-shot pulse. When these trigger signals are enabled in the A/TOM[i]_CH[x]_IRQ_EN, an interrupt signal is generated by A/TOM on the CCU0TC and CCU1TC trigger conditions and the corresponding A/TOM[i]_CH[x]_IRQ_NOTIFY bits are set.

Observed behavior:

If the compare register CM1 is set to 1 and a new one-shot pulse is triggered, two effects can be observed:

- The first observed behavior is that the capture compare unit doesn't generate the TRIG_CCU1 trigger signal in the initial phase of the one-shot cycle.
- The second observed behavior is that at the end of the operation phase of the one-shot cycle, where CN0 reaches CM0-1 a second time, the capture compare unit generates a TRIG_CCU1 trigger signal which is not expected at this point in time.

Scope

TOM/ATOM

Effects

Missing TRIG_CCUI trigger signal in initial phase of the one-shot cycle and unexpected TRIG_CCUI trigger signal at the end of the operation phase of the one-shot cycle.

Workaround

Instead of using value 1 for CM1 it could be possible to generate the same pulse length by using a higher CMU_FXCLK/CMU_CLK frequency. Then, to get the same pulse length, the value of CM1 has to be multiplied by the difference of the two CMU_FXCLK/CMU_CLK frequencies.

Be aware that this workaround is only possible, if you are not already using the CMU_FXCLK(0) because there is no higher CMU_FXCLK frequency to select.

Example for TOM: Instead of using CMU_FXCLK(1), which has the divider value 2^{**4} , use CMU_FXCLK(0), which has the divider value 2^{**0} . In this case, CM1 has to be configured with value 2^{**4} minus 2^{**0} which is equal to $2^{**4}=16$.

Hint: To get the same length of period, which defines the length of the initial phase, the value for the period in CM0 has to be multiplied by the same value.

A second limitation is that the maximum length of the period, which is configured in CM0, is limited. Using a higher CMU_FXCLK/CMU_CLK frequency reduces the maximum possible period.

GTM_AI.344 DPLL: Incorrect AEI_STATUS on internal MCS2DPLL interface on valid and implemented address accesses

The status signal on the MCS2DPLL interface is always responding with "0b11" independent if an available or an unavailable address with correct byte alignment of that interface is accessed.

Scope

DPLL, MCS0

Effects

When the master interface of the MCS is accessing any address of the MCS2DPLL interface the DPLL always responds by setting the internal signal `mcs_aeim_status` = "0b11". When this happens the register `CCM0_AEIM_STA` is storing the `mcs_aeim_status` of "0b11" and additionally storing the address of the access. Although the MCS2DPLL interface is operating correctly it is not possible to check for invalid accesses under the described conditions.

If the register `MCS[0]_CTRL_STAT.HLT_AEIM_ERR=0b1` the MCS0 channel which executed the bus master access is halted.

Workaround

The register bit field `MCS0_CTRL_STAT.HLT_AEIM_ERR` must be set to "0b0" to prevent the MCS0 channels from halt.

For the `mcs_aeim_status` there is no workaround possible. The master AEI interface of the MCS is operating correctly under the above configuration, but it is not possible to check for invalid address accesses via the `CCM0_AEIM_STA` register when the MCS is accessing any address of the MCS2DPLL interface.

GTM_AI.345 SPE: Incorrect behaviour of direction change control via SPE_CMD.SPE_CTRL_CMD bits

A direction change ("00" <-> "01") via `SPE_CTRL_CMD` disturbs the increment/decrement of the `pat_ptr` resulting in incorrect output patterns not corresponding to the input pattern position. Changing the direction bit in `SPE_CTRL_CMD` can also generate invalid IRQs.

Scope

SPE, TOM

Effects

Modifying the direction bit ("00" <-> "01") in `SPE_CTRL_CMD` does not provide the correct output pattern to the BLDC motor. Due to a wrong `pat_ptr` position incorrect output patterns will be sent to the motor, which are not correlated to the sensor position.

In addition the SPE logic can generate unpredictable IRQs (perr_irq, dchg_irq, bis_irq).

Workaround

Do not use SPE_CTRL_CMD.

Instead reprogram the SPE_OUT_PAT register to change the direction.

GTM AI.346 ATOM SOMS mode: Shift cycle is not executed correctly in case the reload condition is deactivated with ATOM[i]_AGC_GLB_CTRL.UPEN = 0

ATOM is configured to SOMS continuous mode by setting the following configuration bitfields:

- ATOM[i]_CH[x]_CTRL.MODE=11
- ATOM[i]_CH[x]_CTRL.OSM=0
- ATOM[i]_CH[x]_CTRL.ARU_EN=0
- ATOM[i]_AGC_GLB_CTRL.UPEN[x]=0b00

Expected behaviour:

After the counter CN0 reaches CM0, no reload cycle is executed due to the configuration of UPEN=0b00.

Instead of a reload cycle a shift cycle has to be executed to ensure an continuous shifting.

Observed behaviour:

Neither a reload cycle nor a shift cycle is executed when the counter CN0 reaches CM0. The shifting stops and the shift register CM1 as well as the output ATOM[i]_CH[x]_OUT stays unexpectedly stable for two shift clock cycles whereas the counter CN0 continuously counting further on.

Scope

ATOM

Effects

After the counter CN0 reaches CM0 the output stays stable for two shift clock cycles before the next shift will be executed.

Workaround

Increase the number of bits that have to be shifted out inside CM0 register to the maximum value of 23 to ensure an continuous shifting of all bits of the shift register CM1.

GTM AI.347 TOM/ATOM: Reset of (A)TOM[i]_CH[x]_CN0 with TIM_EXT_CAPTURE are not correctly synchronized to selected CMU_CLK/CMU_FXCLK

To reset the counter (A)TOM[i]_CH[x]_CN0 (SOMP mode in ATOM), the input signal TIM_EXT_CAPTURE can be used by configuration of (A)TOM[i]_CH[x]_CTRL.EXT_TRIG=1 and (A)TOM[i]_CH[x]_CTRL.RST_CCU0=1.

The reset of the counter (A)TOM[i]_CH[x]_CN0 should happen synchronously to the internal selected CMU clock CMU_CLK/CMU_FXCLK. Therefore a synchronisation stage is implemented to synchronize the input signal TIM_EXT_CAPTURE to the internal selected CMU clock CMU_CLK/CMU_FXCLK.

It can be observed, that the reset of the counter is done immediately with the occurrence of the input signal TIM_EXT_CAPTURE and not as expected synchronously to the selected CMU clock enable CMU_CLK/CMU_FXCLK.

As a consequence of this, the output signal for the compare values 0 and 1 of (A)TOM[i]_CH[x]_CM1.CM1 and (A)TOM[i]_CH[x]_CM0.CM0 will not be set correctly.

Scope

ATOM, TOM

Effects

The output signal (A)TOM[i]_CH[x]_OUT is not set correctly for the compare values 0 and 1 of the operation register bitfields (A)TOM[i]_CH[x]_CM1.CM1 and (A)TOM[i]_CH[x]_CM0.CM0.

Workaround 1

Select a CMU clock enable signal CMU_CLK/CMU_FXCLK by appropriate setting of (A)TOM[i]_CH[x]_CTRL.CLK_SRC which is setup inside the CMU module in that way, that each system clock is enabled. In other words this means that the selected clock enable signal CMU_CLK/CMU_FXCLK should be always active high.

Note: No frequency divider should be used for CMU_CLKz (only CMU_CLK_z_CTRL.B.CNT = 0) and CMU_FXCLKx (only CMU_FXCLK0).

Workaround 2

Avoid the compare values 0 and 1 for the operation register bitfields (A)TOM[i]_CH[x]_CM1.CM1 and (A)TOM[i]_CH[x]_CM0.CM0.

GTM_AI.348 DPLL: Correction of missing pulses delayed after start of pulse generation

The described erratum occurs in the DPLL configuration DPLL_CTRL_1.DMO=0 (Automatic end mode) and DPLL_CTRL_1.COA=0 (Fast pulse correction). When after the start of pulse generation (DPLL_CTRL_1.SGE1/2=0-->1) not all pulses scheduled could be generated, repeating the pulses at fast speed is not executed at the second TRIGGER/STATE input event.

Scope

DPLL

Effects

When the pulse generation has been started by setting DPLL_CTRL_1.SGE1/2 and not all scheduled pulses could be generated there is no fast pulse correction after the second active input signal. Beyond that the DPLL internal pulse counter DPLL_ICNT1/2 is incremented correctly so that no pulse is getting lost. After the third input event the pulse correction is working as specified.

Workaround 1

DPLL must be in direct load mode (DPLL_CTRL_1.DLM1/2 =1). Set DPLL_ADD_IN_LD1/2.ADD_IN_LD1/2=0 for the first two increments after the DPLL pulse generation has been started by DPLL_CTRL_1.SGE1/2=1 (all GTM Versions)

Workaround 2

Do nothing: If there is no need to do the pulse correction for the second input signal after start of pulse generation. With the third input signal the pulse correction is starting to work.

Workaround 3

Use pulse correction mechanism triggered by DPLL_CTRL_1.PCM1/2:

- Set DPLL_MPVAL1/2.MPVAL1/2 to the desired number of pulses which has to be sent out fast.
- Set DPLL_CTRL_11.PCMF1/2=1 AND DPLL_CTRL_11.PCMF1/2_INCCNT_B=1.
- Trigger the fast pulses by setting DPLL_CTRL_1.PCM1/2=1.

*Note: Workaround 3 is applicable for all GTM versions used in TC3xx devices.
It is not applicable for TC2xx devices.*

GTM_AI.349 TOM-SPE: OSM-Pulse width triggered by SPE_NIPD for selected CMU_FXCLK not correct

The SPE_NIPD signal is used to reset TOM_CH_CN0 and to generate a one-shot pulse. When the CMU_FXCLK of the corresponding TOM_CH is set to a value unequal to 0, there are two effects observed:

1. the first pulse triggered by SPE_NIPD is generated with the CMU_FXCLK(0), while any subsequent pulses are generated with the configured CMU_FXCLK;
2. the pulses generated with the correct CMU_FXCLK show no determinism. Some pulses end with CCU_TRIG1, some with CCU_TRIG0.

Scope

TOM, SPE

Effects

The OSM-Pulse width triggered by SPE_NIPD are not correct.

Workaround

Use SYS_CLK by selecting CMU_FXCLK(0) instead of a value unequal to zero for CMU_FXCLK.

To reach the same pulse width on the output signal, the value for the period (TOM[i]_CH[x]_CM0.CM0) and duty cycle (TOM[i]_CH[x]_CM1.CM1) has to be scaled due to the relationship between SYS_CLK and the needed CMU_FXCLK.

GTM_AI.350 TOM-SPE: Update of SPE[i]_OUT_CTRL triggered by SPE_NIPD not working for a delay value 1 in TOM[i]_CH[x]_CM1

When configured in one-shot mode some TOM channels can initiate a delayed change of register SPE_OUT_CTRL. The delay can be configured in TOM[i]_CH[x]_CM1 register of the corresponding TOM channel.

Expected behaviour:

The SPE_OUT_CTRL register changed its content after a delay of CMU_FXCLK cycles which are configured in the TOM channel. For CM1=0, no update is expected, for CM1=1, the update is expected with the next CMU_FXCLK, for CM1=2, a delay of two CMU_FXCLK clock cycles is expected.

Observed behaviour:

For CM1=1, there is no change of SPE_OUT_CTRL at all, independent of CMU_FXCLK.

Scope

TOM, SPE

Effects

The update of SPE_OUT_CTRL register is not executed.

Workaround

Use SYS_CLK by selecting CMU_FXCLK(0) instead of a value unequal to zero for CMU_FXCLK.

To get the trigger signal from TOM for the delayed update at the same time, the value for the period (TOM[i]_CH[x]_CM0.CM0) and duty cycle (TOM[i]_CH[x]_CM1.CM1) has to be scaled due to the relationship between SYS_CLK and the needed CMU_FXCLK.

GTM AI.351 MAP: Disable of input lines by MAP_CTRL register not implemented for input signals TSPP0 TIM0_CHx(48) (x=0..2) and TSPP1 TIM0_CHx(48) (x=3..5)

The Control bits TSPP0_I0V, TSPP0_I1V, TSPP0_I2V, TSPP1_I0V, TSPP1_I1V, TSPP1_I2V of register MAP_CTRL are not operating as specified. The specified gating functions of the input signals TIM0_CH0(48), TIM0_CH1(48), TIM0_CH2(48) of TSPP0 submodule and the input signals

Functional Deviations

TIM0_CH3(48), TIM0_CH4(48), TIM0_CH5(48) of TSPP1 submodule are not implemented, hence the input signals cannot be disabled.

Scope

MAP

Effects

The specified disable function of the input signals TIM0_CH0(48), TIM0_CH1(48), TIM0_CH2(48) of TSPP0 submodule and the input signals TIM0_CH3(48), TIM0_CH4(48), TIM0_CH5(48) of TSPP1 submodule are not implemented, hence the input signals cannot be disabled.

Workaround

The combined TRIGGER or STATE output signals to the DPLL module can be disabled by using the control signals DPLL_CTRL_0.TEN(TRIGGER, TSPP0) and DPLL_CTRL_0.SEN(STATE, TSPP1).

No workaround exists for switching off the level input signals of the TSPP0 and TSPP1 submodules individually.

GTM_AI.352 ATOM: No reload of data from ARU in SOMS and SOMP mode if TIM_EXT_CAPTURE(x) or TRIGIN(x) is selected as clock source

ATOM configuration:

- SOMP or SOMS mode (ATOM[i]_CH[x]_CTRL.MODE=0b10/0b11)
- ARU input stream enabled (ATOM[i]_CH[x]_CTRL.ARU_EN=1)
- TRIGIN(x) or TIM_EXT_CAPTURE(x) as selected clock source (ATOM[i]_CH[x]_CTRL.CLK_SRC=0b1101/0b1110)

Expected behaviour in SOMS mode:

ATOM Channel in SOMS mode shifts all data provided by ARU.

Observed behaviour in SOMS mode:

ATOM channel stops after data is shifted out which was stored in shift register ATOM[i]_CH[x]_CM1.CM1 by the CPU. Data which was transferred via ARU stays in shadow register ATOM[i]_CH[x]_SR1.SR1 and will not be reloaded into the shift register; instead the channel stops.

Expected behaviour in SOMP continuous mode:

Synchronized to the beginning of a new period ATOM Channel requests new data from ARU. The received values from ARU are stored into the shadow registers. If the actual period is ended the stored values are copied from the shadow registers into the operation registers for the new period. At the same time, a new read request to the ARU is started.

Observed behaviour in SOMP continuous mode:

ATOM Channel requests new data from ARU without synchronization to the beginning of a new period. The received values are stored into the shadow registers and then copied directly into the operation registers. The next ARU read request is started immediately without synchronization to the actual period.

SOMP one-shot mode together with the reloading of values via the ARU is not supported and is therefore not affected by this ERRATUM.

Scope

ATOM

Effects

The reloading and update of new values for the shadow registers from ARU doesn't happen. The channel stops.

Workaround

If TIM_EXT_CAPTURE(x) is to be used as clock source, this can be configured within the CCM as clock source for one of the CMU clock sources. This clock source must then be selected in the ATOM itself.

If TRIGIN(x) is to be used as clock source, the output signal of the ATOM channel, which delivers the trigger signal TRIGIN(x), can be routed to TIM input

as AUX_IN signal. Now the TIM_EXT_CAPTURE(x) signal from this TIM module can be used with the same workaround as described before for TIM_EXT_CAPTURE(x) clock source. An additional clock delay of 3 cluster clocks would need to be considered for the generation of the TRIGIN(x) source.

GTM AI.353 SPEC-ATOM: Specification of the smallest possible PWM Period in SOMP mode wrong, when ARU_EN=1

Configuration in use:

- ATOM[i]_CH[x]_CTRL.MODE=0b10 (SOMP),
- ATOM[i]_CH[x]_CTRL.ARU_EN=1,
- ATOM[i]_AGC_GLB_CTRL.UPEN_CTRLx=1

Functionality:

When ATOM[i]_CH[x]_CTRL.ARU_EN=1 and ATOM[i]_AGC_GLB_CTRL.UPEN_CTRLx=1 the PWM period and duty cycle (PWM characteristic) can be reloaded via ARU in SOMP mode. The ATOM generates a PWM on the operation registers ATOM[i]_CH[x]_CM0.CM0 and ATOM[i]_CH[x]_CM1.CM1 while the new values received via ARU are stored in the shadow registers ATOM[i]_CH[x]_SR0.SR0 and ATOM[i]_CH[x]_SR1.SR1.

Reloading of the ATOM[i]_CH[x]_CM0.CM0 and ATOM[i]_CH[x]_CM1.CM1 registers with the values from ATOM[i]_CH[x]_SR0.SR0 and ATOM[i]_CH[x]_SR1.SR1 takes place, when the old PWM period expires (ATOM[i]_CH[x]_CN0.CN0 reaches ATOM[i]_CH[x]_CM0.CM0 in up counter mode or ATOM[i]_CH[x]_CN0.CN0 reaches 0 in up/down counter mode).

Therefore, it is important, that the new PWM characteristic is available in the shadow registers ATOM[i]_CH[x]_SR0.SR0 and ATOM[i]_CH[x]_SR1.SR1 before ATOM[i]_CH[x]_CN0.CN0 reaches ATOM[i]_CH[x]_CM0.CM0 (up counter mode) or 0 (up/down counter mode).

Problem description:

The GTM-IP specification defines as minimal possible PWM period, where the PWM characteristic can be reloaded in a predictable manner so that new data is always available in time at the ATOM channel, to be the ARU round trip time

Functional Deviations

of the specific microcontroller device. This is not correct, because the data needs two additional ARU clock cycles to flow through the ARU from a source to the ATOM channel plus one clock cycle for loading the value from the shadow registers `ATOM[i]_CH[x]_SR0.SR0` and `ATOM[i]_CH[x]_SR1.SR1` to the registers `ATOM[i]_CH[x]_CM0.CM0` and `ATOM[i]_CH[x]_CM1.CM1`.

When the PWM period is smaller than the ARU round trip time plus three ARU clock cycles, the PWM output is not correct.

Scope

SPEC-ATOM

Effects

When the ATOM channel operates in SOMP mode and receives updates of PWM period and/or duty cycle via ARU, new PWM period and/or duty cycle values get lost, when the PWM Period is smaller than the ARU round trip time plus one or two ARU clock cycles for the given microcontroller device the PWM Period runs on.

Workaround

The PWM period has to be larger than ARU round trip time + 3 ARU clock cycles. Alternatively use ARU dynamic routing, or reduce the value of `ARU_CADDR_END` to a value, which fits the PWM period. So, PWM period greater than `ARU_CADDR_END + 1 + 3 ARU clock cycles`.

GTM AI.354 MCS: Unresolved hazard resulting from RAW (Read After Write) dependency

If an MCS instruction sequence has any RAW (read after write) data dependency, which involves one of the following SFRs mentioned below, the read access is executed before the write access if the latency of these instructions is one or two clock cycles.

The involved SFRs are: `GMI0`, `GMI1`, `DSTA`, `DSTAX` or `AXIMI`.

Example:

Assume that following sequence

- MOV GMIO, R0 // write GMIO
- MOV R1, GMIO // read GMIO

is executed in two subsequent clock cycles (w/o any additional wait cycles), read access of GMIO is executed before the write access to GMIO.

Scope

MCS

Effects

The executed order of the program sequence is not as specified in the program code.

Workaround

Ensure that the delay between such RAW dependencies is always greater than 2 clock cycles.

For example:

1. Chose round robin scheduling mode, in which the situation will never occur.
2. Reformulate the sequence in a way that there are at least two instructions between the critical RAW dependency.

For example:

- MOV GMIO, R0
- NOP
- NOP
- MOV R1, GMIO

GTM_AI.357 MCS: instructions XCHB, SETB, and CLRB do not suppress register write

According to the specification, the instructions XCHB CLRB, and SETB perform a specific bit operation on the B[4:0]-th bit of register A, but only if B[4:0] is less

Functional Deviations

than 24. If B[4:0] is greater than or equal to 24, the content of A shall not be modified.

However, the current RTL implementation of these instructions always reads register A and it is always followed by a write back to register A, independently of the value B[4:0]. But the read content of A is only modified if B[4:0] is less than 24.

Thus, the functional behavior of this implementation is correct in the case that A is a register which only has non-volatile register bits. However, if A is a register that has volatile bits, the result might also be modified if B[4:0] is greater than or equal to 24, since the write access to this register might modify its content.

Scope

MCS

Effects

If B[4:0] is greater than or equal to 24, unexpected write accesses to the referred SFR of A can occur.

Workaround

MCS program must ensure that B[4:0] is always in the range of 0 to 23, at least if volatile SFRs are used as argument A in the instructions XCHB, SETB, or CLRB.

GTM AI.358 TOM/ATOM: Synchronous update of working register for RST_CCU0=1 and UDMODE=0b01 not correct

TOM/ATOM is configured in SOMP mode with ATOM[i]_CH[x]_CTRL.MODE="10" (only for ATOM) and up-down counter mode is enabled by setting of (A)TOM[i]_CH[x]_CTRL.UDMODE=0b01. With the additional configuration of (A)TOM[i]_CH[x]_CTRL.RST_CCU0=1, the counter direction from up to down is changed with the trigger signal from a preceding channel TRIGIN[x] or with the TIM_EXT_CAPTURE signal from TIM module.

Expected behaviour:

The synchronous update of the working registers (A)TOM[i]_CH[x]_CM0 and (A)TOM[i]_CH[x]_CM1 in this configuration shall be done only when the channel counter (A)TOM[i]_CH[x]_CN0 reaches zero.

Observed behaviour:

Additionally to the update of the working registers (A)TOM[i]_CH[x]_CM0 and (A)TOM[i]_CH[x]_CM1 when the channel counter (A)TOM[i]_CH[x]_CN0 reaches zero, the update is executed with the selected trigger signal TRIGIN[x] or TIM_EXT_CAPTURE(x). This is not expected in this configuration with (A)TOM[i]_CH[x]_CTRL.UDMODE=0b01.

Scope

TOM, ATOM

Effects

The synchronous update of the working register (A)TOM[i]_CH[x]_CM0 and (A)TOM[i]_CH[x]_CM1 is done unintendedly with the selected trigger signal TRIGIN[x] or TIM_EXT_CAPTURE.

Workaround

For settings where the PWM phases are longer than the register access times on target system: Ensure to deliver new data to the associated shadow registers (A)TOM[i]_CH[x]_SR0 and (A)TOM[i]_CH[x]_SR1 only when the channel counter ATOM[i]_CH[x]_CN0 is in down counting phase. The down counting phase is reported by the according interrupt.

The described workaround is only possible for ATOM as long as the ARU interface is disabled and the new shadow register values are delivered by configuration interface and not by ARU interface.

GTM_AI.359 TOM: Both edges on TOM_OUT_T at unexpected times for RST_CCU0=1 and UDMODE>0

TOM channel is configured in up-down counter mode by setting of TOM[i]_CH[x]_CTRL.UDMODE>0 and the channel is triggered by a preceding channel or by TIM_EXT_CAPTURE with configuration of TOM[i]_CH[x]_CTRL.RST_CCU0=1.

Expected behaviour:

In up-counting phase, the output signal TOM_OUT is set to SL when $CN0 \geq CM1$ and the second output signal TOM_OUT_T has to be set to SL when $CN0 \geq CM0$.

In down-counting phase the output signals has to be set to !SL when $CN0 < CM1/CM0$.

Observed behaviour:

The second output signal TOM_OUT_T is set to SL in upcounting phase when $CN0 \geq CM0 - 1$, which is one CMU clock cycle to early.

When the counter is counting down, the output signal TOM_OUT_T is set to !SL when $CN0 < CM0 - 1$, which is one CMU clock cycle too late.

Scope

TOM

Effects

The second output signal TOM_OUT_T is set one CMU clock cycle too early in up-counting phase and one CMU clock cycle to late in down-counting phase.

Workaround

The compare value TOM[i]_CH[x]_CM0 for the second output signal TOM_OUT_T has to be configured with a value which is greater by one ($CM0+1$).

GTM_AI.360 SPEC-(A)TOM: PCM mode (BITREV=1) is only available for UDMODE=0

If TOM/ATOM channel is configured in PCM mode with (A)TOM[i]_CH[x]_CTRL.BITREV=1, the channel may be configured in up-counting mode only with (A)TOM[i]_CH[x]_CTRL.UDMODE=0.

Up-down counting mode ((A)TOM[i]_CH[x]_CTRL.UDMODE>0) is not supported for PCM mode.

Scope

TOM, ATOM

Effects

The user is not aware that the combination of PCM mode together with up-down counting mode is not supported and may not be used.

Workaround

Do not use the combination of PCM mode together with up-down counting mode.

GTM_AI.361 IRQ: Missing pulse in single-pulse interrupt mode on simultaneous interrupt and clear event

In single-pulse interrupt mode ([MODULE]_IRQ_MODE = 0b11) only the first interrupt event of the interrupt bits of the interrupt notify register inside this module generates a pulse on the output signal IRQ_line, if the associated interrupt is enabled ([MODULE]_IRQ_EN=1). All further interrupt events have no effect on the output signal IRQ_line until all enabled interrupts are cleared, except when an interrupt and a clear event (HW_clear or a SW_clear) occur at the same time.

Expected behaviour:

On simultaneous occurrence of an interrupt and clear event, a pulse on the output signal IRQ_line is generated.

Observed behaviour:

If the associated notify register bit of the interrupt event is not set and another bit of the same notify register is set and this interrupt is enabled, no pulse on the output signal IRQ_line is generated.

All modules ([MODULE]) are affected by this ERRATUM, which are able to generate interrupts and which have multiple interrupt sources which are ORed to the output. Not affected are the modules DPLL and ARU.

Scope

IRQ

Effects

Missing pulse on interrupt signal IRQ_line.

All modules, which deliver an interrupt signal and have more than one internal interrupt source which are ORed are affected. The only exceptions are the modules ARU and DPLL.

Workaround

On a SW clear prevent HW clear events and read the interrupt notify register to check on new interrupts without a received interrupt pulse on IRQ_line. In this case repeat the SW clear step to enable interrupt generation again.

When disabling the HW clear is not an option refrain from using the single-pulse interrupt mode.

GTM_AI.362 MCS: Using wrong WURM mask during execution of instruction WURMX or WURCX

If a WURM mask defined in R6 for usage with the instruction WURMX or WURCX is updated exactly one clock cycle before the associated instruction is executed, the WURMX or WURCX instruction is using the old (not yet updated) value of R6 as WURM mask for exactly one cluster clock cycle.

Example

Assume that the sequence

```
MOVL R6, 0x2
```

```
...
```

```
MOVL R6, 0x1
```

```
WURMX R0, STRG
```

is executed with Accelerated Scheduling Mode and the scheduler does not apply any delay between both instructions, the WURMX instruction is using the old value 0x2 as WURM mask for the very first cluster clock cycle. In subsequent cluster clock cycles the correct value 0x1 is used as WURM mask.

Scope

MCS

Effects

WURMX or WURCX instruction is sensitive to the wrong volatile bit to be observed (e.g. interrupt or trigger bit) for one cluster clock cycle.

Workaround

Ensure that delay between update of the WURM mask R6 and its associated WURM instruction is greater than one cluster clock cycle. For example:

1. Insert NOP instruction or another useful instruction between update of R6 and the associated WURMX or WURCX instruction.
2. use Round Robin Scheduling Mode.

GTM_AI.364 ATOM: ARU read request does not start at expected time-point in UDMODE=1 and UDMODE=3

ATOM is configured in SOMP continuous up-down counter mode with UDMODE=1,3 and ARU interface is enabled by setting of ARU_EN=1.

Expected behaviour:

A new ARU read request has to be started always after the operation registers are updated from their shadow registers. This depends on the UDMODE configuration:

- UDMODE=1: New ARU read request after CN0 changes the count direction from down to up.
- UDMODE=2: New ARU read request after CN0 changes the count direction from up to down.
- UDMODE=3: New ARU read request in both cases.

Observed behaviour:

A new ARU read request is always started when the counter CN0 changes the count direction from up to down, independently from UDMODE configuration.

- UDMODE=1: New ARU read request after CN0 changes the count direction from up to down.
- UDMODE=2: Works as expected.
- UDMODE=3: New ARU read request after CN0 changes the count direction from up to down.

Scope

ATOM

Effects

The effect depends on the UDMODE configuration:

- UDMODE=1: The remaining time, from starting a ARU read request until new data from ARU should be received is only half of the defined PWM period instead of the full PWM period.
- UDMODE=3: No new ARU read request is started when the counter CN0 changes the count direction from down to up and therefore no new data can be delivered in this case.

Workaround

Workaround for UDMODE=1:

The PWM period length in up-down counter mode has to be double the length as the ARU round trip cycle (plus 3 ARU clock cycles).

Workaround for UDMODE=3:

Use AEI interface for reloading new shadow register values instead of ARU.

GTM AI.367 MCS: Instructions WURMX and WURCX implement invalid extended register set for argument A

Current implementation uses register set XOREG for the argument A of instructions WURMX and WURCX. However, the specification only allows the usage of the register set OREG, which is a subset of XOREG. In detail: the current implementation is evaluating a don't care bit of its instruction code (bit position 14) for determination of the register address A.

Scope

MCS

Effects

If the SW tool chain is expanding a '1' for the don't care bit at position 14, the WURMX and WURCX instruction will use a wrong register A.

Workaround

The SW tool chain must ensure that the unused don't care bits of these instructions are always expanded as '0'.

GTM_AI.370 TOM/ATOM: Unexpected reset of CN0 in up-down counter mode and CM0=2

TOM/ATOM is configured in SOMP mode with `ATOM[i]_CH[x]_CTRL.MODE=0b10` (only for ATOM) and up-down counter mode is enabled by setting of `(A)TOM[i]_CH[x]_CTRL.UDMODE != 0b00`.

Expected behaviour:

In this case, the counter CN0 changes its count direction from up to down either until CN0 reaches CM0-1 for `RST_CCU0=0` or with the selected trigger signal TRIGIN (`EXT_TRIG=0`) or `EXT_TRIGIN` (`EXT_TRIG=1`) for `RST_CCU0=1`.

Observed behaviour:

There are three different configuration scenarios, where the counter CN0 is unexpectedly reset.

- 1. In case of `RST_CCU0=0`:
 - The period value inside CM0 is configured to 2 and then reconfigured to a value greater than 2. After the counter CN0 starts incrementing and reaches value 1, CN0 is once reset to 0 unexpectedly, before it starts incrementing again.
- 2. In case of `RST_CCU0=1` and `EXT_TRIG=0`:
 - The TRIGIN signal from a preceding channel is used to reset the count direction of CN0.
 - After the period value CM0 of the preceding channel is reconfigured from value 2 to a greater value, CN0 of this channel, which is triggered by the preceding channel, is once reset to 0 similar to the first scenario, which happens in the preceding channel.
- 3. In case of `RST_CCU0=1` and `EXT_TRIG=1`:
 - The `EXT_TRIGIN` signal from TIM module is used to reset the count direction of CN0.
 - If the `EXT_TRIGIN` signal occurs while the counter CN0 is incrementing and reaches the value 1, CN0 is once reset unexpectedly. However, there is already no deterministic dependency between the `EXT_TRIGIN` signal and the reset of CN0.

Scope

TOM, ATOM

Effects

Unexpected reset of the counter CN0.

Workaround

No workaround available. The following limitations have to be considered:

- For scenario 1 and 2:
 - Do not use value 2 for the period, which is configured inside CM0.
- For scenario 3:
 - Do not use EXT_TRIGIN as trigger signal to change the count direction in up-down counter mode.

GTM AI.371 MCS: Instruction MWRIL applies unexpected address offset calculation

The MCS instruction MWRIL applies an address offset calculation by evaluation of bits 2 to 15 of the corresponding instruction code, although these bits are defined as don't care bits.

Scope

MCS

Effects

If the don't care bits 2 to 15 of the instruction code are set unequal to zero, a wrong address is calculated for the memory access.

Workaround

Ensure that the don't care bits 2 to 15 of the instruction word are set to zero.

GTM_AI.374 SPEC-ATOM: Statement on timing of duty cycle output level change not correct for SOMP up/down-counter mode

The duty cycle output level is determined by ATOM[i]_CH[x]_CTRL.SL bit. The specification describes in section 15.3.3 “ATOM Signal output mode PWM (SOMP)” of the GTM chapter in the AURIX™ TC3xx User’s Manual, that “the duty cycle output level can be changed during runtime by writing the new duty cycle level into SL bit of the channels configuration register” (section 15.3.3.4). Further, it is mentioned: “the new signal level becomes active for the next trigger CCU_TRIGx (since bit SL is written)”.

However, the timing specification in the second part of the statement is only valid for the SOMP in up-counter mode. When the ATOM is configured in SOMP up/down-counter mode, the new signal level becomes immediately active, when the ATOM[i]_CH[x]_CTRL.SL bit is written.

Scope

ATOM

Effects

When the ATOM channel is configured in SOMP up/down-counter mode, a change of bit ATOM[i]_CH[x]_CTRL.SL will be visible immediately after the value is written by software and not, as described in the specification, with the next compare match event of one of the CCUx compare units.

Workaround

No workaround for SOMP up/down-counter mode. Use SOMP up-counter mode, if update of SL-Bit needed during runtime.

GTM_AI.375 ATOM: Data from ARU are read only once in SOMC mode even though ARU blocking mode is disabled while FREEZE=1 and EN-DIS=0

ATOM is configured in SOMC mode and ARU input stream is enabled and ARU blocking mode is disabled.

Configuration register setting:

ATOM[i]_CH[x]_CTRL.MODE==0b01 (SOMC mode)

ATOM[i]_CH[x]_CTRL.ARU_EN==0b1 (ARU input stream enabled)

ATOM[i]_CH[x]_CTRL.ABM==0b0 (ARU blocking mode disabled)

Expected behaviour:

If the channel gets disabled while ATOM[i]_CH[x]_CTRL.FREEZE is set, a pending ARU read request will still be held active, even if the current request is served from ARU with valid data. This is the expected non-blocking behavior.

Observed behaviour:

If the channel gets disabled while ATOM[i]_CH[x]_CTRL.FREEZE is set and afterwards the ARU read request is served by an ARU read valid, the ARU read request is reset and no more data is requested from ARU interface. This corresponds to a blocking behavior.

Scope

ATOM

Effects

In SOMC mode and activated FREEZE mode, reading new compare values stops after the first received data instead of continuing data reads.

Workaround

Instead of using the ARU interface for reloading new compare values while the channel is in FREEZE mode, the configuration interface can be used to deliver the new compare values.

If DPLL is used as data source for the ATOM compare values, an MCS channel has to be used to first read the data from DPLL by ARU interface and afterwards to write the data via MCS master interface to ATOM. The used MCS module has to be in the same cluster as the ATOM module.

GTM_AI.376 TOM/ATOM: Interrupt trigger signals CCU0TC_IRQ and CCU1TC_IRQ are delayed by one CMU_CLK period related to the output signals

Interrupt trigger signals CCU0TC_IRQ and CCU1TC_IRQ are delayed by one CMU_CLK period if the following configurations are used:

1. Both CCU0TC_IRQ and CCU1TC_IRQ are affected (ATOM: in SOMP mode) when the channel is configured in up-down counter mode ((A)TOM[i]_CH[x]_CTRL.UDMODE>0)
2. CCU1TC_IRQ only is affected (ATOM: in SOMP mode) when the channel is configured in up-counter mode ((A)TOM[i]_CH[x]_CTRL.UDMODE==0) and (A)TOM[i]_CH[x]_CTRL.SR0_TRIG is enabled

Scope

ATOM, TOM

Effects

Interrupt signals CCU0TC_IRQ and CCU1TC_IRQ are raised with a delay of one CMU_CLK period.

Depending on the CMU_CLK period related to system frequency outside of the GTM this can be an issue or none at all.

Workaround

No workaround available.

GTM_AI.387 DPLL: Wrong calculation of pulse generator frequency for DPLL_CTRL_0.AMT/S=1 and DPLL_CTRL_11.ADT/S=1 when number of pulses (DPLL_CTRL_0.MLT or DPLL_MLS1/2.MLS1/2) is too small

When the number of pulses per increment DPLL_CTRL_0.MLT is smaller than 127, or DPLL_MLS1/2.MLS1/2 is smaller than 128 and the correction of physical deviations is used (DPLL_CTRL_0.AMT/AMS=1 and DPLL_CTRL_11.ADT/ADS=1), the calculation of internal values such as DPLL_DT_T/S_ACT.DT_T/S_ACT, DPLL_RDT_T/S_ACT.RDT_T/S_ACT,

Functional Deviations

and DPLL_ADD_IN_CAL1/2.ADD_IN_CAL_1/2 is wrong. The resulting frequency of the generated sub increment pulses of the DPLL is too small.

Scope

DPLL

Effects

The frequency of the generated sub increment pulses of the DPLL is too small. This leads to an unbalanced generation of micro ticks.

Workaround

1. Do not use pulse numbers DPLL_CTRL_0.MLT < 127 and/or DPLL_MLS1/2.MLS1/2 < 128, when using correction of physical deviation (DPLL_CTRL_11.ADT/ADS=1 when DPLL_CTRL_0.AMT/AMS=1)
2. When workaround 1. cannot be applied use configuration DPLL_CTRL_11.ADT/ADS=0 when DPLL_CTRL_0.AMT/AMS=1 is used

GTM_TC.018 DPLL RAM trace data can be wrong

Note: This problem only has an effect during debugging.

The OCDS Trigger Bus Interface supports routing of various trigger sets to MCDS on OTGBM0 and OTGBM1 (see table “Trigger Set Mapping Options” in the GTM chapter).

Tracing of addresses or data of a DPLL RAM on one part of the OTGBM interface (OTGBM0 or OTGBM1, respectively) can create wrong DPLL RAM trace data when any other source (including data or addresses of a different DPLL RAM) is configured for the other part of the OTBGM interface (OTGBM1 or OTGBM0, respectively).

Workaround

- If DPLL RAM addresses are configured for OTGBM0 (bit field OTSS.OTGBM0 = 2 or 3 or 4):
 - only DPLL RAM data of the same DPLL RAM may be selected for OTGBM1 (i.e. OTSS.OTGBM1 must be equal to OTSS.OTGBM0);

- otherwise “No Trigger Set” must be selected for OTGBM1 (OTSS.OTGBM1 = 0).
- If DPLL RAM data are configured for OTGBM1 (bit field OTSS.OTGBM1 = 2 or 3 or 4):
 - only DPLL RAM addresses of the same DPLL RAM may be selected for OTGBM0 (i.e. OTSS.OTGBM1 must be equal to OTSS.OTGBM0);
 - otherwise “No Trigger Set” must be selected for OTGBM0 (OTSS.OTGBM0 = 0).

GTM_TC.019 ARU can not be traced if GTM cluster 5 is disabled

Note: This problem only has an effect during debugging.

Tracing of the ARU is controlled by the GTM cluster 5 clock. If cluster 5 is disabled, the ARU can not be traced anymore.

Workaround

Do not disable GTM cluster 5 if ARU shall be traced.

GTM_TC.020 Debug/Normal read access control via bit field ODA.DRAC

A few GTM registers have a different read behavior when accessing them with debug read accesses (see section “GTM Software Debugger Support” in the GTM chapter of the User’s Manual for further details).

Depending on the reading master and the configuration of bit field DRAC in register GTM_ODA (OCDS Debug Access Register), the read can be performed in a specific way for debug related read operation.

According to the User’s Manual the read is performed as a debug read operation

- for all masters when ODA.DRAC = 10_B or 11_B,
- for the Cerberus (OCDS) FPI master when ODA.DRAC = 00_B

Problem Description

In the current implementation the read is performed as debug read operation

- for all masters when ODA.DRAC = 10 or 11_B,
- for the CPU2 FPI master when ODA.DRAC = 00_B

Workaround

The problem described above has 2 aspects:

1. For CPU2 Access to GTM

When the CPU2 FPI master is used to perform a normal read of the GTM registers mentioned above, setting ODA.DRAC = 01_B is required to avoid an unintended debug read access that would be caused by this issue.

2. For Cerberus (OCDS) Access to GTM

When ODA.DRAC = 00_B, due to this problem any read access of the Cerberus (OCDS) FPI master to the registers that by default have a different behavior between normal and debug read will cause the normal read behavior. To get the intended debug read behavior, ODA.DRAC needs to be set to 10_B or 11_B before each access of the Cerberus and set back to 00_B afterwards to not affect the access of other FPI masters on the registers mentioned above.

GTM_TC.021 Registers CANOUTSEL0, CANOUTSEL1 - Documentation update for fields SELx (x = 0, 1)

The description in the current version of the product specific TC3xx Appendix regarding fields SELx (x = 0, 1) in registers CANOUTSEL0 and CANOUTSEL1 is partly incorrect and will be updated as shown in the following tables.

Note: The changes only affect settings $8_H..F_H$ in fields SEL0 and SEL1 of registers CANOUTSEL0 and CANOUTSEL1, respectively.

Table 11 GTM_CANOUTSEL0 - CAN0/CAN1 Output Select Register - Documentation update for fields SELx (x = 0, 1)

Field	Description
SELx (x = 0)	Output Selection for GTM to CAN connection x This bit field defines which TOM/ATOM channel output is used as CAN0/CAN1 node trigger x.
0 _H ..7 _H	- No change: see description in TC3xx Appendix-
8 _H	CDTM0_DTM1_2, TOM0_6 , Dead-time output of TOM0, channel 6
9 _H	CDTM0_DTM1_3, TOM0_7 , Dead-time output of TOM0, channel 7
A _H	TOM0_13 , Output of TOM0, channel 13
B _H	TOM0_14 , Output of TOM0, channel 14
C _H	CDTM0_DTM5_0, ATOM0_4 , Dead-time output of ATOM0, channel 4
D _H	CDTM0_DTM5_1, ATOM0_5 , Dead-time output of ATOM0, channel 5
E _H	CDTM0_DTM5_2, ATOM0_6 , Dead-time output of ATOM0, channel 6
F _H	CDTM0_DTM5_3, ATOM0_7 , Dead-time output of ATOM0, channel 7
SELx (x = 1)	Output Selection for GTM to CAN connection x This bit field defines which TOM/ATOM channel output is used as CAN0/CAN1 node trigger x.
0 _H ..7 _H	- No change: see description in TC3xx Appendix-
8 _H	CDTM1_DTM1_2, TOM1_6 , Dead-time output of TOM1, channel 6
9 _H	CDTM1_DTM1_3, TOM1_7 , Dead-time output of TOM1, channel 7
A _H	TOM1_13 , Output of TOM1, channel 13
B _H	TOM1_14 , Output of TOM1, channel 14

Table 11 GTM_CANOUTSEL0 - CAN0/CAN1 Output Select Register - Documentation update for fields SELx (x = 0, 1) (cont'd)

Field	Description
C _H	CDTM1_DTM5_0, ATOM1_4 , Dead-time output of ATOM1, channel 4
D _H	CDTM1_DTM5_1, ATOM1_5 , Dead-time output of ATOM1, channel 5
E _H	CDTM1_DTM5_2, ATOM1_6 , Dead-time output of ATOM1, channel 6
F _H	CDTM1_DTM5_3, ATOM1_7 , Dead-time output of ATOM1, channel 7

Table 12 GTM_CANOUTSEL1 - CAN2 Output Select Register - Documentation update for fields SELx (x = 0, 1)

Field	Description
SELx (x = 0)	Output Selection for GTM to CAN connection x This bit field defines which TOM/ATOM channel output is used as CAN2 node trigger x.
0 _H ..7 _H	- No change: see description in TC3xx Appendix-
8 _H	CDTM0_DTM1_2, TOM0_6 , Dead-time output of TOM0, channel 6
9 _H	CDTM0_DTM1_3, TOM0_7 , Dead-time output of TOM0, channel 7
A _H	TOM0_13 , Output of TOM0, channel 13
B _H	TOM0_14 , Output of TOM0, channel 14
C _H	CDTM0_DTM5_0, ATOM0_4 , Dead-time output of ATOM0, channel 4
D _H	CDTM0_DTM5_1, ATOM0_5 , Dead-time output of ATOM0, channel 5
E _H	CDTM0_DTM5_2, ATOM0_6 , Dead-time output of ATOM0, channel 6

Table 12 GTM_CANOUTSEL1 - CAN2 Output Select Register - Documentation update for fields SELx (x = 0, 1) (cont'd)

Field	Description	
	F _H	CDTM0_DTM5_3, ATOM0_7 , Dead-time output of ATOM0, channel 7
SELx (x = 1)	Output Selection for GTM to CAN connection x This bit field defines which TOM/ATOM channel output is used as CAN0/CAN1 node trigger x.	
	0 _H ..7 _H	- No change: see description in TC3xx Appendix-
	8 _H	CDTM1_DTM1_2, TOM1_6 , Dead-time output of TOM1, channel 6
	9 _H	CDTM1_DTM1_3, TOM1_7 , Dead-time output of TOM1, channel 7
	A _H	TOM1_13 , Output of TOM1, channel 13
	B _H	TOM1_14 , Output of TOM1, channel 14
	C _H	CDTM1_DTM5_0, ATOM1_4 , Dead-time output of ATOM1, channel 4
	D _H	CDTM1_DTM5_1, ATOM1_5 , Dead-time output of ATOM1, channel 5
	E _H	CDTM1_DTM5_2, ATOM1_6 , Dead-time output of ATOM1, channel 6
	F _H	CDTM1_DTM5_3, ATOM1_7 , Dead-time output of ATOM1, channel 7

GTM_TC.022 Register ATOMi_AGC_ENDIS_STAT - Documentation Update

Note: This erratum might affect the SFR C Header Definitions. In such cases, SFR usage in the software shall be analyzed within the applications for their correct handling.

In the description of register ATOMi_AGC_ENDIS_STAT (i=0-11) in the GTM chapter of the current version of the TC3xx User's Manual,

Functional Deviations

- the symbolic bit names in the register image and in column “Field” shall be changed from ENDIS_CTRLx to ENDIS_STATx (x=0-7);
- in column “Description”, the description shall be extended with the behavior on a read access as shown below:
 - Write access:
 - 0b00 Don't care, bits will not be changed
 - 0b01 Disable channel
 - 0b10 Enable channel
 - 0b11 Don't care, bits will not be changed
 - Read access:
 - 0b00 Channel disabled
 - 0b01 Unused
 - 0b10 Unused
 - 0b11 Channel enabled

HSCT_TC.012 HSCT sleep mode not supported

Due to unreliability of the wake-up functionality, sleep mode for the HSCT is no longer supported and shall not be used.

Do not set bit SLEEPCTRL.SLPEN = 1_B.

HSCT_TC.013 Internal Loopback Mode not reliable

The internal loopback mode used for looping the HSCT TX data back internally to HSCT RX is not reliable to work under all operating conditions.

Therefore, do not use the internal loopback mode (i.e. do not set bit TESTCTRL.LLOPTXRX = 1_B).

Workaround

Use external loopback by configuring another external device (slave) by sending an interface control command with payload value = 0xFF (Turn on payload loopback) from the master interface.

MCDS_TC.052 TriCore wrap around write access causes redundant MCDS message

Note: This problem is only relevant for development tools. This problem corresponds to problem miniMCDS_TC.005 for devices with miniMCDS.

This effect will only occur for Circular Addressing Mode when there is an unaligned write access at the wrap around boundary. There is no known case where such an access would be generated for normal compiled code.

When TriCore performs such an access, MCDS generates a redundant message.

Example:

TriCore writes 0x87654321 to address 0xAF01F90E, but due to wrap around it first writes 0x4321 to 0xAF01F90E and then writes 0x8765 to 0xAF01F900.

MCDS outputs the following messages:

- DTU_<AorB>_TCX.DTW 0x8765 0xAF01F900
 - i.e. writing HWORD(8765) to AF01F900
- DTU_<AorB>_TCX.DTW 0x87654321 0xAF01F90E
 - i.e. writing WORD(87654321) to AF01F90E

Workaround

No workaround possible.

MCDS_TC.064 ACCEN0 register write not supervisor protected

Note: This problem is only relevant for development tools.

The write access terms for register ACCEN0 are defined as “SV, SE” (access only when Supervisor Mode/Safety Endinit is active) in table “Registers Overview” in the MCDS and MCDSLigh chapter of the TC3XX_ED documentation.

Actually, the implementation of register ACCEN0 in the MCDS and MCDSLigh modules does not have Supervisor Mode protection (“SV”), it only has Safety Endinit protection (“SE”).

MCDS TC.065 Selection of SRI trace sources

Note: This problem is only relevant for development tools. It corresponds to problem miniMCDS_TC.006 for devices with miniMCDS.

The MCDS/MCDSlight provides the capability to trace accesses to the SRI Slaves CPUx_MEMSlave, LMU0, OLDA, to trace accesses initiated by the SRI Master DMA, and to trace SPU output events.

The signal timing at these interfaces is compliant to the Infineon internal SRI bus protocol. The bus protocol consists of an address and data phase. It is not possible to select one of the above trace sources while transactions are ongoing. This can lead to permanently corrupted MCDS trace messages.

Workaround

Switch to the trace source only in a time frame when no transactions are ongoing.

MCDS TC.066 Selection of CPU trace sources

Note: This problem is only relevant for development tools. It corresponds to problem miniMCDS_TC.007 for devices with miniMCDS.

The MCDS/MCDSlight provides the capability to trace CPU read/write accesses to registers and memories.

The signal protocol at the CPU trace interface has separated address and data phases. If another CPU is selected as trace source while the CPU is running, this can lead to the effect that no MCDS data trace messages are generated anymore.

Workaround

Switch to another CPU trace source only at a time when no CPU transactions are ongoing (e.g. CPU halted).

MCDS_TC.067 MCDS kernel reset shall not be used

Note: This problem is only relevant for development tools. It corresponds to problem miniMCDS_TC.008 for devices with miniMCDS.

If an MCDS/MCDSlight kernel reset is triggered via bit CT.SETR, this can confuse the data trace generation with the duplex DTUs. In this case data trace messages are missing and wrong data trace messages are generated where the data part and the address part are from different data transactions. This confused state of the DTU is then permanent.

Workaround

Do not use the MCDS/MCDSlight kernel reset.

In case of reprogramming set all used MCDS/MCDSlight configuration registers to new values or to their reset values.

MCMCAN_AI.015 Edge filtering causes mis-synchronization when falling edge at Rx input pin coincides with end of integration phase

When edge filtering is enabled (CCCRi.EFBI = '1') and when the end of the integration phase coincides with a falling edge at the Rx input pin it may happen, that the MCMCAN synchronizes itself wrongly and does not correctly receive the first bit of the frame. In this case the CRC will detect that the first bit was received incorrectly, it will rate the received FD frame as faulty and an error frame will be send.

The issue only occurs, when there is a falling edge at the Rx input pin within the last time quantum (tq) before the end of the integration phase. The last time quantum of the integration phase is at the sample point of the 11th recessive bit of the integration phase. When the edge filtering is enabled, the bit timing logic of the MCMCAN sees the Rx input signal delayed by the edge filtering. When the integration phase ends, the edge filtering is automatically disabled. This affects the reset of the FD CRC control unit at the beginning of the frame. The Classical CRC control unit is not affected, so this issue does not affect the reception of Classical frames.

Functional Deviations

In CAN communication, the MCMCAN may enter integrating state (either by resetting CCCRi.INIT or by protocol exception event) while a frame is active on the bus. In this case the 11 recessive bits are counted between the acknowledge bit and the following start of frame. All nodes have synchronized at the beginning of the dominant acknowledge bit. This means that the edge of the following start of frame bit cannot fall on the sample point, so the issue does not occur. The issue occurs only when the MCMCAN is, by local errors, mis-synchronized with regard to the other nodes, or not synchronized at all.

Glitch filtering as specified in ISO 11898-1:2015 is fully functional.

Edge filtering was introduced for applications where the data bit time is at least two t_q (of the nominal bit time) long. In that case, edge filtering requires at least two consecutive dominant time quanta before the counter counting the 11 recessive bits for idle detection is restarted. This means edge filtering covers the theoretical case of occasional 1- t_q -long dominant spikes on the CAN bus that would delay idle detection. Repeated dominant spikes on the CAN bus would disturb all CAN communication, so the filtering to speed up idle detection would not help network performance.

When this rare event occurs, the MCMCAN sends an error frame and the sender of the affected frame retransmits the frame. When the retransmitted frame is received, the MCMCAN has left integration phase and the frame will be received correctly. Edge filtering is only applied during integration phase, it is never used during normal operation. As integration phase is very short with respect to “active communication time”, the impact on total error frame rate is negligible. The issue has no impact on data integrity.

The MCMCAN enters integration phase under the following conditions:

- when CCCRi.INIT is set to '0' after start-up
- after a protocol exception event (only when CCCRi.PXHD = '0').

Scope

The erratum is limited to FD frame reception when edge filtering is active (CCCRi.EFBI = '1') and when the end of the integration phase coincides with a falling edge at the Rx input pin.

Effects

The calculated CRC value does not match the CRC value of the received FD frame and the MCMCAN sends an error frame. After retransmission the frame is received correctly.

Workaround

Disable edge filtering or wait on retransmission in case this rare event happens.

MCMCAN_AI.017 Retransmission in DAR mode due to lost arbitration at the first two identifier bits

When the MCMCAN CAN Node is configured in DAR mode (CANx.CCCRi.DAR = '1') the Automatic Retransmission for transmitted messages that have been disturbed by an error or have lost arbitration is disabled. When the transmission attempt is not successful, the Tx Buffer's transmission request bit (CANx.TXBRPi.TRPz) shall be cleared and its cancellation finished bit (CANx.TXBCFi.CFz) shall be set.

When the transmitted message loses arbitration at one of the first two identifier bits, it may happen, that instead of the bits of the actually transmitted Tx Buffer, the CANx.TXBRPi.TRPz and CANx.TXBCFi.CFz bits of the previously started Tx Buffer (or Tx Buffer 0 if there is no previous transmission attempt) are written (CANx.TXBRPi.TRPz = '0', CANx.TXBCFi.CFz = '1').

If in this case the CANx.TXBRPi.TRPz bit of the Tx Buffer that lost arbitration at the first two identifier bits has not been cleared, retransmission is attempted.

When the CAN Node loses arbitration again at the immediately following retransmission, then actually and previously transmitted Tx Buffer are the same and this Tx Buffer's CANx.TXBRPi.TRPz bit is cleared and its CANx.TXBCFi.CFz bit is set.

Scope

The erratum is limited to the case when the MCMCAN CAN Node loses arbitration at one of the first two transmitted identifier bits while in DAR mode.

The problem does not occur when the transmitted message has been disturbed by an error.

Effects

In this case it may happen, that the CANx.TXBRPi.TRPz bit is cleared after the second transmission attempt instead of the first.

Additionally it may happen that the CANx.TXBRPi.TRPz bit of the previously started Tx Buffer is cleared, if it has been set again. As in this case the previously started Tx Buffer has lost MCMCAN internal arbitration against the active Tx Buffer, its message has a lower identifier priority. It would also have lost arbitration on the CAN bus at the same position.

Workaround

None.

MCMCAN_AI.018 Tx FIFO Message Sequence Inversion

Assume the case that there are two Tx FIFO messages in the output pipeline of the Tx Message Handler (TxMH) and transmission of Tx FIFO message 1 is started:

- Position 1: Tx FIFO message 1 (transmission ongoing)
- Position 2: Tx FIFO message 2
- Position 3: --

Now a non-Tx FIFO message with a higher CAN priority is requested. Due to its priority it will be inserted into the output pipeline. The TxMH performs so called “message-scans” to keep the output pipeline up to date with the highest priority messages from the Message RAM. After the following two message-scans the output pipeline has the following content:

- Position 1: Tx FIFO message 1 (transmission ongoing)
- Position 2: non Tx FIFO message with higher CAN priority
- Position 3: Tx FIFO message 2

If the transmission of Tx FIFO message 1 is not successful (lost arbitration or CAN bus error) it is pushed from the output pipeline by the non-Tx FIFO message with higher CAN priority. The following scan re-inserts Tx FIFO message 1 into the output pipeline at position 3:

Functional Deviations

- Position 1: non Tx FIFO message with higher CAN priority (transmission ongoing)
- Position 2: Tx FIFO message 2
- Position 3: Tx FIFO message 1

Now Tx FIFO message 2 is in the output pipeline in front of Tx FIFO message 1 and they are transmitted in that order, resulting in a message sequence inversion.

Note: Within the scope of the scenario described above, in case of more than two Tx FIFO messages, the Tx FIFO message that has lost arbitration will be inserted after the next pending Tx FIFO message.

Scope:

The erratum describes the case when the MCMCAN uses both, dedicated Tx Buffers and a Tx FIFO (CAN_TXBCi.TFQM = '0') and the messages in the Tx FIFO do not have the highest internal CAN priority. The described sequence inversion may also happen between two non-Tx FIFO messages (Tx Queue or dedicated Tx Buffers) that have the same CAN identifier and that should be transmitted in the order of their buffer numbers (not the intended use).

Effects:

In the described case it may happen that two consecutive messages from the Tx FIFO exchange their positions in the transmit sequence.

Workaround

When transmitting messages from a dedicated Tx Buffer with higher priority than the messages in the Tx FIFO, choose one of the following workarounds:

First Workaround:

Use two dedicated Tx Buffers, e.g. use Tx Buffers 4 and 5 instead of the Tx FIFO.

The pseudo-code below replaces the function that fills the Tx FIFO.

- Write message to Tx Buffer 4
- Transmit Loop:
 - Request Tx Buffer 4 - write TXBAR.A4

- Write message to Tx Buffer 5
- Wait until transmission of Tx Buffer 4 completed – CAN_IRi.TC, read CAN_TXBTOi.TO4
- Request Tx Buffer 5 - write CAN_TXBARi.AR5
- Write message to Tx Buffer 4
- Wait until transmission of Tx Buffer 5 completed – CAN_IRi.TC, read CAN_TXBTOi.TO5

Second Workaround:

Assure that only one Tx FIFO element is pending for transmission at any time. The Tx FIFO elements may be filled at any time with messages to be transmitted, but their transmission requests are handled separately. Each time a Tx FIFO transmission has completed and the Tx FIFO gets empty (CAN_IRi.TFE = '1') the next Tx FIFO element is requested.

Third Workaround:

Use only a Tx FIFO. Send the message with the higher priority also from Tx FIFO.

Drawback: The higher priority message has to wait until the preceding messages in the Tx FIFO have been sent.

MCMCAN_AI.019 Unexpected High Priority Message (HPM) interrupt

There are two configurations where the issue occurs:

Configuration A:

- At least one Standard Message ID Filter Element is configured with priority flag set (S0.SFEC = "100"/"101"/"110")
- No Extended Message ID Filter Element configured
- Non-matching extended frames are accepted (GFC.ANFE = "00"/"01")

The HPM interrupt flag IR.HPM is set erroneously on reception of a non-high-priority extended message under the following conditions:

1. A standard HPM frame is received, and accepted by a filter with priority flag set
--> Interrupt flag IR.HPM is set as expected
2. Next an extended frame is received and accepted because of GFC.ANFE configuration
--> Interrupt flag IR.HPM is set erroneously

Configuration B:

- At least one Extended Message ID Filter Element is configured with priority flag set (F0.EFEC = "100"/"101"/"110")
- No Standard Message ID Filter Element configured
- Non-matching standard frames are accepted (GFC.ANFS = "00"/"01")

The HPM interrupt flag IR.HPM is set erroneously on reception of a non-high-priority standard message under the following conditions:

1. An extended HPM frame is received, and accepted by a filter with priority flag set
--> Interrupt flag IR.HPM is set as expected
2. Next a standard frame is received and accepted because of GFC.ANFS configuration
--> Interrupt flag IR.HPM is set erroneously

Scope

The erratum is limited to:

- Configuration A:
 - No Extended Message ID Filter Element configured and non-matching extended frames are accepted due to Global Filter Configuration (GFC.ANFE = "00"/"01").
- Configuration B:
 - No Standard Message ID Filter Element configured and non-matching standard frames are accepted due to Global Filter Configuration (GFC.ANFS = "00"/"01").

Effects

Interrupt flag IR.HPM is set erroneously at the reception of a frame with:

- Configuration A: extended message ID
- Configuration B: standard message ID

Workaround

Configuration A:

Setup an Extended Message ID Filter Element with the following configuration:

- F0.EFEC = "001"/"010" - select Rx FIFO for storage of extended frames
- F0.EFID1 = any value - value not relevant as all ID bits are masked out by F1.EFID2
- F1.EFT = "10" - classic filter, F0.EFID1 = filter, F1.EFID2 = mask
- F1.EFID2 = zero - all bits of the received extended ID are masked out

Now all extended frames are stored in Rx FIFO 0 respectively Rx FIFO 1 depending on the configuration of F0.EFEC.

Configuration B:

Setup a Standard Message ID Filter Element with the following configuration:

- S0.SFEC = "001"/"010" - select Rx FIFO for storage of standard frames
- S0.SFID1 = any value - value not relevant as all ID bits are masked out by S0.SFID2
- S0.SFT = "10" - classic filter, S0.SFID1 = filter, S0.SFID2 = mask
- S0.SFID2 = zero - all bits of the received standard ID are masked out

Now all standard frames are stored in Rx FIFO 0 respectively Rx FIFO 1 depending on the configuration of S0.SFEC.

MCMCAN_AI.022 Message order inversion when transmitting from dedicated Tx Buffers configured with same Message ID

Configuration

Several Tx Buffers are configured with the same Message ID. Transmission of these Tx Buffers is requested sequentially with a delay between the individual Tx requests.

Expected behaviour

When multiple Tx Buffers that are configured with the same Message ID have pending Tx requests, they shall be transmitted in ascending order of their Tx Buffer numbers. The Tx Buffer with lowest buffer number and pending Tx request is transmitted first.

Observed behaviour

It may happen, depending on the delay between the individual Tx requests, that in the case where multiple Tx Buffers are configured with the same Message ID the Tx Buffers are not transmitted in order of the Tx Buffer number (lowest number first).

Scope

The erratum is limited to the case when multiple Tx Buffers are configured with the same Message ID.

Effects

In the case described it may happen that Tx Buffers configured with the same Message ID and pending Tx request are not transmitted with lowest Tx Buffer number first (message order inversion).

Workaround

First write the group of Tx messages with same Message ID to the Message RAM and then afterwards request transmission of all these messages concurrently by a single write access to **TXBARi**. Before requesting a group of Tx messages with this Message ID ensure that no message with this Message ID has a pending Tx request.

MCMCAN AI.023 Incomplete description in section *.5.2 “Dedicated Tx Buffers” and *.5.4 “Tx Queue” of the M_CAN documentation in the User’s

Manual related to transmission from multiple buffers configured with the same Message ID

*Note: The absolute chapter number * depends on the version of the User's Manual.*

Section *.5.2 Dedicated Tx Buffers

Wording User's Manual

In case that multiple dedicated Tx Buffers are configured with the same Message ID, the Tx Buffer with the lowest buffer number is transmitted first.

Enhancement - additional text

These Tx buffers shall be requested in ascending order with lowest buffer number first.

Alternatively all Tx buffers configured with the same Message ID can be requested simultaneously by a single write access to **TXBARI**.

Section *.5.4 Tx Queue

Wording User's Manual - to be deleted

In case that multiple Queue Buffers are configured with the same Message ID, the Queue Buffer with the lowest buffer number is transmitted first.

Replacement

In case that multiple Tx Queue buffers are configured with the same Message ID, the transmission order depends on numbers of the buffers where the messages were stored for transmission. As these buffer numbers depend on the then current states of the PUT index, a prediction of the transmission order is not possible.

Wording User's Manual - to be deleted

An Add Request cyclically increments the Put Index to the next free Tx Buffer.

Replacement

The Put Index always points to that free buffer of the Tx Queue with the lowest buffer number.

Scope

Use of multiple dedicated Tx Buffers or Tx Queue buffers configured with same Message ID.

Effects

In case the dedicated Tx buffers with the same Message ID are not requested in ascending order or at the same time or in case of multiple Tx Queue buffers with the same Message ID, it cannot be guaranteed, that these messages are transmitted in ascending order with lowest buffer number first.

Workaround

In case a defined order of transmission is required the Tx FIFO shall be used for transmission of messages with the same Message ID. Alternatively dedicated Tx buffers with same Message ID shall be requested in ascending order with lowest buffer number first or by a single write access to **TXBARI**. Alternatively a single Tx Buffer can be used to transmit those messages one after the other.

MTU_TC.012 Security of CPU Cache Memories During Runtime is Limited

MTU chapter “Security Applications” in the User’s Manual describes that selected memories with potentially security relevant content are initialized under certain conditions to prevent reading of their data or supplying manipulated data.

The description is correct, but the initialization of CPU cache and cache tag memories triggered by MBIST enable/disable and when mapping/un-mapping these memories to/from system address space using MEMMAP register is of limited value:

- These memories stay functional as cache in the address mapped state. Therefore software can enable address mapping and afterwards watch

cache usage of the application (this is a debug feature). Even manipulation of the cache content is feasible.

- It is possible to abort an ongoing memory initialization.

The security of memory initialization during startup is not affected. Also protection of FSI0 and HSM memories is not limited.

Workaround

Handle security relevant data exclusively inside HSM. Protect the application code by locking external access (e.g. lock debug interface, prevent boot via serial interface). Consider validation of application code by HSM secure boot.

MTU_TC.017 Unexpected alarms after application reset

As described in the MTU chapter “Alarms after startup” section, in case of an application reset, there are no SSH alarms or status bits expected to be triggered.

However, this device deviates from this expected behavior, and status flags AG0.SF10 and AG1.SF10 (DMEM Uncorrectable critical error) are set also after an application reset. Correspondingly, the OPERR[0] bits of the following SSHs are also set in the corresponding MCi_FAULTSTS registers after an application reset:

- MC0 (CPU0_DMEM),
- MC34 (CPU0_DMEM1), and
- MC35 (CPU1_DMEM1)

Note: In contrast to alarms resulting from real errors, for these unexpected alarms after application reset MCi_ERRINFO = 0x0 (i = 0, 34, 35).

Workaround

The application software may clear the above mentioned alarms and errors after an application reset if MCi_ERRINFO = 0x0 (i = 0, 34, 35), and proceed.

In case these errors occur during normal application run, this shall be considered as a real error.

MTU_TC.018 Gated SRAM alarms

Due to a corner case, SRAM alarms to the SMU for SRAM errors are not correctly generated for the following modules.

- GTM: ALM6[10], ALM6[11];
- DMA, SCR: ALM6[19], ALM6[20];
- CPUx: ALMx[4], ALMx[7], ALMx[10]
(x = 0..n; n depends on number of CPUs available in product).

Background:

From the SRAMs, the following errors are triggered to the SMU:

- ECC-correctable error: Triggered on a read access to SRAM.
- ECC-uncorrectable error: Triggered on a read access to SRAM.
- Address error: Triggered on read or write access to SRAM.

In case of an error, normally these alarms are triggered appropriately on each read or write access.

However, due to this corner case, for certain SRAMs mentioned above, the alarm is not triggered on the read or write access on which the error is generated, rather, it is generated only on the **next** access to the SRAM or to an SSH register (e.g. MCx_ECCD register).

Note: Only the SMU alarm generation is affected by this issue and not the error triggering to the module. E.g. error notification to GTM MCS still works as expected and the MCS may be stopped on an uncorrectable ECC error.

Additionally, only the alarm propagation is gated in this corner case, i.e. the error status is still correctly stored in the MCx_ECCD, MCx_FAULTSTS registers.

Workaround**For GTM & SCR SRAMs**

Read the MCx_ECCD register periodically, depending on application safety considerations, for example within each diagnostic test interval.

- Corresponding SSH instances:
 - GTM: MC53..MC60;

- SCR: MC77, MC78.

For DMA & CPU SRAMs (except DLMUx_STBY)

No workaround is recommended, because here the issue affects only the address error generation on a write access. In this case, the next read access (when the data would be used) will trigger the error.

For DLMU_STBY

The issue occurs in a corner case just before entering standby mode. Therefore, if standby mode is used and Standby RAM is enabled ($\text{PMSWCR0.STBYRAMSEL} \neq 000_{\text{B}}$) - then just before entering standby, perform an additional dummy read to DLMU_STBY location 0x9000 0000 or 0xB000 0000 (when using CPU0 dLMU RAM) and 0x9001 0000 or 0xB001 0000 (when using CPU1 dLMU RAM). This dummy read triggers the alarm propagation and ensures that no alarms are lost due to standby entry.

MTU_TC.019 Type properties for reserved bits MCONTROL.R8, R12..R14 - Documentation update

In the description of register MCi_MCONTROL in the MTU chapter of the current version of the TC3xx User's Manual, the type properties of the reserved bits R8, R12, R13, R14 are indicated as read-only ("r").

- Actually, these bits are writable, i.e. the type of the reserved bits MCi_MCONTROL.R8, R12, R13, R14 is read/write ("rw").

Note:

As documented in the register description for MCi_MCONTROL,

- Bit R14 shall always be written with 1,
- Bits R8, R12, R13 shall always be written with 0.

PADS_TC.011 Pull-ups activate on specific analog inputs upon PORST

If $\text{HWCFG}[6] = 1$ or $\text{PMSWCR5.TRISTREQ} = 0$, respectively, the following analog inputs in the V_{DDM} domain:

- analog inputs overlaid with general purpose inputs (class S pads) on all pins of P40 and P41¹⁾,
- analog inputs (class D pads) of channels with multiplexer diagnostics²⁾,

will activate internal pull-ups during cold or warm PORST.

When PORST is deasserted and the internal circuitry is reset, the inputs mentioned above will be released to tri-state mode.

Note: This behavior differs from the description in the “Ports” chapter of the User’s Manual (P40/P41 always in tri-state mode during PORST) and the Data Sheet (corresponding pins marked with symbol “HighZ” in columns for buffer/pad type of the pin definition tables).

PMS_TC.005 Voltage rise at P33 and P34 up to $V_{\text{EVR SB}}$ during start-up and up to V_{LVDRSTB} during power-down

The HWCFG pins (located in the V_{EXT} domain) information is evaluated when basic supply and clock infrastructure components are available as the supplies $V_{\text{EVR SB}}$ and V_{EXT} ramp up. Tristate control information based on $\text{HWCFG}[6]$ latched with V_{EXT} supply ramp can’t be used within the $V_{\text{EVR SB}}$ supply domain until both supplies (V_{EXT} and $V_{\text{EVR SB}}$) have reached the minimum threshold value of V_{LVDRST5} and V_{LVDRSTB} , respectively.

Therefore, the pad behavior at P33 and P34 pins is “pull-up”, even if pin $\text{HWCFG}[6] = 0$, with the following characteristics:

- the pad voltage level rises to $V_{\text{EVR SB}}$ until the V_{LVDRSTB} and V_{LVDRST5} thresholds of $V_{\text{EVR SB}}$ and V_{EXT} are reached during the ramp-up phase,

1) Availability depends on TC3xy device version, see the product specific Data Sheet.

2) These channels are explicitly marked with (MD) in table “Analog Input Connections for Product TC3yx” in the EVADC chapter of the product specific appendix (file TC3yX_um_appx_V1.*.pdf) to the AURIX™ TC3XX User’s Manual.

- the pad voltage level is below $V_{LVDRSTSB}$ for the ramp-down phase of the V_{EVRSB} supply.

Workaround

If an application requires to ensure the state of P33 and P34 pins within the logical “low” level, then an external pull-down must be used which can overdrive the internal pull-up.

In order to quantify the strength of such an external pull-down, parameter “Pull-up current” (I_{PUH} , CC) for the respective pin may be used as the reference. There, the values for the internal pull-up resistor (for TTL and AL) can be found via parameter R_{MDU} in table “VADC 5V” (see footnotes on parameter “Pull-up current” in the Data Sheet).

PMS_TC.006 PORST not released during Cold Power-on Reset until VDDM is available

Upon a cold power-on reset, the PORST pin is kept asserted by the PMS until the ADC Analog Supply voltage (VDDM) is above 500 mV. This might lead to an additional start-up delay dependent on when VDDM is available from the external regulator relative to the VEXT, VDDP3 and VDD supplies.

During operation, if VDDM drops below the secondary monitor undervoltage threshold, an SMU alarm is generated. If VDDM further drops below 500 mV, the dedicated ADC of the secondary voltage monitor stops converting and the Secondary Monitor Activity Counter (EVRMONSTAT1.ACTVCNT) freezes at the last value.

Workaround

The ADC Analog Supply voltage (VDDM) has to be available and needs to be above 500 mV to ensure proper release of PORST during start-up and proper functioning of secondary monitors.

PMS_TC.007 VDDP3 or VDD Overvoltage during start-up may not be detected by PBIST

In AURIX™ TC3xx devices, Power Built in Self Test (PBIST) is introduced to ensure that the supply voltages do not exceed absolute maximum limits during the start-up phase.

However, for a VDDP3 or VDD overvoltage event during start-up beyond operational upper limits, the PBIST is not able to detect this overvoltage event.

Workaround

Check the VDDP3 overvoltage condition in registers EVRSTAT (flag OV33) and EVRMONSTAT1 (field ADC33V) in software additionally during the start-up phase before enabling the corresponding SMU alarm.

Check the VDD overvoltage condition in registers EVRSTAT (flag OVC) and EVRMONSTAT1 (field ADCCV) in software additionally during the start-up phase before enabling the corresponding SMU alarm.

PMS_TC.011 VEXT supplied PU2 and PD2 pads always in tristate after standby entry - Documentation correction

Tristate mode is enabled for VEXT supplied PU2 and PD2 pads (marked PU2 / VEXT and PD2 / VEXT in column “Buffer Type” in the Data Sheet) at the moment of and after entry to standby mode, regardless of the PMSWCR5.TRISTREQ bit setting and the HWCFCFG[6] pin setting (reflected in the PMSWSTAT register).

For a definition of the buffer types see also chapter “Legend” in the Data Sheet.

Recommendation

If the application requires the pull-up state of VEXT supplied PU2 pads (or pull-down state of PD2 pads), then it shall ensure it by means of external pull-up devices (or pull-down devices for PD2 pads) in the event of:

- Standby entry while the VEXT supply ramps down,
- Standby entry with the VEXT supply available.

Documentation correction for TC3xx User's Manual V1.5.0 and following

In TC3xx User's Manual V1.5.0 and following versions, the description of this behavior has been included in the PMS and PMSLE chapters. Erroneously, the term "PU1" was used instead of "PU2 and PD2".

In the following sections and sentences in chapter PMS (*=11) and PMSLE (*=12), the term "PU1" shall be replaced by "**PU2 and PD2**":

- Section *.2.1.1 Supply Mode Selection:
 - „Regardless of the HWCFG[6] setting, the VEXT-buffered PU1 pads (see the PU1 buffer type in the data sheet) are set into tristate ..“
shall be replaced by
 - “Regardless of the HWCFG[6] setting, the VEXT-buffered **PU2 and PD2** pads (see the **PU2 and PD2** buffer type in the data sheet) are set into tristate ..”.
- Section *.2.3.4.8 Entering Standby Mode (only VEVRSB domain supplied):
 - “Regardless of the PMSWCR5.TRISTREQ setting, the VEXT-buffered PU1 pads (see the PU1 buffer type in the data sheet) are set into tristate ..”
shall be replaced by
 - “Regardless of the PMSWCR5.TRISTREQ setting, the VEXT-buffered **PU2 and PD2** pads (see the **PU2 and PD2** buffer type in the data sheet) are set into tristate ..”.
- Section *.2.3.4.9 Entering Standby Mode (both VEVRSB and VEXT domain supplied):
 - “Regardless of the PMSWCR5.TRISTREQ setting, the VEXT-buffered PU1 pads (see the PU1 buffer type in the data sheet) are set into tristate ..”
shall be replaced by
 - “Regardless of the PMSWCR5.TRISTREQ setting, the VEXT-buffered **PU2 and PD2** pads (see the **PU2 and PD2** buffer type in the data sheet) are set into tristate ..”.
- Section *.2.3.4.10 State during Standby Mode:
 - “Regardless of the PMSWCR5.TRISTREQ setting, the VEXT-buffered PU1 pads (see the PU1 buffer type in the data sheet) are set into tristate ..”
shall be replaced by

- “Regardless of the PMSWCR5.TRISTREQ setting, the VEXT-buffered **PU2 and PD2** pads (see the **PU2 and PD2** buffer type in the data sheet) are set into tristate ..”.

See also the corresponding entries in the revision history for PMS chapter V2.2.31 and PMSLE chapter V1.0.4 at the end of each chapter.

PMS_TC.012 Short to Supply and Ground Detection – Documentation update

In the first sentence of the paragraph above Figure “Short to Supply and Ground Detection” in the PMSLE and PMS chapters of the TC3xx User’s Manual, starting with “A short detection scheme may be activated for EVR33..”, the reference to the register bits to control this detection is incorrect.

Correction

The correct sentence should read as follows:

- A short detection scheme may be activated for EVR33 via **EVR33CON**. SHLVEN / SHHVEN bits.

Note: For details on EVR33CON see the register description in the PMSLE chapter in TC3xx User’s Manual V1.3.0 and following.

Note: In V1.5.0 of the TC3xx User’s Manual, the PMSLE chapter contains the correct sentence. Update in the PMS chapter will follow in the next revision.

PMS_TC.014 Parasitic coupling on shared ADC pins depending on supply voltages

Bulk diodes exist from the V_{EXT} supply rail to the V_{DDM} supply rail through respective shared analog pins of EVADC Group 9 (P00.1 - P0.12).

If $V_{EXT} > V_{DDM}$ and any of the shared pin voltages (V_{INPIN}) is higher than V_{DDM} by a diode voltage ($V_{Diode} \sim 0.6V$), i.e.

- $V_{INPIN} > (V_{DDM} + V_{Diode})$ OR V_{INPIN} pulled up to V_{EXT} by internal/external pull-ups $> (V_{DDM} + V_{Diode})$

then during start-up and operation, sink currents will flow from the pin to the V_{DDM} supply. The currents shall be limited by an internal/external pull-up resistor in order to stay within the overload conditions.

Behavior during start-up:

Only during the start-up phase, when the V_{DDM} supply voltage is less than the V_{DDPPA} (~1.3V) subthreshold limit, then the shared analog pins within an ADC multiplexer group of EVADC group G9 are internally connected together. The internal connection is high ohmic in nature (current < 100 μ A). Consequently an external pull-up on one pin may be visible on the other pins in the same EVADC multiplexer group until the V_{DDM} supply is above the V_{DDPPA} limit and LVD reset limits on V_{EXT} and V_{EVRSB} have been reached.

Workaround

To avoid any current flow from V_{INPIN}/V_{EXT} to V_{DDM} and to prevent parasitic coupling on shared ADC pins:

- It needs to be ensured that the shared pin voltages (V_{INPIN}) are within the ($V_{DDM} + V_{Diode}$) supply range. Alternatively, V_{DDM} and V_{EXT} may be supplied together from the same supply source if the pull-ups on the pins are to the V_{EXT} rail.
- When both V_{EXT} and V_{EVRSB} are kept supplied during Standby mode, V_{DDM} should also be kept supplied if shared analog pins are pulled high.

Note: Related to this text module, in TC3xx User's Manual versions after V1.6, the row for V_{DDM} in table "5 V Nominal Supply: Voltage variations at independent supply rails during system modes" will be updated accordingly, and a diagram "Parasitic Diode Connectivity between supply rails" will be added.

PMS_TC.015 EVRC synchronization – Documentation update for register EVRSDCTRL11 (PMS) and EVRSDCTRL2 (PMSLE)

The formulas for $d f_{MAXDEV}$ (Maximum Deviation of the Synchronization Input Frequency) and SYNCHYST (Lock Unlock Hysteresis Window) that are documented in the description of fields SYNCMAXDEV and SYNCHYST in

register EVRSDCTRL11 (chapter PMS) and EVRSDCTRL2 (chapter PMSLE) of the TC3xx User's Manual shall be corrected/updated as listed below.

SYNCMAXDEV in TC3xx User's Manual V2.0 (and earlier versions):

- $d f_{MAXDEV} = 100 \text{ MHz} \cdot (2 \cdot SYNCMAXDEV) / (SDFREQ^2 + SYNCMAXDEV^2)$
- $SYNCMAXDEV = \text{round} [(100 \text{ MHz} / d f_{MAXDEV}) - \sqrt{(100 \text{ MHz} / d f_{MAXDEV})^2 - SDFREQ^2}]$

Correction to SYNCMAXDEV in register EVRSDCTRL11 (PMS) and EVRSDCTRL2 (PMSLE):

- $d f_{MAXDEV} = 100 \text{ MHz} \cdot (2 \cdot SYNCMAXDEV) / (SDFREQ^2 - SYNCMAXDEV^2)$
- $SYNCMAXDEV = \text{round} [\sqrt{(100 \text{ MHz} / d f_{MAXDEV})^2 + SDFREQ^2} - (100 \text{ MHz} / d f_{MAXDEV})]$

SYNCHYST in TC3xx User's Manual V2.0 (and earlier versions):

- $SYNCHYST = \text{round} [d f_{HYST} \cdot (SDFREQ \pm SYNCMAXDEV)^2] / [d f_{HYST} \cdot (SDFREQ \pm SYNCMAXDEV) + 100 \text{ MHz}]$

Correction/Update to SYNCHYST in register EVRSDCTRL11 (PMS) and EVRSDCTRL2 (PMSLE):

- $SYNCHYST = \text{round} [d f_{HYST} \cdot (SDFREQ \pm SYNCMAXDEV)^2 / (100 \text{ MHz} \pm d f_{HYST} \cdot (SDFREQ \pm SYNCMAXDEV))]$
- First hysteresis band:
 - $d f_{HYST} = 100 \text{ MHz} / (SDFREQ + SYNCMAXDEV - SYNCHYST) - 100 \text{ MHz} / (SDFREQ + SYNCMAXDEV)$
- Second hysteresis band:
 - $d f_{HYST} = 100 \text{ MHz} / (SDFREQ - SYNCMAXDEV) - 100 \text{ MHz} / (SDFREQ - SYNCMAXDEV + SYNCHYST)$

QSPI TC.006 Baud rate error detection in slave mode (error indication in current frame)

According to the specification, a baud rate error is detected if the incoming shift clock supplied by the master has less than half or more than double the expected baud rate (determined by bit field GLOBALCON.TQ).

However, in this design step, a baud rate error is detected not only if the incoming shift clock has less than half the expected baud rate (as specified), but also already when the incoming shift clock is somewhat (i.e. less than double) higher than the expected baud rate.

In this case, the baud rate error is indicated in the current frame.

Workaround

It is recommended not to rely on the baud rate error detection feature, and not to use the corresponding automatic reset enable feature (i.e. keep GLOBALCON.AREN=0_B).

The baud rate error detection feature in slave mode is of conceptually limited use and is not related to data integrity. Data integrity can be ensured e.g. by parity, CRC, etc., while clocking problems of an AURIX™ master are detected by mechanisms implemented in the master.

Protection against the effects of high frequency glitches is provided by the spike detection feature in slave mode.

QSPI TC.009 USB Events for PT1=2 (SOF: Start of Frame)

In master mode, when the interrupt on USB event is associated with Start of Frame (i.e. USREN=1_B, PT1=2 in register GLOBALCON1, BACON.UINT=1_B), then flag STATUS.USRF is not set and the interrupt is not triggered for the first frame.

Workaround

In the configuration where the interrupt on USB event is associated with Start of Frame (i.e. USREN=1_B, PT1=2 in GLOBALCON1, BACON.UINT=1_B), first transmit a “dummy” frame with this configuration. Then, for all subsequent

frames, flag USRF will be set and the interrupt on USR event will be generated as expected.

QSPI TC.010 Move Counter Mode - USR Events for PT1=4 (RBF: Receive Buffer Filled)

When a master operates in Move Counter Mode (MCCON.MCEN=1_B), and the interrupt on USR event is associated with Receive Buffer Filled (i.e. USREN=1_B, PT1=4 in register GLOBALCON1), the enable signal in BACON.UINT is only evaluated at the start of frame event.

This means in an ongoing frame the status of UINT in the first BACON control word involved determines whether flag STATUS.USRF is set and a user interrupt is generated or not. The status of UINT in following BACON control words in this frames' transmission is not considered.

Workaround

In case the Receive Buffer Filled event shall only be used as interrupt on USR event for parts of a frame, initialize e.g. BACON.UINT=1_B and GLOBALCON.PT1=4 before start of frame, and use GLOBALCON1.USREN to selectively disable/enable the user interrupt during frame transmission.

QSPI TC.013 Slave: No RxFIFO write after transmission upon change of BACON.MSB

While a slave transmission is in progress, and if the BACON.MSB configuration is changed for the subsequent frame, then the RxFIFO write of the currently received frame may not occur.

Also in case of a TxFIFO underflow, the RxFIFO write of the currently received frame may not occur.

Workaround

As a general recommendation, in slave mode the configuration should be done before any transmission starts.

Functional Deviations

In particular to avoid the problem described above, the re-configuration of the BACON has to be done after the RxFIFO write has occurred. This implies the need for a gap between frames if a BACON update occurs.

QSPI_TC.014 Slave: Incorrect parity bit upon TxFIFO underflow

When a slave TxFIFO underflow occurs, the slave transmits only “ones” in response to a request of the master.

If parity is enabled, also the parity bit transmitted by the slave is always set to “1”. This may be incorrect, depending on data length and parity type.

Workaround

If parity is enabled, select even parity if data length is odd, and select odd parity if data length is even.

QSPI_TC.016 Master: Move Counter Mode - Counter underflows when data is present in the TXFIFO while in the last TRAIL state of the previous transaction

When a master operates in move counter mode ($\text{MCCON.MCEN} = 1_{\text{B}}$) and is configured for adjacent move counter transactions, the MC.CURRENT counter value underflows when the move counter transaction is in the last TRAIL state of the previous transaction and the TXFIFO is already filled with data for the next move counter transaction. Due to this there is a possibility that the next move counter transaction enters an EXPECT state expecting more frames and stays there until intervened by the software.

Therefore, TXFIFO shall not be filled with the next move counter transaction data before the current transaction is over.

Workaround

The End of Frame (EOF) phase transition interrupt (i.e. $\text{GLOBALCON1.PT1} = 101_{\text{B}}$ or $\text{GLOBALCON1.PT2} = 101_{\text{B}}$) shall only be used to trigger the CPU/DMA to fill the TXFIFO with the next move counter transaction data.

QSPI TC.017 Slave: Reset when receiving an unexpected number of bits

A deactivation of the slave select input (SLSI) by a master is expected to automatically reset the bit counter of the QSPI module when configured as a slave.

This reset should help slaves to recover from messages where faults in the master or glitches on SCLK lead to an incorrect number of clocks on SCLK (= incorrect number of bits per SPI frame).

However, in this design step, the reset of the bit counter is unreliable.

Workaround

The slave should enable the Phase Transition interrupt ($PT2EN = 1_B$ in register GLOBALCON1) to be triggered after the PT2 event "SLSI deselection" ($PT2 = 101_B$).

In the interrupt service routine, after ensuring that the receive data has been copied, the software should issue a reset of the bit counter and the state machine via GLOBALCON.RESETS = 01_B .

SAFETY TC.002 SM[HW]:NVM.PFLASH:FLASHCON_MONITOR – Safe setting - Documentation update

Section 6.325 "SM[HW]:NVM.PFLASH:FLASHCON_MONITOR" of chapter "Safety Mechanisms" in the current version of the AURIX™ TC3xx Safety Manual contains the following paragraph:

- "The NVM configuration register CPUx_FLASHCON2 possess redundant configuration bits to be set by the application software to configure the PFlash NVM. The FLASHCON_MONITOR detects illegal values from incorrect software or random hardware faults from this register to the PFlash NVM and correct unwanted illegal values ($00_B, 11_B$ becomes 01_B , considered as "safe setting")."

The sentence related to "safe setting" is incorrect/misleading.

Note: The corresponding description of register FLASHCON2 in the TC3xx User's Manual is correct.

Documentation update:

The paragraph in “SM[HW]:NVM.PFLASH:FLASHCON_MONITOR” in the Safety Manual shall be corrected as follows:

- The NVM configuration register CPUx_FLASHCON2 possesses redundant configuration bits to be set by the application software to configure the PFlash NVM. The FLASHCON_MONITOR detects illegal values from incorrect software or random hardware faults from this register to the PFlash NVM. If an illegal value (00_B or 11_B) is detected an alarm will be generated and the system will behave as specified for the “safe setting” 10_B

Note: Absolute section numbers in the text above apply to V1.06 of the AURIX™ TC3xx Safety Manual.

SAFETY_TC.004 ESM[HW]:MCU:LBIST_MONITOR - Documentation update to Safety Manual

ESM[HW]:MCU:LBIST_MONITOR in the current version of the AURIX™ TC3xx Safety Manual (“Notes” section and corresponding figure) states that the behavior of both pins ESR0 and ESR1 is influenced by the STMEM0.ESR0CNT configuration during FW execution.

This statement shall be revised in the following aspects:

Documentation Update

- Only ESR0 pin will show a behavior depending on the ESR0CNT configuration, during FW execution.
- Furthermore, the STMEM0 register is not mentioned in the TC3xx User's Manual, and should not be accessed by users.
- Alternatively, HF_PROCONDF.ESR0CNT shall be used to monitor ESR0 during FW execution.

SAFETY_TC.006 SM[HW]:SMU:CCF_MONITOR - Documentation update to Safety Manual

Table “Fault identification interfaces” of SM[HW]:SMU:CCF_MONITOR in the AURIX™ TC3xx Safety Manual is wrongly mentioning alarms that are reserved in the AURIX™ TC3xx devices.

Documentation Update

The “Fault identification interfaces” for the SM[HW]:SMU:CCF_MONITOR have to be considered as shown in the following table:

Table 13 Fault identification interfaces of SM[HW]:SMU:CCF_MONITOR

Alarm Interface	SM Flag
SMU Alarm	ALM20[x] - SMU_Stdby Alarms (x=4..15)
SMU Alarm	ALM21[x] - SMU_Stdby Alarms (x=0..5, 7..16)

SAFETY_TC.007 SM[HW]:PMS:VDDM_MONITOR - Documentation correction

Section “Description” of SM[HW]:PMS:VDDM_MONITOR in the current version of the AURIX™ TC3xx Safety Manual recommends to perform cyclic software checks of EVRSTAT.UVC and EVRSTAT.OVC to monitor the VDDM supply.

This statement is wrong with respect to the mentioned EVRSTAT flags.

Documentation correction

Instead, the dedicated VDDM monitoring flags EVRSTAT.**UVDDM** and EVRSTAT.**OVDDM** must be used.

Note: For users of AURIX™ TC3xx Safety Manual v1.05 or previous versions, the same correction has to be considered for ESM[HW]:SYS:ES_ERROR_PIN_MONITOR and ESM[HW]:SYS:SW_ERROR_PIN_MONITOR.

Note: For users of AURIX™ TC3xx Safety Manual v1.03 or previous versions, the same correction has to be considered for ESM[HW]:SYS:FSP_ERROR_PIN_MONITOR.

SAFETY_TC.021 SM[HW]:LMU:CFG_AS_AP - Documentation correction

Note: This issue applies to AURIX™ TC3xx Safety Manual version v1.05 or previous versions. It is fixed in v1.06 and following.

The Safety Manual versions listed above state that ALM7[17] and ALM7[18] are the Fault identification interfaces of SM[HW]:LMU:CFG_AS_AP.

This is not correct.

Documentation correction

Only the ALM7[15]: “Bus-level MPU error” will be triggered when an error is detected by the SM[HW]:LMU:CFG_AS_AP safety mechanism.

ALM7[17] and ALM7[18] are not part of the “Fault identification interfaces” of SM[HW]:LMU:CFG_AS_AP.

SAFETY_TC.023 MCU infrastructure Safety Related Function - Documentation Update

Note: This issue applies to AURIX™ TC3xx Safety Manual version v2.0.

Section 4.3.1 (Introduction) of chapter “Safety Related Functions” in the AURIX™ TC3xx Safety Manual v2.0 mentions in the last bullet point below the table that Safety Related Functions 10, 11 and 12 shall always be correctly implemented in order to reach the ASIL level of the listed Safety Related Functions.

The listed absolute numbers 10, 11, 12 are not correct in this context.

Documentation Update

The MCU infrastructure Safety Related functions **12, 13 and 14** are assumed to be always correctly implemented.

SAFETY_TC.024 Clock alive monitor for f_{SPB} - Documentation update

The AURIX™ TC3xx Safety Manual states in section 6.37 SM[HW]:CLOCK:ALIVE_MONITOR that the clock alive monitor for f_{SPB} is only visible to HSM.

This statement is not correct.

Documentation update

The clock alive monitor for f_{SPB} is visible to all interfaces in the SMU.

SCR_TC.015 Bit SCU_PMCON1.WCAN_DIS does not disable WCAN PCLK input

Setting bit SCU_PMCON1.WCAN_DIS to 1_B has no effect – the WCAN clock input (PCLK) is not disabled. Power consumption of the WCAN module will not decrease as expected.

Workaround

In order to keep power consumption at a minimum, the WCAN module must not be enabled (WCAN_CFG.WCAN_EN = 0_B).

SCR_TC.016 DUT response to first telegram has incorrect C_START value

Note: This problem is only relevant for tool development, not for application development.

The C_START value returned by the SCR OCDS of the DUT (device under test) in response to a first telegram is wrong.

Each monitor processed command starts with sending a telegram containing the CMD (e.g. READ_BYTE). The response to this telegram should be a telegram containing the C_START value of 0x1.

Instead, the value sent by the DUT is a random value.

Workaround

Do not

poll for TRF==1 on the first telegram of the monitor processed commands, and do not

evaluate the return value of the first telegram from the DUT. Even though the returned C_START is wrong, the returned checksum is correct, and should be checked with the theoretical C_START value of 0x01.

SCR_TC.018 SSC Receive FIFO not working

The receive FIFO of the SSC module is not working properly. An unexpected receive FIFO full indication can be set.

Workaround

Do not use the receive FIFO.

Read the received data from the receive buffer register SSC_RBL each time a receive interrupt event is signaled (flag IRCON1.RIR).

The received data must be read before the next data is received.

SCR_TC.019 Accessing the XRAM while SCR is in reset state

When accessing the XRAM while the SCR is executing a reset, the following erroneous behavior will occur:

- A read access returns 0 instead of the actual XRAM contents.
- A write access has no effect, the data will not be written to the XRAM.

Workaround

One of the following methods will avoid this problem:

1. Check the SCR reset status bit PMSWSTAT.SCRST before and after any read/write transaction to the XRAM:
 - a) If the bit is set before the transaction, clear bit PMSWSTAT.SCRST and perform the desired XRAM access.

- b) If the bit is set after the transaction, clear bit PMSWSTAT.SCRST and repeat the XRAM read/write access. OR
- 2. Disable the SCR generated reset sources. OR
- 3. Disable the entire SCR (no SCR reset can occur): i.e. set
 - PMSWCR0.SCRWKEN = 0_B – wake-up via SCR disabled;
 - PMSWCR4.SCREN = 0_B – SCR disabled.

SCR_TC.020 Stored address in mon_RETH may be wrong after a break event

Note: This problem is only relevant for tool development, not for application development.

When setting a breakpoint via the SCR debugger connection on address $xxFE_H$ of an instruction, the stored address in mon_RETH is wrong if mon_RETL contains 00_H (see also section “Calculation of the return address upon a break event” in the SCR chapter). This effect will happen whenever a carry bit should be propagated from the lower 8 bits to the upper 8 bits of the address.

Workaround

If mon_RETL contains 00_H after a breakpoint was hit, the debugger tool must increment mon_RETH by 1 before performing the calculation of the return address as described in section “Calculation of the return address upon a break event” in the SCR chapter.

SCR_TC.021 RTC not counting after reset if P33.10 is high

The Real-Time Clock (RTC) in the SCR module may not reliably start counting if a high level was present on P33.10 (SCR_P01.2) during LVD reset. If enabled, the RTC will only start counting after the first high-to-low transition on P33.10 (SCR_P01.2).

Note: Applications using an external (32 / 32.768 kHz) oscillator on P33.10 as clock source for the RTC are not affected.

Workaround 1

Ensure a low level on P33.10 (SCR_P01.2) during LVD reset, for example via a pull-down.

Workaround 2

Generate a high-to-low transition on P33.10 (SCR_P01.2) after LVD reset (by software or external hardware).

SCR_TC.022 Effect of application or system reset and warm PORST on MC77_ECCD and MC78_ECCD for SCR RAMs

Unlike for ECCD registers of other modules, error flags in MC77_ECCD (for SCR_XRAM) and MC78_ECCD (for SCR_RAMINT) are not cleared upon application or system reset.

As consequence the corresponding alarms ALM6[19], ALM6[20] and ALM6[21] in AG6 are not cleared by an application and system reset (if ECCD is not cleared by SW before triggering the reset).

Furthermore, flags in MC77_ECCD are not cleared upon warm PORST.

Workaround

Clear flags in register MC77_ECCD and MC78_ECCD via software by writing '0' to the respective bits.

SCR_TC.023 External interrupts EXINT0, EXINT1 may get locked

As described in chapter "Interrupt System" of the SCR chapter in the TC3xx User's Manual, if the external interrupt is positive (negative) edge triggered, the external source must hold the request pin low (high) for at least one CCLK cycle, and then hold it high (low) for at least one CCLK cycle to ensure that the transition is recognized.

However, for external interrupts EXINT0 and EXINT1, respectively, if the time between two triggering edges is shorter than 2 CCLK cycles, no further interrupt

request is triggered after the first triggering edge. Further EXINT0 or EXINT1 interrupts are locked until the next application reset.

Note: This problem only occurs if interrupt generation on both rising and falling edge is selected, i.e. for EXINT0 if $EXICON0.EXINT0 = 10_B$, and for EXINT1 if $EXICON0.EXINT1 = 10_B$, respectively.

Workaround:

If using interrupt generation on both edges, ensure that the time between two triggering edges for EXINT0, EXINT1 is $> 2 \text{ CCLK cycles}$. To include some margin for clock jitter and external signal slope asymmetries etc., the external source should hold the request pin low (high) e.g. for $2.1/f_{\text{CCLK}}$ to ensure that the transitions are correctly recognized.

Otherwise, only use external interrupts EXINT2..15.

SCU_TC.031 Bits SCU_STSTAT.HWCFGx (x=1-5) could have an unexpected value in application if pins HWCFGx are left unconnected

An unexpected value for the HWCFGx pin state (x=1-5) may be latched in register field SCU_STSTAT.HWCFGx after application reset if the corresponding HWCFGx pin is not externally connected to a pull-up or a pull-down and the default reset state of port pins is set to tristate (pin P14.4/HWCFG[6] is pulled to GND).

EVR3 start-up function after cold reset is not affected (HWCFG2).

EVR33 start-up function after cold reset is not affected (HWCFG1).

Only the intended function of HWCFG[3-5] pin configuration options in the corresponding reset cases is affected when BMI.PINDIS=0_B and DMU_HF_PROCONT.P.BML=00_B (application boot defined by HWCFG[3-5] pins).

Workaround

Do not leave pins HWCFGx (x=1-5) unconnected if the default reset state of port pins is set to tristate (HWCFG[6] pulled to GND).

Note: This is not a general option for devices in QFP-80 and QFP-100 packages where P14.2/HWCFG2 is internally left unconnected.

If HWCFG2 is left unconnected, alternatively the application shall not rely on bit SCU_STSTAT.HWCFG[2] and may check for the correct state in the registers PMSWSTAT.HWCFGEVR or EVRSTAT.EVRC.

SDMMC_AI001 Timeout Error When BOOT ACK Driven on All Data Lines in SD/eMMC Mode

Defect Summary

In eMMC mode during Boot operation, when the device responds with BOOT ACK in all the data lines for 4/8 bit data widths, timeout/CRC error is reported by the controller because it erroneously detects the start bit of BOOT ACK as start bit of the BOOT Data.

Impacted Configurations

Configurations with the following register settings:

- BOOT_CTRL_R.BOOT_ACK_ENABLE=1;
- HOST_CTRL1_R.DAT_XFER_WIDTH=1 or
HOST_CTRL1_R.EXT_DAT_XFER=1

Consequence(s)

- Unexpected event requiring software interrupt
- System benignly self-recovers
- Persistent data corruption/loss

Method of Reproducing

Enabling BOOT ACK with 4/8 bit data widths, and driving BOOT ACK on all the data lines will reproduce this issue.

Workaround 1

Drive BOOT ACK on D0 only.

Workaround 2

Disable the BOOT ACK feature during BOOT.

SMU_TC.012 Unexpected alarms when registers FSP or RTC are written

Due to a synchronization issue, ALM6[7] and ALM10[21] are sporadically triggered if the PRE2 field of register FSP is written while the SMU is configured either

- in Time Switching protocol (FSP.MODE = 10_B) and FSP[0] is toggling with a defined T_{SMU_FFS} period,
- or in Dual Rail protocol (FSP.MODE = 01_B) and FSP[1:0] are toggling with a defined T_{SMU_FFS} period.

Also, ALM6[7] and ALM10[21] are sporadically triggered if the PRE1 or TFSP_HIGH fields of register FSP are written while the SMU is in the Fault State and T_{FSP_FS} has not yet been reached (STS.FSTS=0_B) (regardless of the FSP.MODE configuration).

In addition, an unexpected ALM10[16] or ALM10[17] is sporadically triggered if field FSP.PRE1 or RTC.RTD is written, and at least one recovery timer is running based on a defined T_{SMU_FS} period (regardless of the FSP.MODE configuration).

The alarms can only be cleared with cold or warm Power-On reset.

Workaround

To avoid unexpected alarms, perform the configuration of the PRE1, PRE2 or TFSP_HIGH fields only when the SMU is not in the Fault State and FSP is in Bi-stable protocol mode (FSP.MODE = 00_B). Mode switching and configuration shall not be done with the same write access to register FSP.

This means that in the Fault Free State:

- before writing to PRE1, PRE2 or TFSP_HIGH while Time Switching or Dual Rail protocol is enabled:
 - disable Time Switching or Dual Rail protocol by setting FSP in Bi-stable protocol mode (FSP.MODE = 00_B);
 - wait until Bi-stable protocol mode is active (read back register FSP twice);
 - write desired value to PRE1, PRE2 or TFSP_HIGH;
 - then switch FSP.MODE to the desired protocol (optional step).
- If the mode shall be changed after writing to PRE1, PRE2 or TFSP_HIGH while in Bi-Stable protocol mode (FSP.MODE = 00_B):
 - write desired value to PRE1, PRE2 or TFSP_HIGH;

- then switch FSP.MODE to Time Switching or Dual Rail protocol.

If field FSP.PRE1 or RTC.RTD shall be written, make sure no recovery timer is running. It is not allowed to write to the PRE1 or RTD field when at least one recovery timer is running (indicated by bits RTS0 and RTS1 in the STS register).

SMU_TC.013 Unexpected setting of Alarm Missed Event bit xAEM in Alarm Executed Status register SMU_AEX

Note: This problem only applies to alarms of Alarm Type: Level (see tables “Alarm Mapping related to ALM group” in the product specific Appendix to the TC3xx User’s Manual).*

While servicing an alarm with alarm type Level, request status bit xSTS in the SMU_AEX register is set. However, the corresponding alarm missed event bit xAEM is also set, 1 cycle after the xSTS bit is set for the same alarm event (x can be any of IRQ0..2, RST0..5, NMI, EMS).

Workaround

While clearing the xSTS bit the corresponding xAEM bit should also be cleared for the alarm event.

If the xAEM bit is not cleared while clearing xSTS, only the alarm missed event xAEM functionality will not be available for later alarm events, and it does not impact any alarm action generation and xSTS bit functionality.

3 Deviations from Electrical- and Timing Specification

ADC_TC.P009 Increased TUE for G10 when using Alternate Reference

When using the alternate reference (G10CH0) for conversions on channels of converter group G10, the Total Unadjusted Error (TUE) of the conversion results may increase with temperature

- up to $\pm 12 \text{ LSB}_{12}$ for operation with converter reference clock $f_{\text{ADCI}} = 32 \text{ MHz}$.
- up to $\pm 25 \text{ LSB}_{12}$ for operation with converter reference clock $f_{\text{ADCI}} = 40 \text{ MHz}$.
- up to $\pm 46 \text{ LSB}_{12}$ for operation with converter reference clock $f_{\text{ADCI}} = 53.33 \text{ MHz}$.

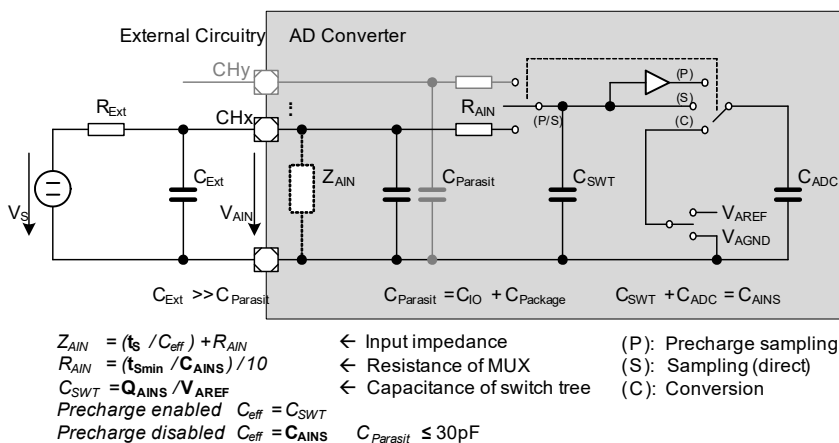
Note: This problem will not occur in the lower range of the ADC analog supply voltage ($V_{\text{DDM}} < 4.5 \text{ V}$), as f_{ADCI} is limited to 26.67 MHz in this case (see Data Sheet).

Recommendation

- Do not use the alternate reference of converter group G10 for $f_{\text{ADCI}} > 26.67 \text{ MHz}$.
- Use a different converter group Gx ($x \neq 10$) when an alternate reference voltage is required for conversions with $f_{\text{ADCI}} > 26.67 \text{ MHz}$.

ADC_TC.P014 Equivalent Circuitry for Analog Inputs - Additional information

Figure “Equivalent Circuitry for Analog Inputs” will be modified in future revisions of the Data Sheet, including the term $C_{\text{Parasit}} \leq 30 \text{ pF}$, as shown in the following figure:

Deviations from Electrical- and Timing Specification

Figure 9 Equivalent Circuitry for Analog Inputs
ADC TC.P015 Increased RMS Noise for TC374* and TC375* devices

Note: This problem only affects TC374 and TC375* devices (devices in PG-QFP-144 and -176 packages).*

On every analog channel ANx, the specified RMS noise (EN_{RMS}) increases, independent of the noise reduction mode.

- For analog channel AN0 and AN1:
 - $EN_{RMS} (Max.) \leq 2.7 \text{ LSB}_{12}$ in the temperature range $T_A > -40^\circ\text{C}$.
- For analog channels AN2 to AN8:
 - $EN_{RMS} (Max.) \leq 2 \text{ LSB}_{12}$ in the temperature range $-40^\circ\text{C} < T_A \leq 0^\circ\text{C}$.
 - $EN_{RMS} (Max.) \leq 1.7 \text{ LSB}_{12}$ for $T_A > 0^\circ\text{C}$
- For all other analog channels ANx (x>8):
 - $EN_{RMS} (Max.) \leq 1.2 \text{ LSB}_{12}$ in the temperature range $T_A > -40^\circ\text{C}$.

Deviations from Electrical- and Timing Specification**EDSADC_TC.P002 Parameters Input Current, Gain Error - Additional information**

In the latest revisions of the Data Sheet, the following information has been added to table “DSADC 5V”:

- Minimum limit for parameter Input Current (I_{RMS})
- Additional footnote on parameter “Gain Error” (ED_{GAIN}), describing the gain mismatch error between the different EDSADC channels

This footnote assumes that the considered EDSADC channels have the same calibration strategy. The footnote needs therefore to be extended with the condition “.. if they have the same calibration strategy” (see text in **bold** below).

Footnote on parameter “Gain Error” (ED_{GAIN}) - Extension

Gain mismatch error between the different EDSADC channels is within $\pm 0.5\%$ **if they have the same calibration strategy.**

FLASH_TC.P003 Program Flash Erase Time per Multi-Sector Command

The maximum value for parameter “Program Flash Erase Time per Multi-Sector Command” can be

- $t_{\text{MERP}} \leq 0.52 \text{ s}$ (instead of 0.5 s as specified in the Data Sheet).

Consequently, the maximum value for parameter “Complete Device Flash Erase Time PFlash and DFlash” can also increase by 0.04 s/Mbyte, resulting in

- $t_{\text{ER_Dev}} \leq 7.24 \text{ s}$ (instead of 7 s as specified in the Data Sheet).

The increased values should be considered e.g. when defining erase timeout limits.

GETH_TC.P001 Maximum and minimum GETH operating frequency - Documentation update

The maximum and minimum value for the GETH frequency (f_{GETH}) will be changed from 200/150 MHz to 150/100 MHz, respectively, in the next revision

Deviations from Electrical- and Timing Specification

of the Data Sheet (chapter “Operating Conditions”) as shown in **Table 14** below.

Table 14 Operating Conditions for f_{GETH} - Documentation update

Parameter	Symbol	Values			Unit
		Min.	Typ.	Max.	
GETH frequency	f_{GETH} CC	100	-	150	MHz

Impacted Use Cases:

There is no impact on ‘optimum performance’ use cases with a 2:1 ratio of $f_{\text{SRI}}:f_{\text{GETH}}$, for example $f_{\text{SRI}} = 300$ MHz, $f_{\text{GETH}} = 150$ MHz.

PADS_TC.P011 High Performance LVDS Pads - Documentation update to Data Sheet

In the current version of the Data Sheet, the note below table “LVDS - IEEE standard LVDS general purpose link (GPL)” referring to the termination resistor R_T shall be extended as follows:

Documentation Update

Note: R_T (or R_T) in table ‘LVDS - IEEE standard LVDS general purpose Link (GPL)’ is a termination resistor of the receiver according to figure 3-5 in IEEE Std 1596.3-1996 and is represented in Figure 3-1¹⁾ either by R_{in} or by $R_T=100$ Ohm but not both. If R_T (or R_T) is mentioned in column Note / Test Condition always the internal resistor R_{in} in Figure 3-1 is the selected one.

1) see corresponding TC3xx Data Sheet, figure “LVDS pad Input model”

Deviations from Electrical- and Timing Specification
PINS_TC.P001 Conditions for Overload Parameters – Data Sheet documentation update

In chapter “Pin Reliability in Overload” in the current version of the Data Sheet, the bullet point defining the condition for the parameters in table “Overload Parameters”

- full operation life-time is not exceeded

shall be replaced by the following expanded definition that includes both ‘Operation Lifetime hours’ and ‘Inactive Lifetime hours’:

- allowed time interval (defined in Note column) for overload condition is not exceeded. If no time limit is defined the allowed time includes both ‘Operation Lifetime hours’ and ‘Inactive Lifetime hours’. The number of hours in Table “Overload Parameters” (see Data Sheet) and Table “Example Inactive Lifetime Temperature Profile” (see **Table 15** below) are examples only and the applicable numbers are defined by the customer profiles accepted by Infineon.

Table 15 Example Inactive Lifetime Temperature Profile

T_J	Duration [h]	Comment
≤ 55°C	≤ 150700	

RESET_TC.P003 Parameter limits for t_{PI} (Ports inactive after ESR0 reset active) – Documentation update

In table “Reset Timing” of the current version of the Data Sheet, parameter “Ports inactive after ESR0 reset active” (symbol t_{PI}) specifies a maximum value of 8/f_{SPB} (or 8/f_{BACKT}, respectively) and/or unit (ns) which is incorrect.

The actual limits are as follows:

Table 16 Ports inactive after ESR0 reset active – Update

Parameter	Symbol	Values			Unit
		Min.	Typ.	Max.	
Ports inactive after ESR0 reset active	t_{PI} CC	$8000/f_{BACKT}$		$18000/f_{BACKT}$	s

Details

t_{PI} defines the pad reset delay on System Reset and Application Reset scenarios triggered by external ESR0 requests. These reset cases trigger execution of the shutdown sequence in the SCU within the t_{PI} time window followed by pad reset generation. The maximum time limit is defined by the timeout counter TOUTCNT which generates reset regardless of the execution state of the shutdown sequence.

4 Application Hints

ADC_TC.H026 Additional Waiting Phase in Slow Standby Mode

When a conversion is requested while slow standby mode is configured and the respective converter currently is in standby state, the extended wakeup time t_{WU} must be added to the intended sample time (see section “Analog Converter Control” in the Target Specification/User’s Manual).

While idle precharge is disabled ($GxANCFG.IPE = 0_B$), an additional waiting phase of $1.6 \mu s$ ($@f_{ADC} = 160 \text{ MHz}$) is inserted automatically. Operation starts after this phase.

However, if the slow standby state is left after just 1 clock cycle, this waiting phase is omitted.

Recommendation

It is, therefore, recommended to add the specified extended wakeup time (t_{WU}) when leaving the standby state in all cases, to ensure proper operation.

ADC_TC.H032 ADC accuracy parameters - Definition

Chapter “VADC Parameters” in the Data Sheet contains the following introduction section:

“The accuracy of the converter results depends on the reference voltage range. The parameters in the table below are valid for a reference voltage range of ($V_{AREF} - V_{AGND}$) $\geq 4.5 \text{ V}$. If the reference voltage range is below 4.5 V by a factor of k (e.g. 3.3 V), the accuracy parameters increase by a factor of $1.1/k$ (e.g. $1.1 \times 4.5 / 3.3 = 1.5$).”

Accuracy parameters in the context of the statement above are:

- Total Unadjusted Error (TUE),
- INL Error (EA_{INL}),
- DNL Error (EA_{DNL}),
- Gain Error (EA_{GAIN}),

- Offset Error (EA_{OFF}),
- RMS Noise (EN_{RMS}),
- Converter diagnostics voltage accuracy (dV_{CSD}),
- Deviation of IVR output voltage V_{DDK} (dV_{DDK}).

ADC_TC.H033 Basic Initialization Sequence for Primary and Secondary EVADC Groups

For consistency, to ensure that the maximum value for the settling time of the analog module is always considered in the basic initialization sequence, the start-up calibration should be started **after** a waiting time equal or higher than the extended wakeup time (t_{WU}). The related basic initialization sequence is described in the following execution scheme.

*Note: Compared to the sequence listed in chapter “Basic Initialization Sequence” in the present version of the EVADC chapter of the User’s Manual, step “WAIT” (third step below) has been shifted **before** the begin of the start-up calibration.*

```
EVADC_GxANCFG = 0x00300000
;Analog clock frequency is 160 MHz / 4 = 40 MHz (example)
;CALSTC = 00
EVADC_GxARBCFG = 0x00000003 ;Enable analog block
WAIT ;Pause for extended wakeup time ( $\geq 5 \mu s$ )
; (other operations can be executed in the meantime)
EVADC_GLOBCFG = 0x80000000 ;Begin start-up calibration
EVADC_GxARBPR = 0x01000000 ;Enable arbitration slot 0
EVADC_GxQMR0 = 0x00000001 ;Enable request source 0
EVADC_GxICLASS0 = 0x00000002
;Select 4 clocks for sampling time: 4 / 40 MHz = 100 ns
;The default setting stores results in GxRES0,
;service requests are issued on GxSR0
EVADC_GxRCR0 = 0x80000000
;Enable result service requests, if required
EVADC_GxQINR0 = 0x00000020
;Request channel 0 in auto-repeat mode
WAIT ;Wait for start-up calibration to complete *)
```

```

; (other operations can be executed in the meantime)
;=> This starts continuous conversion of the channel
*)time tSUCAL or flag GxARBCFG.CAL=0

```

ADC_TC.H034 Effect of reduced reference voltage on parameter QCONV - Data Sheet footnote update

The following footnote on parameter QCONV (Reference input charge consumption per conversion (from VAREF)) in table "VADC 5V" in the current version of the Data Sheet

- "For reduced reference voltages the consumed charge is reduced by factor k"

shall be changed to

- "For reduced reference voltages $VAREF < 3.375V$, the consumed charge QCONV is reduced by the factor of $k_2 = VAREF [V] / 3.375$. For reduced reference voltages $4.5V < VAREF \leq 3.375V$, QCONV is not reduced."

ADC_TC.H035 Effect of input leakage current on Broken Wire Detection

The Broken Wire Detection (BWD) feature uses the sample capacitor of the ADC input to discharge (BWG: Broken Wire Detection against V_{AGND}) or to charge (BWR: Broken Wire Detection against V_{AREF}) the input node of the ADC.

This mechanism can be seen as small current sink (BWG) or current source (BWR). When the BWD feature is enabled, in case the ADC input is not connected to an external voltage source (i.e. the wire is broken), the ADC input voltage is drifting down or up. When a defined voltage level (i.e. the detection threshold) is reached, "broken wire detected" is claimed.

Broken Wire Detection currents I_{BWG} , I_{BWR} are quite small and must overwhelm input leakage currents I_{OZ} on the same node. Input leakage currents depend exponentially on junction temperature.

It is therefore required to check whether an application using Broken Wire Detection can deal with leakage currents also under worst case conditions.

Application Considerations

1. Get the input leakage current (I_{OZ}) limits from the Data Sheet, depending on used ADC pins and maximum junction temperature T_J of your application.
2. Compare this limit against the Broken Wire Detection currents I_{BWG} , I_{BWR} , which can be calculated as follows:
 - Broken Wire Detection against V_{AGND} (BWG):
 - $I_{BWG} = V_{AIN} * C_{AINS} * CR$
 - Broken Wire Detection against V_{AREF} (BWR):
 - $I_{BWR} = (V_{AIN} - V_{AREF}) * C_{AINS} * CR$

where

- V_{AIN} : ADC input voltage at the detection threshold (typ. 10% of full scale for BWD, 80% of full scale for BWR)
- C_{AINS} : ADC input sampling capacitance, typ. 2.5 pF
- CR: Conversion Rate, i.e. number of conversions per second per input

Recommendation

The absolute value of the Broken Wire Detection current (I_{BWG} or I_{BWR}) at the BWD threshold shall be at least 2x the maximum input leakage current I_{OZ} (absolute value).

Examples

1. Typical Case Example

Assuming that $T_J \leq 150^\circ\text{C}$ (max) and ADC inputs are used in a configuration where $I_{OZ} \leq 150$ nA (see Data Sheet), I_{BWG} should be ≥ 300 nA according to the recommendation above.

With $C_{AINS} = 2.5$ pF and $V_{AIN} = 0.5\text{V}$ (10% of full scale) it can be calculated from the formula for I_{BWG} above that CR should be $\geq 240\,000$ samples per second and input.

2. Worst Case Example

Assuming that $T_J \leq 170^\circ\text{C}$ (max) and ADC inputs are used in a configuration where $I_{OZ} \leq 800$ nA (see Data Sheet), I_{BWG} should be ≥ 1600 nA according to the recommendation above.

With $C_{\text{AINS}} = 2.5 \text{ pF}$ and $V_{\text{AIN}} = 0.5\text{V}$ (10% of full scale) it can be calculated from the formula for I_{BWG} above that CR should be $\geq 1\,280\,000$ samples per second and input.

Recommendations for increasing the Broken Wire Detection current

In order to increase the Broken Wire Detection current,

1. Relax the detection threshold, e.g. for BWG from 10% to 20% of the full scale voltage.
2. Increase the conversion rate CR per input by introducing additional conversions.

ADC TC.H036 Minimum Input Buffering Time - Additional information

As described in section “Buffer for the Analog Input” in the EVADC chapter “Analog Signal Buffering”, the analog input buffer boosts the selected analog input signal for a certain time, when enabled. The time during which the input buffer is active can be adapted to the configured sample time by bitfields AIPS/AIPE in register GxICLASSi (i=0-1;x=0-11) / GLOBICLASSi (i=0-1), or by bitfield AIPF in register FCxFCCTRL (x=0-7)¹⁾, respectively. The input precharge time can be configured to 8, 16, or 32 clocks of f_{ADC} .

After the programmed buffer time the sampling is continued directly from the selected input. The effective overall sampling time must cover the specified minimum sampling time t_s (see Data Sheet), i.e. the programmed sample time (in bitfields STC*) must cover both phases, buffered sampling (configured in bitfields AIP*) and direct sampling.

Note: Sampling times with input buffer enabled specified in the Data Sheet consider a buffered sample time of 200 ns, that means for $f_{\text{ADC}} = 160 \text{ MHz}$ the input precharge time (in bitfields AIP) has to be configured to 32 clocks of f_{ADC} . For input precharge times lower than 200 ns, the charge consumption from the analog input is increased accordingly.*

1) in TC39x step AA: GxFCCTRL (x=12-19)

ADC_TC.H037 CPU read access latency to result FIFO buffer

Using the result FIFO buffer, data consistency for a sequence of conversion results can be guaranteed. This means, the results of the conversion sequence can be read by the CPU at a deterministic point in time. The data transfer from the result FIFO buffer to the CPU is usually done with a consecutive procedure of single read commands.

The read access latency between a CPU and the result FIFO buffer is defined by 6 system peripheral bus clock cycles (f_{SPB}) and 6 ADC clock cycles (f_{ADC}). The architecturally determined access time from a CPU via the system peripheral bus to the result FIFO is given by 5 system peripheral bus cycles (f_{SPB}).

Recommendation

Therefore, a waiting time between consecutive reads from the result FIFO buffer of 1 f_{SPB} cycle + 6 f_{ADC} cycles must be considered to ensure conversion results are correctly read from the FIFO. Otherwise, if this waiting time is not met for consecutive reads, the FIFO may get stuck.

The preferred way is to read the FIFO after the corresponding service request has been generated.

ADC_TC.H039 DMA read access latency to result FIFO buffer

Using the result FIFO buffer, data consistency for a sequence of conversion results can be guaranteed. Initiated by a service request, the results of the conversion sequence can be read by the DMA, as soon as the last conversion result is available in the result FIFO buffer. This approach enables data integrity for application cases where the EVADC trigger scheme is asynchronous to the related SW task. To update the output of the result FIFO buffer, the latency is defined by 6 system peripheral bus clock cycles (f_{SPB}) and 6 ADC clock cycles (f_{ADC}).

To ensure a deterministic and interrupt-free transfer of the complete content of the FIFO buffer, single DMA transfer with the related number of data moves is the most efficient approach. For this purpose, the DMA source address is assigned to the output stage of the FIFO buffer and the destination address in

the corresponding memory (DLMU, EMEM, ...) has to increment or decrement linearly. In this mode, the initial data move needs $6 f_{\text{SPB}}$ cycles and 13 system resource interface clock cycles (f_{SRI}), and every subsequent data move needs $3 f_{\text{SPB}}$ clock cycles and $11 f_{\text{SRI}}$ clock cycles.

That means, this DMA configuration cannot be used to read the content of the FIFO buffer. Starting from the second data move, the corresponding latency ($3 \times f_{\text{SPB}} + 11 \times f_{\text{SRI}}$) is shorter than the time ($6 \times f_{\text{SPB}} + 6 \times f_{\text{ADC}}$) required to update the output stage of the FIFO buffer. As this waiting time is not met for consecutive reads, this leads to an inconsistent representation in the corresponding memory region (DLMU, EMEM, ...) because the FIFO may get stuck.

Recommendation

To use the result FIFO buffer together with the DMA, a Linked List DMA configuration could be used. Using this kind of configuration, it is ensured that the DMA latency ($6 \times f_{\text{SPB}} + 13 \times f_{\text{SRI}}$) is longer than the time to update the result FIFO buffer ($6 \times f_{\text{SPB}} + 6 \times f_{\text{ADC}}$).

Note: See also ADC_TC.H037 for CPU read access.

AGBT_TC.H004 Configuration of registers PYCR2 and PACR2

Settings different to the reset configuration are required for the following fields of registers PYCR2 and PACR2:

- Register PYCR2.[26:24] = 100_{B} (CKRXTERM)
- Register PYCR2.[12:8] = 01101_{B} (TXOCDSLE)
- Register PACR2.[26:24] = 010_{B} (PICAPSEL)

AGBT_TC.H005 Availability of AGBT depending on feature package

The Data Sheets of TC39x, TC37xEXT, TC35x and TC33xEXT in general refer to all variants of the respective product family, including their specific emulation devices. Therefore, table "Platform Feature Overview" also includes the AGBT module.

Note: The Aurora Gigabit Trace Module (AGBT) is a trace interface intended for development use only (not to be used in series production).

It is only available on the specific emulation devices with feature package E, T, and on ADAS devices with feature package A, H of the TC39x, TC37xEXT, TC35x, TC33xEXT.

AGBT I/O functions are only available for packages with 292 or more pins.

For details on AGBT parameters see the “TC3xx Emulation Devices” Data Sheet.

ASCLIN TC.H001 Bit field FRAMECON.IDLE in LIN slave tasks

For LIN performing slave tasks, bit field FRAMECON.IDLE has to be set to 000_B (default after reset), i.e. no pause will be inserted between transmission of bytes.

If FRAMECON.IDLE > 000_B, the inter-byte spacing of the ASCLIN module is not working properly in all cases in LIN slave tasks (no bit errors are detected by the ASCLIN module within the inter-byte spacing).

BROM TC.H008 CAN BSL does not support DLC = 9 and DLC = 11

The CAN Bootstrap loader (BSL) only supports messages where the number of data bytes is a multiple of 8.

Therefore, Data Length Code settings DLC = 11 (number of data bytes = 20) and DLC = 9 (number of data bytes = 12) are not allowed (see also chapter “CAN BSL flow” of chapter “AURIX™ TC3xx Platform Firmware”).

Recommendation

When using the CAN Bootstrap loader, only use settings where DLC ≠ 9 or DLC ≠ 11.

BROM_TC.H009 Re-Enabling Lockstep via BMHD

For all CPUs with lockstep option, the lockstep functionality is controlled by Boot Mode Headers (BMHD) loaded during boot upon a reset trigger.

If lockstep is disabled for a CPUx with lockstep functionality, re-enabling (e.g. via a different BMHD) is not reliably possible if warm PORST, System or Application reset is executed.

Recommendation

Use cold PORST if lockstep is disabled and shall be re-enabled upon the reset trigger.

BROM_TC.H011 Assertion of ALM7[14] after Cold/Warm PORST

After a cold or warm PORST, if no global PFLASH or DFLASH read protection is set and no Halt After Reset has been requested, the startup software checks for a 64-bit signature at 3 predefined locations within EMEM as part of the prolog code handling (see chapter “Startup with Prolog Code in EMEM” in the TC3xxED documentation).

This may trigger ALM7[14] (EMEM ECC Error) if the EMEM is not ECC-clean initialized at that time.

Note: No entry into the ETRR registers is made due to this issue.

Recommendation

Ignore ALM7[14] after cold or warm PORST if the corresponding ETRR registers contain no entry.

BROM_TC.H012 Availability of V_{DDSB} during start-up

Devices with integrated EMEM have a separate EMEM SRAM Standby Power Supply (V_{DDSB}).

As documented e.g. in chapter “Power Supply Concept” in the TC3xxED documentation

- V_{DDSB} has to be supplied when V_{DD} is supplied and the EMEM is unlocked
- V_{DDSB} can be unsupplied when V_{DD} is supplied and PORST is active or the EMEM is locked
- V_{DDSB} can be supplied when V_{DD} is unsupplied and PORST is active (EMEM standby mode).

Note: If V_{DDSB} is not supplied at PORST release and the EMEM is unlocked, cross current from V_{DD} domain could lead to device damage.

Software may check availability of V_{DDSB} via bit SBRCTR.STBPON when EMEM is unlocked.

During start-up, however, there are situations where the EMEM is unlocked for a short time without checking SBRCTR.STBPON before.

Recommendation

The external system must ensure that V_{DDSB} is within the active operation range ($1.25\text{ V} \pm 10\%$, see Data Sheet) after PORST release during startup.

BROM TC.H014 SSW behavior in case of wrong state or uncorrectable error in UCBs - Documentation Update

The boot sequence terminates and the device is put into error state (endless loop) in the following cases:

- **Wrong state** - i.e. different from CONFIRMED or UNLOCKED (in case an UCB has ORIGINAL and COPY: wrong state of the both) – for the following UCBs:
 - UCB_BMHDx, UCB_SWAP, UCB_SSW, UCB_USER, UCB_PFLASH, UCB_DFLASH, UCB_DBG, UCB_HSM, UCB_HSMCOTP0...1, UCB_HSMCFG, UCB_ECPRIO, UCB_OTP0...7, UCB_REDSEC, UCB_TEST, UCB_RETEST.
- **Uncorrectable ECC error** within the used locations when state valid (CONFIRMED or UNLOCKED) – for the following UCBs:
 - UCB_SSW, UCB_PFLASH, UCB_DFLASH, UCB_DBG, UCB_HSM, UCB_HSMCOTP0...1, UCB_ECPRIO, UCB_OTP0...7, UCB_REDSEC, UCB_RETEST.

- For UCB_SWAP ORIGINAL/COPY – according to the descriptions in User's Manual.

Recommendation

Instructions to be followed for UCB-reprogramming (in order to avoid unexpected boot termination):

- always verify the changed contents before confirming the UCB state
- strictly follow the sequence in section “UCB Confirmation” in the “Non Volatile Memory (NVM)” chapter of the User's Manual¹⁾.

BROM TC.H015 Different initial values for CPU0_PMEM SSH registers in MTU after cold PORST if SOTA/SWAP is enabled

If SOTA/SWAP functionality is enabled via the SOTA Mode Enable (UCB_OTP.PROCONT.PSWAPEN), and a cold PORST is performed, registers ECCD, ETRRx and ERRINFOx in MC2 (associated with CPU0_PMEM) may contain “false-positive signatures”, indicating correctable or uncorrectable ECC errors. However, these are no real errors but result from firmware side effects (prefetches to - at that time - uninitialized memory).

Recommendation

Execute the following code sequence during startup (e.g. before MBIST or other safe application startup routines) in order to reverse this effect:

```
Ifx_MTU_MC *mc = &MODULE_MTU.MC[IfxMtu_MbistSel_cpu0Pspr];  
mc->ECCD.B.TRC = 1; // Clears EOv, VAL bits plus the ETRR  
and ERRINFO registers  
mc->ECCD.B.CERR = 0; // Clears CERR and enables further  
alarms to be forwarded to SMU  
---
```

Note: Resulting signatures are matching with AURIX™ TC3xx Safety Manual Appendix A.

1) For TC39x A-step: chapter “Program Memory Unit (PMU)” of the Target Specification.

BROM_TC.H017 CHSW results after LBIST execution

In AURIX™ TC3xx devices, LBIST execution terminates – independent whether successfully finished or interrupted by power-drop or external PORST - with a warm reset.

The Startup Software executed afterwards follows the flow as after cold power-on with the purpose to perform full device initialization.

If Checker Software (CHSW) is activated by the user configuration, the checks will be executed as required after cold power-on and the results are indicated in registers SCU_STMEM3...6 accordingly. Consequently, a successful device start-up will be indicated with the SCU_STMEM3...6 values shown in row “Cold power-on” of table “ALL CHECKS PASSED indication by CHSW for TC3xx” in the Firmware chapter of the TC3xx Appendix for the corresponding TC3xx device.

Recommendation

If using Checker Software, check bits SCU_STMEM3...6.[7:4] after start-up to determine which type of reset has been processed by device firmware. Then verify the SCU_STMEM3...6 contents against the values defined for the respective reset type in table “ALL CHECKS PASSED..” of the TC3xx Appendix for the corresponding TC3xx device.

CCU_TC.H012 Configuration of the Oscillator- Documentation Update

As described in chapter „Configuration of the Oscillator” in the CCU chapter of the User’s Manual, configuration of the oscillator is always required before an external crystal / ceramic resonator can be used as clock source.

Depending on the supply voltage ramp-up characteristics the behavior described in the following note may be observed:

Note: If VEXT is present then the oscillator could start oscillating (crystal/resonator connected). As soon as Cold PORST of AURIX™ is released, the oscillator is set to External Input Mode and the oscillation decays. This characteristic behavior has no impact on the oscillator start-up as initiated by software.

CLC_TC.H001 Description alignment for bits DISR, DISS, EDIS in register CLC - Documentation Update

For the description of bits DISR, DISS, and EDIS (if available) in register CLC (and CLC1 for I2C), different styles are used in the current version of the TC3xx User's Manual.

For the following modules, the function of these bits depending on their status (0_B or 1_B) is not explicitly described:

- ASCLIN, CIF, E-RAY, FCE, GETH, GTM, HSPDM, HSSL (incl. HSCT), I2C, MCMCAN, MSC, PSI5, PSI5-S, QSPI, SDMMC, SENT, STM,

For these modules, the missing parts of the bit description can be taken from the following general description:

Table 17 General description of bits DISR, DISS, EDIS in register CLC

Field	Bits	Type	Description
DISR	0	rw	Module Disable Request Bit Used for enable/disable control of the module 0_B No disable requested 1_B Disable requested
DISS	1	rh	Module Disable Status Bit Bit indicates the current status of the module 0_B Module is enabled 1_B Module is disabled
EDIS	3	rw	Sleep Mode Enable Control Used for module Sleep Mode control 0_B Sleep Mode request is regarded. Module is enabled to go into Sleep Mode on a request. 1_B Sleep Mode request is disregarded: Sleep Mode cannot be entered on a request.

Note:

1. Bit EDIS is not implemented for the following of the modules listed above:
CIF, GETH, I2C, SDMMC
2. In the FCE module, the bit at position of EDIS is of type 'rw', but without function and not shown in the User Manual
3. In the EDSADC, GTM, STM modules bit DISS is of type 'rh', but shown as 'r' in the User's Manual

CPU_TC.H019 Semaphore handling for shared memory resources

Overview

In a multiprocessor system, sharing state between different cores is generally guarded by semaphores or mutexes.

In AURIX™ TC3xx and TC2xx devices specific synchronization steps are needed to achieve specific results for programs running concurrently on multiple processors.

Special care needs to be taken in software when guarded state and semaphores are located in different memory modules.

When the paths from two CPUs to common memory resources are not the same for both CPUs, the effect of two generic stores from one CPU can appear in the opposite order to two generic loads from the other CPU if correct synchronization steps are not taken. This can happen when the master releasing the semaphore has a different access path to a shared resource than to its associated semaphore. In this case, it is possible for another master to observe the semaphore update prior to the final update of the guarded state.

In order to guarantee that the guarded state update is globally visible, both correct sequence and correct synchronization are required. A master must first acquire the semaphore to ensure correct synchronization. It is also required to include a DSYNC in the semaphore acquire and release methods. DSYNC waits until the store buffer is empty and then DSYNC completes ensuring correct sequence. In a multi-domain crossbar where one of the paths from the master to the shared resource involves an SRI extender, additional steps are required to ensure correct sequence. In such a case it is highly recommended to locate the semaphore and shared buffer in the same memory module.

Operational Details

From a CPU's point of view, resources can be accessed in different ways:

- Local resource to the CPU
 - Local DSPR
 - Local DLMU (AURIX™ TC3xx)
- SRI accessed resource
 - Any resource accessed via the SRI on the local crossbar.
- SRI accessed resource via SRI bridge (AURIX™ TC3xx)
 - Any resource located behind an SRI to SRI bridge in a multi-domain crossbar (relative to the accessing master).

In the case of multi-domain crossbars connected by SRI to SRI bridges there may be multiple paths of different latency from masters to shared resources potentially involving different bridges. When the guarded state is a shared memory location, the sequence observed by each master is guaranteed to be the same as long as the semaphore and guarded state are located in the same memory module. If semaphore and guarded state are not located in the same memory module then a load from the module is required prior to releasing the semaphore.

In order to achieve correct synchronization between the different masters, correct semaphore handling is required.

Acquiring and Releasing semaphores - Recommendations

In order to ensure correct sequence and synchronization a DSYNC instruction should be used as part of the semaphore acquire and release sequences. Additionally, a typical use case always requires the acquisition of the semaphore prior to accessing the guarded resource. The DSYNC waits until the store buffer is empty and then completes.

- Acquiring semaphores: A sequence of atomic compare and swap followed by a DSYNC.
- Releasing semaphores: A sequence of DSYNC followed by the clearing of the semaphore.

Examples

The following examples refer to memory accesses to non-peripheral regions (i.e. segments $0_H..D_H$). These examples are just describing the memory operations and not the complete sequence of operations

Example 1a: Out of order memory access due to different access paths to semaphore and shared resource

In this example, the semaphore is local to CPUx and the resource is local to CPUy. CPUx already owns the semaphore at the start of the described sequence. CPUy has not acquired the semaphore prior to accessing the resource.

Table 18 Example 1a: Out of order memory access due to different access paths to semaphore and shared resource

CPUx	CPUy	Memory Access Sequence
st-1 (resource-update)	ld-1 (semaphore-check)	
st-2 (semaphore-release)	ld-2 (resource-read)	
		st-2 (semaphore-release)
		ld-1 (semaphore-check)
		ld-2 (resource-read) "stale data"
		st-1 (resource-update)

Example 1b: Access order is enforced by correct semaphore handling

Table 19 Example 1b: Access order is enforced by correct semaphore handling

CPUx	CPUy	Memory Access Sequence
st-1 (resource-update)	CMPSWAP.W (semaphore-acquire)	
DSYNC	DSYNC	
st-2 (semaphore-release)	ld-1(resource-read)	
		st-1 (resource-update)
		st-2 (semaphore-release)
		CMPSWAP.W (semaphore-acquire)
		ld-1(resource-read)

A master may only access a resource if the associated semaphore is acquired successfully.

Note: CMPSWAP.W is only used here as an example. TriCore provides several other instructions supporting the implementation of semaphore operations

CPU_TC.H020 Inconsistent register description in CPU chapter - Documentation update

1. Overview

The current version of the CPU chapter in the TC3xx family User's Manual uses incorrect names for some of the Bus MPU registers. In multiple places the register names are combined with an incorrect index variable 'x'. Variable 'x' normally refers to the CPU instance. For these registers the intention was to refer to a particular range number.

The following description provides a summary of all the incorrect references as well as their actual intended values.

Note: Absolute chapter numbers refer to CPU chapter version V1.1.19 included in the TC3xx User's Manual V1.4.0. They may change if used in other versions of this document.

2. Chapter “Summary of SFR Reset Values and Access modes”(5.3.4.22.2)

Both of the tables named

- **Register Overview – SPR** (ascending Offset Address)
- **Register Overview – DLMU** (ascending Offset Address)

incorrectly use the letter ‘x’ as an index variable where ‘i’ was intended in the Short Name, Long Name and Offset Address columns.

Corrected description of Register Overview tables

Corrected parts of these tables (‘i’ intended in 3 places per row) see below:

Table 20 Corrections to table “Register Overview – SPR”

Short Name	Long Name	Offset Address
SPR_SPROT_ RGNACCENAi_R	CPUx Safety Protection Region SPR Read Access Enable Register Ai	0E088 _H +i*10 _H
SPR_SPROT_ RGNACCENBi_R	CPUx Safety Protection Region SPR Read Access Enable Register Bi	0E08C _H +i*10 _H

Table 21 Corrections to table “Register Overview – DLMU”

Short Name	Long Name	Offset Address
DLMU_SPROT_ RGNLAI	CPUx Safety Protection DLMU Region Lower Address Register i	0E200 _H +i*10 _H
DLMU_SPROT_ RGNUAI	CPUx Safety Protection DLMU Region Upper Address Register i	0E204 _H +i*10 _H
DLMU_SPROT_ RGNACCENAi_W	CPUx Safety Protection Region DLMU Write Access Enable Register Ai	0E208 _H +i*10 _H
DLMU_SPROT_ RGNACCENBi_W	CPUx Safety Protection Region DLMU Write Access Enable Register Bi	0E20C _H +i*10 _H

Table 21 Corrections to table “Register Overview – DLMU” (cont’d)

Short Name	Long Name	Offset Address
DLMU_SPROT_RGNACCENAI_R	CPUx Safety Protection Region DLMU Read Access Enable Register Ai	0E288 _H +i*10 _H
DLMU_SPROT_RGNACCENBI_R	CPUx Safety Protection Region DLMU Read Access Enable Register Bi	0E28C _H +i*10 _H

3. Section “Scratch Pad SRAMs” in chapter “Bus MPU” (5.4.6.1)

This section uses incorrect index variable ‘x’ or no index variable in references to the SPR_SPROT_* registers.

Corrected description of section “Scratch Pad SRAMs”

Each scratchpad region is defined using the registers, SPR_SPROT_RGNLAI (i=0-7) to define the lower address of the region, SPR_SPROT_RGNUAI (i=0-7) to define the upper address of the region.

Each region may be enabled for writes on a per bus master basis using the register SPR_SPROT_RGNACCENAI_W (Masters 31-0) and SPR_SPROT_RGNACCENBI_W (Masters 63-32).

Each region may be enabled for reads on a per bus master basis using the register SPR_SPROT_RGNACCENAI_R (Masters 31-0) and SPR_SPROT_RGNACCENBI_R (Masters 63-32).

A write access to the PSPR/DSPR memory is seen as valid if the master tag of the access is enabled in the SPR_SPROT_RGNACCENi_W register and the address of the access satisfies the following relationship:-

$$\text{SPR_SPROT_RGNLAI} \leq \text{address} < \text{SPR_SPROT_RGNUAI}$$

A read access to the PSPR/DSPR is seen as valid if the master tag of the access is enabled in the SPR_SPROT_RGNACCENi_R register and the address of the access satisfies the following relationship:-

$$\text{SPR_SPROT_RGNLAI} \leq \text{address} < \text{SPR_SPROT_RGNUAI}$$

If any of these conditions are not satisfied, the access is seen as invalid.

Accesses from all masters to the local DSPR (excluding data access from the local CPU) are checked by the SPR safety mechanism.

Accesses from all masters to the local PSPR (excluding fetch access from the local CPU) are checked by the SPR safety mechanism

4. Section “DLMU SRAMs” in chapter “Bus MPU” (5.4.6.1)

This section uses incorrect index variable ‘x’ or no index variable in references to the DLMU_SPROT_* and SPR_SPROT_RGNACCEN* registers.

Corrected description of section “DLMU SRAMs”

Each DLMU region is defined using the registers, DLMU_SPROT_RGNLAI (i=0-7) to define the lower address of the region, DLMU_SPROT_RGNUAi (i=0-7) to define the upper address of the region.

Each region may be enabled for writes on a per bus master basis using the register DLMU_SPROT_RGNACCENAi_W (Masters 31-0) and DLMU_SPROT_RGNACCENBi_W (Masters 63-32).

Each region may be enabled for reads on a per bus master basis using the register DLMU_SPROT_RGNACCENAi_R (Masters 31-0) and DLMU_SPROT_RGNACCENBi_R (Masters 63-32).

A write access to the local DLMU memory is seen as valid if the master tag of the access is enabled in the DLMU_SPROT_RGNACCENi_W register and the address of the access satisfies the following relationship:-

$$\text{DLMU_SPROT_RGNLAI} \leq \text{address} < \text{DLMU_SPROT_RGNUAi}$$

A read access to the local DLMU memory is seen as valid if the master tag of the access is enabled in the DLMU_SPROT_RGNACCENi_R register and the address of the access satisfies the following relationship:-

$\text{DLMU_SPROT_RGNLAI} \leq \text{address} < \text{DLMU_SPROT_RGNUAi}$ if any of these conditions are not satisfied, the access is seen as invalid.

Accesses from all masters to the local DLMU (including those from the local CPU) are checked by the DLMU safety protection mechanism.

5. Chapter “Register access enable Protection” (5.4.6.2)

This chapter uses incorrect index variable ‘x’ in reference to the SFR_SPROT_ACCEN*_W registers.

Corrected paragraphs of chapter “Register access enable Protection”

The CPUs implement the standard memory protection scheme for peripheral registers using the SFR_SPROT_ACCENA_W (Masters 31-0) and SFR_SPROT_ACCENB_W (Masters 63-32) register. This allows all CPU CSFR and SFR registers to be protected from write access by untrusted masters.

The SFR_SPROT_ACCENA_W and SFR_SPROT_ACCENB_W registers define which masters may write the SFR and CSFR registers via bus access through the SRI slave interface.

The SFR_SPROT_ACCENA_W and SFR_SPROT_ACCENB_W registers are protected by the safety_endinit signal.

6. Chapter “Safety Protection registers” (5.4.7.2)

This chapter describes all the registers in detail. The register names and descriptions of the registers listed in [Table 20](#) and [Table 21](#) all use incorrect index ‘x’ when ‘i’ was intended

- in the register name,
- in the offset calculation,
- in the register description.

DAM_TC.H002 Triggering DAM MEMCON.RMWERR and INTERR flags

The MEMCON.INTERR error flag is linked to the MEMCON.RMWERR error flag and both flags are set for the same error condition.

This error condition can be triggered by inserting an uncorrectable ECC error into a RAM location and then making a write of 32 bits or less to the same RAM location.

Note: For devices with EMEM see also Application Hint EMEM_TC.H006

DSADC_TC.H010 Support for synchronous use of two or more DSADC channels

Note: This Application Hint refers to the DSADC module in AURIX™ TC2xx devices and to the EDSADC module in AURIX™ TC3xx devices.

The Global Run Control register GLOBRC controls the general operation of the available channels of the EDSADC module. For every EDSADC channel, register GLOBRC supports an individual bit for the related modulator (GLOBRC.MxRUN) and the related digital filter chain (GLOBRC.CHxRUN), where x depends on the number of implemented channels in the respective AURIX™ microcontroller device.

For applications where two or more EDSADC channels have to provide synchronous results, all related channels shall be enabled synchronously using a single write access to register GLOBRC. This approach guarantees synchronization between EDSADC channels under all loading conditions of the system peripheral bus (SPB).

Recommendation

To handle the EDSADC channel specific modulator settling time, the following sequence is proposed:

- Enable all modulators of the application specific synchronization group by a single write access to the corresponding MxRUN bits in the upper half-word of the Global Run Control Register:
 - $\text{GLOBRC} = \text{XXXX } 0000_{\text{H}}$, where XXXX_{H} depends on the number of implemented modulators;
- Wait for modulator settling time t_{MSET} (see Data Sheet);
- Enable all modulators and corresponding digital filter chains of the application specific synchronization group by a single write access to the corresponding MxRUN and CHxRUN bits in the Global Run Control Register:
 - $\text{GLOBRC} = \text{XXXX XXXX}_{\text{H}}$, where XXXX_{H} depends on the number of implemented modulators/demodulator channels.

DTS_TC.H002 Unexpected alarms after start-up/wake-up when temperature is close to lower/upper limit

The result of the first temperature measurement received from the Die Temperature Sensor (DTS) after start-up from cold PORST or wake-up from standby mode is inaccurate due to parallel processing of sensor trimming.

Effect

If temperature is close (< 10 K) to the thresholds defined in register DTSLIM, alarms ALM9[0] or ALM9[1] in SMU_core and ALM21[9] or ALM21[8] in SMU_stdby can be triggered falsely indicating lower temperature limit underflow or upper limit overflow, respectively. Also, the corresponding flag DTSLIM.LLU or DTSLIM.UOF is set.

Recommendation

The application software shall clear the respective flag in DTSLIM and **afterwards** clear related SMU alarms. In case alarms are retriggered, application SW shall consider these as real alarms, and trigger a reaction within the FTTI (Fault Tolerant Time Interval) of the respective application.

EDSADC_TC.H001 Auxiliary filter cleared with start of integration window - Additional information

Note: The following information is an extension to the description included in section “Starting the Integration Window” in the EDSADC chapter of the TC3xx User’s Manual.

To support deterministic integration results in the case where the integration window is controlled by a hardware signal ($\text{DICFGx.ITRMODE} = 01_{\text{B}}$ or 10_{B}), the filter chain can be cleared with the start of the integration window if bit $\text{IWCTRx.FRC} = 0_{\text{B}}$. This means, every non-recursive filter element of the filter chain (CIC3, FIR0, FIR1, integrator stage) is cleared to zero and the related decimation counters are loaded with their start values.

In this TC3xx design implementation, simultaneously also the CIC filter of the Auxiliary Filter is cleared to zero and the related decimation counter is set to its initial value.

Clearing of the described filter elements can be avoided if bit FRC is set to 1_B , which means no filter element inside the filter chain nor the Auxiliary Filter is cleared.

Note: There is no EDSADC configuration supported where the filter elements of the filter chain are cleared and the Auxiliary Filter keeps its value. For this particular configuration, the characteristic of the TC3xx EDSADC is not compatible with the TC2xx DSADC module of the AURIX™ product family.

EDSADC TC.H003 Behavior of EDSADC result register in case of hardware controlled integration

The hardware triggered integration ($DICFGx.ITRMODE = 01_B$, $DICFGx.ITRMODE = 10_B$) can be used to define a timeframe where a specific number of samples coming from the time equidistant data stream of the upstreamed filter chain is accumulated. The values which are accumulated within this timeframe will be stored in the EDSADC result register and can be read by DMA or CPU. As soon the integration procedure is finished ($ISTATx.INTEN = 0_B$), the source for the result register changes from the integrator output to the upstreamed filter chain. When no result FIFO is used, results in the results register will be continuously overwritten by the subsequent incoming results. This means, the last result of the hardware signal controlled integration is available in the EDSADC result register only for the timeframe which is defined by the data rate period of the upstreamed filter chain.

Recommendation

To avoid the described overwriting procedure, the EDSADC result FIFO can be used. Using the result FIFO, the accumulation result is accessible by CPU or DMA up to the time where another hardware signal controlled integration is initiated. For this purpose, the result FIFO has to use one of the following configurations:

- $DICFGx.ITRMODE = 01_B$, $FCFGMx.SRGM = 10_B$, $RFCx.SRLVL = 00_B$

- $DICFGx.ITRMODE = 10_B$, $FCFGMx.SRGM = 01_B$, $RFCx.SRLVL = 00_B$

These configurations have the effect that service requests are only generated during the integration window. In case of disabled integrator stage ($ISTATx.INTEN = 0_B$), results generated by the upstreamed filter chain will not trigger service requests. However, results from the upstreamed filter chain will be stored in higher stages of the result FIFO. When the FIFO stages are fully loaded, all other results from the upstreamed filter chain are discarded and FIFO write error is indicated ($RFCx.WREC=1B$).

EMEM_TC.H006 Triggering EMEM MEMCON.RMWERR and INTERR flags

The following methods can be used to set the relevant bits in the MEMCON register of the EMEM module:

Method 1

The MEMCON.**RMWERR** bit is set when an EMEM memory address is written using a non-BTR4 access after the ECC of that word has been written via the MTU interface so that an uncorrectable ECC will occur.

Method 2

The MEMCON.**INTERR** bit is set when the SCTRL.GED bit in an EMEM module is written with a 1 and then an EMEM memory address in the same module is written using a non-BTR4 access.

Note: For devices with DAM see also Application Hint DAM_TC.H002

EMEM_TC.H007 Access restrictions to EMEM for tools

Overview

Access to any EMEM tile configured in common-tool mode from the BBB can be blocked by continuous write accesses to the same tile from the SRI. The blocked BBB access results in an FPI Timeout condition that is logged as an error at the EBCU and/or IOClient.

Details

In common-tool mode, an EMEM tile may be accessed from both SRI and BBB interfaces, with arbitration logic always giving the SRI access higher priority.

Writes to EMEM must be carried out as an internal read-modify-write sequence because of the 32-byte word width of the SRAM tiles used (unless the write is a 32-byte item such as BTR4 on SRI). During this internal read-modify-write sequence, the tile arbitration logic of EMEM does not allow a BBB access to the same tile.

Therefore, a sequence of pipelined writes from SRI can keep the tile interface permanently busy, completely blocking access from BBB.

Note: Accesses to any two different tiles from the BBB and SRI can operate in parallel with complete independence, not causing the problem described above. Also, the problem does not occur for EMEM tiles used in common-application mode (ADAS application) and EMEM tiles used in trace mode (MCDS trace).

Recommendation

The problem can be avoided by modifying the SRI master behavior, to perform writes to EMEM using only BTR4 transactions. The 32-byte BTR4 write is carried out as a single write at the EMEM tile and no internal read-modify-write sequence is necessary. This allows sufficient idle cycles for any BBB access to take place.

The problem can also be avoided by modifying the SRI master behavior, to perform some alternative tile access along with the original writes to the affected tile. For example, a dummy read to any other tile in the same megabyte module of EMEM will allow cycles for a blocked BBB access to take place.

FLASH_TC.H019 Write Burst Once command – Documentation update

For the Write Burst Once command, the current version of the TC3xx User's Manual states in section "Command Sequence Definitions":

"This function starts the programming process for an aligned group of pages as the normal "Write Burst" does. But before programming it checks if the pages

are erased. If the page is not erased (allowing correctable errors) the command fails with PVER and EVER.”

*Note: The actual implementation of the Write Burst Once command is similar to the Write Page Once command, therefore it will be updated in the next version of the TC3xx User's Manual as follows (changes marked in **bold** below:*

Documentation Update - Write Burst Once

“This function starts the programming process for an aligned group of pages as the normal “Write Burst” does. But before programming it checks if the pages are erased. If the **pages are** not erased (allowing correctable errors) the command fails with **EVER**.”

FlexRay AI.H004 Only the first message can be received in External Loop Back mode

If the loop back (TXD to RXD) will be performed via external physical transceiver, there will be a large delay between TXD and RXD.

A delay of two sample clock periods can be tolerated from TXD to RXD due to a majority voting filter operation on the sampled RXD.

Only the first message can be received, due to this delay.

To avoid that only the first message can be received, a start condition of another message (idle and sampling '0' -> low pulse) must be performed.

The following procedure can be applied at one or both channels:

- wait for no activity (TEST1 . AOx=0 -> bus idle)
- set Test Multiplexer Control to I/O Test Mode (TEST1 . TMC=2), simultaneously TXDx=TXENx=0
- wait for activity (TEST1 . AOx=1 -> bus not idle)
- set Test Multiplexer Control back to Normal signal path (TEST1 . TMC=0)
- wait for no activity (TEST1 . AOx=0 -> bus idle)

Now the next transmission can be requested.

FlexRay_AI.H005 Initialization of internal RAMs requires one eray_bclk cycle more

The initialization of the E-Ray internal RAMs as started after hardware reset or by CHI command CLEAR_RAMs (SUCC1.CMD[3:0] = 1100_B) takes 2049 eray_bclk cycles instead of 2048 eray_bclk cycles as described in the E-Ray Specification.

Signalling of the end of the RAM initialization sequence by transition of MHDS.CRAM from 1_B to 0_B is correct.

FlexRay_AI.H006 Transmission in ATM/Loopback mode

When operating the E-Ray in ATM/Loopback mode there should be only one transmission active at the same time. Requesting two or more transmissions in parallel is not allowed.

To avoid problems, a new transmission request should only be issued when the previously requested transmission has finished. This can be done by checking registers TXRQ1/2/3/4 for pending transmission requests.

FlexRay_AI.H007 Reporting of coding errors via TEST1.CERA/B

When the protocol engine receives a frame that contains a frame CRC error as well as an FES decoding error, it will report the FES decoding error instead of the CRC error, which should have precedence according to the non-clocked SDL description.

This behaviour does not violate the FlexRay protocol conformance. It has to be considered only when TEST1.CERA/B is evaluated by a bus analysis tool.

FlexRay_AI.H009 Return from test mode operation

The E-Ray FlexRay IP-module offers several test mode options

- Asynchronous Transmit Mode
- Loop Back Mode

- RAM Test Mode
- I/O Test Mode

To return from test mode operation to regular FlexRay operation we strongly recommend to apply a hardware reset via input `eray_reset` to reset all E-Ray internal state machines to their initial state.

Note: The E-Ray test modes are mainly intended to support device testing or FlexRay bus analyzing. Switching between test modes and regular operation is not recommended.

FlexRay AI.H011 Behavior of interrupt flags in FlexRay™ Protocol Controller (E-Ray)

In the corner case described below, the actual behavior of the interrupt flags of the FlexRay™ Protocol Controller (E-RAY) differs from the expected behavior.

Note: This behaviour only applies to E-RAY interrupts INT0 and INT1. All other E-RAY interrupts are not affected.

Expected Behavior

When clearing an interrupt flag by software, the resulting value of the flag is expected to be zero.

A hardware event that occurs afterwards then leads to a zero to one transition of the flag, which in turn leads to an interrupt service request.

Actual Behavior in Corner Case

When the interrupt flag is being cleared by software in the same clock cycle as a new hardware event sets the flag again, then the hardware event wins and the flag remains set without being cleared.

As interrupt requests are generated only upon zero to one transitions of the flag, no interrupt request will be generated for this flag until the flag is successfully cleared by software later on.

Workaround

After clearing the flag, the software shall read the flag and repeat clearing until the flag reads zero.

FlexRay_TC.H003 Initialization of E-Ray RAMs - Documentation Update

After Power-On reset, the E-Ray RAMs hold arbitrary values which causes ECC errors (MHDS) when a read operation is performed on an E-Ray RAM location. Hence the E-Ray RAMs should be initialized always after a Power-On reset.

Recommendation

The E-Ray RAMs initialization can be performed using the CLEAR_RAMs command of the E-Ray module. A safe initialization sequence of the E-Ray RAM blocks using the CLEAR_RAMs command is described in section “CLEAR_RAMs Command” of chapter “FlexRay™ Protocol Controller (E-Ray)” in the AURIX™ TC3xx Target Specification/User’s Manual.

Documentation Update

Note: In order to ensure proper FlexRay communication, RAM test mode must be explicitly disabled via TEST1.TMC = 00b at the end of the initialization sequence.

Therefore, Step16 in section “CLEAR_RAMs Command” of the TC3xx User’s Manual must be updated from

- 16. Switch off Test Mode: TEST1.WRTEN = 0b
- to
- 16. Switch off Test Mode: **TEST1.TMC = 00b and** TEST1.WRTEN = 0b

FlexRay_TC.H004 Bit WRECC in register TEST2 has no function

In the AURIX™ implementation of the E-Ray module, bit WRECC in register TEST2 has no function.

Recommendation

The value read from WRECC should not be evaluated by software, the value written (0_B or 1_B) to it is irrelevant.

For new software projects, keep bit WRECC at its reset value (0_B) for easier migration to future AURIX™ generations.

FPI_TC.H003 Burst write access may lead to data corruption

For the FPI slave modules listed below, if a write burst access is aborted on the last beat, this may lead to data corruption of all future accesses. No error is generated when the burst access is aborted.

This problem only affects the following modules:

- CONVCTRL, EVADC, PMS, SCR XRAM

Recommendation

Do not perform burst accesses to registers in CONVCTRL, EVADC, PMS, and to SCR XRAM.

GETH_AI.H001 Preparation for Software Reset

Note: This application hint applies to MII and RMII. For RGMII see GETH_TC.002.

When a kernel reset or software reset (via bit DMA_MODE.SWR) shall be performed, the GETH module must be clocked (MII: RXCLK and TXCLK; RMII: REFCLK) and be in a defined state to avoid unpredictable behavior.

Therefore, it is recommended to use the defined sequence listed below if frame transactions took place before setting bit SWR:

1. Finish running transfers and make sure that transmitters and receivers are set to stopped state:
 - a) Check the RPSx and TPSx status bit fields in register DMA_DEBUG_STATUS0/1.
 - b) Check that MTL_RXQ0_DEBUG, MTL_RXQi_DEBUG, MTL_TXQ0_DEBUG and MTL_TXQi_DEBUG register content is equal

to zero.

Note: it may be required to wait $70 f_{SPB}$ cycles after the last reset before checking if RXQSTS in MTL_RXQ0_DEBUG and MTL_RXQi_DEBUG are zero.

2. Wait until a currently running interrupt is finished and globally disable interrupts.
3. Apply kernel reset to GETH module:
 - a) Deactivate Endinit protection, as registers KRST0/1 and KRSTCLR can only be written in Supervisor Mode and when Endinit protection is not active.
Write to corresponding RST bits of KRST0/1 registers to request a kernel reset. The reset status flag KRST0.RSTSTAT may be cleared afterwards by writing to bit CLR in the KRSTCLR register.
Re-activate Endinit protection.
 - b) Wait $70 f_{SPB}$ cycles, then check if RXQSTS in MTL_RXQ0_DEBUG and MTL_RXQi_DEBUG are zero.
4. Configure the same mode as before (MII, RMII) in bit field GPCTL.EPR.
5. Apply software reset by writing to the DMA_MODE.SWR bit.
Wait $4 f_{SPB}$ cycles, then check if DMA_MODE.SWR = 0_B.

If coming directly from Power-on Reset (i.e. no frame transaction took place yet), it is sufficient to follow the simplified sequence:

1. Configure the desired mode (MII, RMII) in bit field GPCTL.EPR
2. Apply software reset by writing to the DMA_MODE.SWR bit.
Wait $4 f_{SPB}$ cycles, then check if DMA_MODE.SWR = 0_B.

GETH_AI.H002 Back-to-back writes to same register - Additional information

After a write operation to a register in the GETH register address space, a certain minimum delay is required before the next write to the same location.

Otherwise, the value written by the second write will not result in an update of the register in the destination clock domain, although the value read back from this location appears to be correct.

The current version of the GETH chapter in the TC3xx User's Manual contains the following statement (see 3rd bullet point in GETH sub-chapter "Registers"):

- “.. Thus, the delay between two writes to the same register location should be at least 4 cycles of the destination clock ..”

This information is insufficient. Instead, follow the modified recommendation below.

Recommendation

After a write operation, there should not be any further writes to the same location until the first write is updated. Thus, the delay between two writes to the same register location should be at least 6 cycles of the destination clock (Reference Clock for the Time Stamp Update (f_{GETH}), PHY receive clock or PHY transmit clock). The delay shall be calculated with the slowest of these clocks.

GETH TC.H002 Stopping and Starting Transmission - Additional information

Section “Stopping and Starting Transmission” in chapter “Programming Sequences” of the GETH chapter in the TC3xx User's Manual shall be extended by additional information in steps 3, 4, and 5.

Note: The following text is copied from the current version of the TC3xx User's Manual, with the additional information added in steps 3a), 4a), and 5a).

Stopping and Starting Transmission

You can pause transmission by disabling the Transmit DMA, waiting for previous frame transmissions to complete, disabling the MAC transmitter and receiver, and disabling the Receive DMA.

Notes

1. Do not change the configuration (such as duplex mode, speed, port, or loop back) when the MAC is actively transmitting or receiving. These parameters are changed by software only when the MAC transmitter and receiver are not active.

2. Similarly, do not change the DMA-related configuration when Transmit and Receive DMA are active.

Complete the following steps to pause the transmission for some time. The steps are provided for Channel 0.

Steps

1. Disable the Transmit DMA (if applicable) by clearing Bit 0 (ST) of DMA_CH0 Register.
2. Wait for any previous frame transmissions to complete. You can check this by reading the appropriate bits of MTL_TxQ0_Debug Register (TRCSTS is not 01 and TXQSTS=0).
3. Disable the MAC transmitter and MAC receiver by clearing Bit 0 (RE) and Bit 1 (TE) of the MAC_Configuration Register.
 - a) The receiver will be stopped after the register got written (verified by reading back the register) in approximately $3 \cdot f_{GETH} + 6 \cdot RXCLK$ cycles if no future packet is in receive state (see description of bit RE).
4. Disable the Receive DMA (if applicable), after making sure that the data in the Rx FIFO is transferred to the system memory (by reading the appropriate bits of MTL_RxQ0_Debug Register, PRXQ=0 and RXQSTS=00).
 - a) In case received data of a queue is not intended to be processed anymore set bit DMA_CHi_RX_CONTROL.RPF of each DMA channel moving out packets from this queue to flush all packets inside the queue after stopping the receive process.
5. Make sure that both Tx Queue and Rx Queue are empty (TXQSTS is 0 in MTL_TxQ0_Debug Register and RXQSTS is 0 in MTL_RxQ0_Debug Register).
 - a) In case a late packet arrived, either forward to the system memory by re-enabling the RX DMAs (see step 6) or flush data out of the queue (see step 4.a)
6. To restart the operation, first start the DMAs, and then enable the MAC Transmitter and Receiver.

GETH_TC.H003 MII and RMII clock period - Data Sheet documentation update

Ethernet transceivers connected to AURIX™ microcontrollers often specify the values of their output clocks as typical (nominal) values to account for tolerances. Such parameters indicate System Requirements (marked “SR” in TC3xx Data Sheets) which must be provided by the system in which the TC3xx is designed in.

To comply with these specifications, the values for the clock period in section “ETH MII Parameters” and “ETH RMII Parameters” in the TC3xx Data Sheets shall be shifted from column “Min.” to column “Typ.”, as shown below.

Documentation update

Table 22 ETH MII Signal Timing Parameters - Update

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Clock period	t_7 SR	-	40	-	ns	$C_L = 25\text{pF}$; baudrate = 100 Mbps
		-	400	-		$C_L = 25\text{pF}$; baudrate = 10 Mbps

Table 23 ETH RMII Signal Timing Parameters - Update

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
ETH_RMII_REF_CL clock period	t_{13} SR	-	20	-	ns	50 ppm; $C_L = 25\text{pF}$

Note: Timings $t_{13}..t_{17}$ listed in the corresponding table “ETH RMII Signal Timing Parameters” in the TC3xx Data Sheets which are related to input signals of the TC3xx shall be considered as System Requirements (SR).

GTM_TC.H010 Trigger Selection for EVADC and EDSADC

If the GTM output selection in the SELz bit fields for ADC triggers (registers ADCTRIGxOUTy, DSADCOUTSELxy) is changed during SW runtime, multi-bit changes may lead to unintended ADC triggering.

Recommendation

Before changing the trigger source in the GTM output selection fields SELz, ensure that the ADCs at the trigger destination will not react on intermediate state changes of the trigger signals.

GTM_TC.H019 Register GTM_RST - Documentation Update

In the current documentation, bit 0 in register GTM_RST is described as

- **Type:** r
- **Description:** Reserved - Read as zero, should be written as zero.

Documentation Update

Actually, bit 0 in register GTM_RST is implemented as follows:

- **Type:** rw
- **Description:** Reserved - Read as zero, **shall** be written as zero.

Note: This Application Hint relates to problem GTM-IP-316 reported by the GTM IP supplier. On this AURIX™ TC3xx device step, the reported problem has no effect, independent of the value written to bit GTM_RST.0. However, GTM_RST.0 shall always be written with 0_B as documented in the register description to ensure compatibility with future versions.

GTM_TC.H021 Interrupt strategy mode selection in IRQ_MODE

The default setting for field IRQ_MODE in register IRQ_MODE is Interrupt Level mode (00_B).

Figure “GTM interrupts” in chapter “GTM Implementation” of the TC3xx User’s Manual shows how the interrupt signal (GTM_IRQ_XXX) triggers an interrupt towards the Interrupt Router (IR), depending on IRQ_MODE.

As described in the text below this figure, while using Level mode, if more internal “interrupt” events are generated (i.e. two TOM channels generating a CCU0 interrupt), just one interrupt signal is sent to the IR, and no more interrupts are triggered until the SW clears the GTM_IRQ_XXX line towards the IR.

Hence, in Level Mode, in some scenarios where another interrupt request is generated by GTM while the ISR handle also requests a SW clear, then, as the interrupt event is dominant over the clear event (for simultaneous interrupt and clear events), GTM_IRQ_XXX is not cleared and remains high. As a consequence, the IR observes no transition on GTM_IRQ_XX. Thus, any forthcoming interrupt events in this scenario are lost as there is no chance to release the CPU IRQ when a collision happens as shown in Figure below.

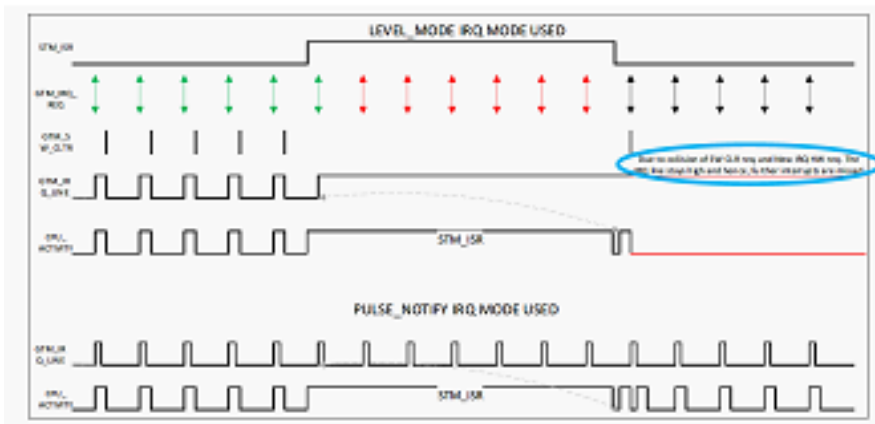


Figure 10 Interrupt Level vs. Pulse-Notify mode - Corner Case Example

If Pulse-Notify mode is selected, every internal trigger will be forwarded to the IR, irrespective of the time of occurrence and the clear event, as the pulse-notify leads to set and reset of GTM_IRQ_XXX as compared to only setting of the GTM_IRQ_XXX line in Level mode.

Recommendation

Therefore, it is recommended to use the Pulse-Notify mode to ensure that none of the interrupts might be lost by the IR even in corner timing cases.

As described above, this scenario in Level mode is only a corner case due to the timing of the SW and ISR handle. If using a different IRQ_MODE setting, evaluate your system performance for sufficient timing margin.

GTM_TC.H022 Field ENDIS_CTRLx in register ATOMi_AGC_ENDIS_CTRL - Documentation Update

The description for settings ENDIS_CTRLx = 10_B and ENDIS_CTRLx = 11_B in register ATOMi_AGC_ENDIS_CTRL in the current version of the TC3xx User's Manual is incorrect.

It will be updated in future revisions of the TC3xx User's Manual as shown in **Figure 11** below.

Field	Bits	Type	Description
ENDIS_CTRLx (x=0-7)	2*x+1:2*x	rw	<p>ATOM channel x enable/disable update value</p> <p>If FREEZE=0: If an ATOM channel is disabled, the counter CN0 is stopped and the output register of SOU unit is set to the inverse value of control bit SL. On an enable event, the counter CN0 starts counting from its current value.</p> <p>If FREEZE=1: If an ATOM channel is disabled, the counter CN0 is stopped (SOMP, SOMS mode) and each comparison is stopped (SOMC, SOMB mode). On an enable event, the counter CN0 starts counting from its current value or a comparison is restarted.</p> <p>Write of following double bit values is possible: <i>Note: If the output is disabled (OUTEN[x]=0), the ATOM channel x output ATOM_OUT[x] is the inverted value of bit SL.</i></p> <p>00_B Don't care, bits 1:0 of register ENDIS_STAT will not be changed on an update trigger</p> <p>01_B Disable channel on an update trigger</p> <p>10_B Enable channel on an update trigger</p> <p>11_B Don't change bits 1:0 of this register</p>

Figure 11 Updated description for settings ENDIS_CTRLx = 10B and ENDIS_CTRLx = 11B in register ATOMi_AGC_ENDIS_CTRL

HSCT_TC.H009 High speed dividers five phase clock sequence ordering

For correct operation of the phase correlator and avoiding degradation of BER during operation, the five phase clock generated by high speed dividers must remain in correct sequence.

To prevent the sequence of the five phase clock from being disordered, certain requirements have to be fulfilled when powering on/off of the HSCT physical layer.

Recommendation**Powering on:**

Make sure the Peripheral PLL clock is already locked and a correct clock is provided before the HSCT physical layer is powered on by setting bit CONFIGPHY.PON to 1_B.

Powering off:

Note that, according to section “Disable Request (Power-Off)” in the HSCT chapter of the TC3xx User’s Manual, high speed dividers need to be disabled (INIT.RXHD = 000_B and INIT.TXHD = 000_B) before the physical layer is powered off by setting CONFIGPHY.PON to 0_B.

HSCT_TC.H010 Interface control command timing on the LVDS ports

As described in section “Interface Control” of the HSCT chapter in the User’s Manual, a HSCT master device is sending interface control commands to a slave device by setting the command in register IFCTRL.IFCVS and triggering IFCTRL.SIFCV.

Once triggered, the interface command is scheduled for take over into the transmission FIFO for sending. Only when the interface command has been taken over into the FIFO, sending of the next interface command must be triggered by software. Therefore, software must monitor the takeover by a transition of IRQ.IFCFS from 0 to 1.

As flag IRQ.IFCFS only indicates

- takeover of the interface command into the FIFO
- readiness for the next interface command to be triggered

the user might falsely assume that also the actual sending on the LVDS TX port has already occurred once the IRQ.IFCFS flag is set, which is not true.

Instead the timing shown in **Figure 12** applies.

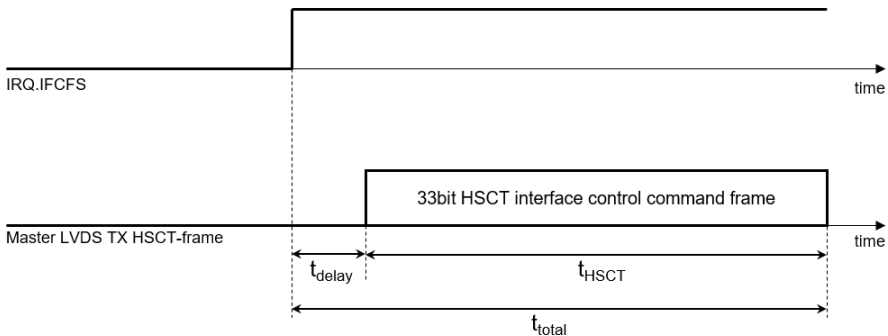


Figure 12 Timing of LVDS TX interface command sending in relation to IRQ.IFCFS

Recommendation

Before changing interface configurations, software must guarantee not having transfers active on the interface. Therefore the time of t_{total} has to be taken into account:

- $t_{\text{total}} = t_{\text{delay}} + t_{\text{HSCT}}$

While t_{HSCT} of the HSCT control command frame is determined and can be calculated from the actual baud rate, there is an additional time t_{delay} to be taken into account with

- $t_{\text{delay}} \geq 10 \mu\text{s}$

This value is valid for $f_{\text{SRI}} \geq 100 \text{ MHz}$, $f_{\text{SPB}} \geq 100 \text{ MHz}$ and baud rate $\geq 5 \text{ MBaud}$.

I2C_TC.H008 Handling of RX FIFO Overflow in Slave Mode

If the I2C kernel has detected a RX FIFO overflow in slave mode, a RX_OFL_srq request is generated, the incoming character is discarded, and the kernel puts a not-acknowledge on the bus and changes to listening state.

However, it does not generate an EORXP_ind signal, so that the remaining characters in the FIFO can not be moved out by means of data transfer requests.

Recommendation

Upon an RX FIFO overflow in slave mode, received data may be invalid. However, they may be read from the FIFO e.g. for analysis if required.

In order to flush the FIFO and correctly resume communication

- set bit RUNCTRL.RUN = 0_B (switch to configuration mode),
- set bit RUNCTRL.RUN = 1_B (participate in I2C communication).

INT_TC.H006 Number of SRNs supporting external interrupt/service requests – Documentation update

As correctly described in the SCU chapter “Output Gating Unit” of the TC3xx User’s Manual, **four** interrupt/service requests can be generated by the ERU OGU[0-3] via its outputs ERU_IOUT[0-3]. These outputs are connected to the IR Service Request registers SRC_SCUERU[0-3] via the signals ERU_INT[0-3].

Documentation update

The following statement in the IR chapter “External Interrupts” of the TC3xx User’s Manual is conflicting with the description above:

- “Eight SRNs (Int_SCUSRC[7:0]) are reserved to handle external interrupts.”

Therefore, it shall be changed as follows:

- “Four SRNs (SRC_SCUERU_x (x=0-3)) are reserved to handle external interrupts.”

MCDS TC.H007 Program trace of CPUx (x > 0) program start not correct

Note: This problem is only relevant for development tools.

All CPUs - except CPU0 - need to be started by user software from another CPU. This user software writes the PC and starts the CPU.

If this phase is traced with MCDS, the program trace for the first two executed instructions is not correct. The start PC is not visible and depending on the trace mode, the address of the second instruction is shown twice in the trace and there can be a wrong IPI message. However these effects are limited to the first two instructions.

Nevertheless this is confusing for the user and it can be an issue for trace based code coverage tools.

Recommendations

- A trace tool can ignore the generated trace messages for the first two instructions and replace it with proper messages.
- A trace tool can notify the user that the initial trace sequence for the first two instructions at startup is not correct.

MCMCAN AI.H001 Behavior of interrupt flags in CAN Interface (MCM-CAN)

In the corner case described below, the actual behavior of the interrupt flags of the CAN Interface (MCMCAN) differs from the expected behavior as follows.

Expected Behavior

When clearing an interrupt flag by software, the resulting value of the flag is expected to be zero.

A hardware event that occurs afterwards then leads to a zero to one transition of the flag, which in turn leads to an interrupt service request.

Actual Behavior in Corner Case

When the interrupt flag is being cleared by software in the same clock cycle as a new hardware event sets the flag again, then the hardware event wins and the flag remains set without being cleared.

As interrupt requests are generated only upon zero to one transitions of the flag, no interrupt request will be generated for this flag until the flag is successfully cleared by software later on.

Note: This behavior applies to all Interrupt flags of MCMCAN, with the exception of the receive timeout event (flag NTRTRi.TE).

Workaround

After clearing the flag, the software shall read the flag and repeat clearing until the flag reads zero.

MCMCAN_AI.H002 Busoff Recovery

Note: The following text is copied from Application Note M_CAN_AN004 V1.1 by Robert Bosch GmbH and describes the busoff recovery handling in the MCMCAN module used in AURIX™ TC3xx devices.

The M_CAN enters Busoff state according to CAN protocol conditions. The Busoff state is reported by setting PSR.BO. Additionally, the M_CAN sets CCCR.INIT to stop all CAN operation.

To restart CAN operation, the application software needs to clear CCCR.INIT.

After CCCR.INIT is cleared, the M_CAN's CAN state machine waits for the completion of the Busoff Recovery Sequence according to CAN protocol (at least 128 occurrences of Bus Idle Condition, which is the detection of 11 consecutive recessive bits).

In the MCMAN chapter of the TC3xx User's Manual the description of Busoff Recovery states that "Once CCCR.INIT has been cleared by the CPU, the device will then wait for 129 occurrences of Bus Idle (129 * 11 consecutive recessive bits) before resuming normal operation. At the end of the Busoff Recovery sequence, the Error Management Counters will be reset".¹⁾

The M_CAN uses its Receive Error Counter to count the occurrences of the Bus Idle Condition. If need be, that can be monitored at ECR.REC. Additionally, each occurrence of the Bus Idle condition is flagged by PSR.LEC = 5 = Bit0Error, which triggers an interrupt (IR.PEA) when IR.PEAE is enabled.

While the Busoff Recovery proceeds, the CAN activity is reported as “Synchronizing”, PSR.ACT = 0 and PSR.BO remains set. The time from resetting CCCR.INIT to the clearing of PSR.BO will be (in the absence of dominant bits on the CAN bus) 1420 (11 * 129 + 1) CAN bit times plus synchronization delay between clock domains.

The M_CAN does not receive messages while the Busoff Recovery proceeds.

The M_CAN does not start transmissions while the Busoff Recovery proceeds. When a transmission is requested while the Busoff Recovery proceeds, it will be started after the Recovery has completed and CAN activity entered Idle state, PSR.ACT = 1.

When the Busoff Recovery has completed, PSR.BO, ECR.TEC, and ECR.REC are cleared, and one CAN bit time later PSR.ACT is set to Idle.

After PSR.ACT reaches Idle, it will remain in Idle for at least one CAN bit time. The M_CAN's CAN state machine will become receiver (PSR.ACT = 2) when it samples a dominant bit during Idle state or it will become transmitter (PSR.ACT = 3) when it detects a pending transmission request during Idle state.

MCMCAN_TC.H006 Unintended Behavior of Receive Timeout Interrupt

On following conditions:

1. Receive timeout feature is enabled (i.e. NTRTR.RELOAD != 0), **and**
2. Received CAN frames are stored in RxFIFO 0/1 or Dedicated Rx Buffers, **and**
3. Respective New CAN frame received interrupts are disabled (i.e. bits IE.RF0NE, IE.RF1NE or IE.DRXE are 0),

1) See Note in description of field LEC and footnote 1) in description of bit BO in Protocol Status Register i (PSRi).

then an unintended receive timeout interrupt (if enabled, i.e. NTRTR.TEIE = 1) is triggered, although a valid CAN frame is newly received and stored in the respective RxFIFO 0/1 or Dedicated Rx Buffers.

Recommendation

Enable the corresponding receive interrupt via bits IE.RF0NE, IE.RF1NE, or IE.DRXE, depending on the usage of RxFIFO0/1 or dedicated Rx Buffers for proper function of the receive timeout interrupt.

Example

If RxFIFO 0 is used, set IE.RF0NE = 1.

MCMCAN_TC.H007 Delayed time triggered transmission of frames

The value written in the bit-field RELOAD of register NTATTRi(i=0-3), NTBTTTRi(i=0-3), NTCTTTRi(i=0-3) represents the reload counter value for the timer used for triggered transmission of message objects (Classical CAN or CAN FD frames).

The timer source and the prescaler value is defined in the NTCCCRi(i=0-3) register.

Once a value is written to bit-field RELOAD with bit STRT=1 the timer starts counting. This timer counts one value more than the written value in bit-field RELOAD, then it triggers the transmission of a message object.

Effect

The message object transmission is delayed by one counter cycle with respect to the desired count time written in bit-field RELOAD.

Recommendation

In order to transmit a message object at a specific time, when using one of these registers:

- NTATTRi(i=0-3), NTBTTTRi(i=0-3), NTCTTTRi(i=0-3),
set bit-field RELOAD one value less than the calculated counter value.

MCMCAN_TC.H008 Parameter “CAN Frequency” - Documentation update to symbol in Data Sheet

As described in chapter “Clocking System” of the AURIX™ TC3xx User’s Manual,

- f_{MCANH} defines the frequency for the internal clocking of the MCMCAN module,
- f_{MCAN} defines the basic frequency for the MCMCAN module used for the baud rate generation.

Documentation Update

For consistency with the description in the TC3xx User’s Manual, the symbol for parameter “CAN frequency” in table “Operating Conditions” in the Data Sheet shall be changed from “ f_{CAN} ” to “ f_{MCAN} ” as shown below:

Table 24 Operating Conditions - CAN Frequency: symbol update

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
CAN Frequency	f_{MCAN} SR	-	-	80	MHz	

MSC_TC.H014 Symbol T_A in specification of FCLPx clock period in Data Sheet - Additional information

The tables in chapter “MSC Timing” in the Data Sheet use symbol “ T_A ” in the specification of parameter “FCLPx clock period”.

In this context, $T_A = 1/f_A$, where f_A is the input clock frequency of the MSC ABRA block (see also the MSC chapter in the User’s Manual).

MTU_TC.H015 ALM7[0] may be triggered after cold PORST

During firmware start-up after cold PORST, alarm status flag AG7.SF0 (correctable SRAM error) may erroneously be set to 1, although no error occurred. This is due to a dummy read to an uninitialized SRAM by firmware.

Note: No entry into any of the ETRR registers is made due to this issue.

Recommendation

As alarms for correctable errors are uncritical in general, no action is required (alarm can be ignored). The application may only react on the error overflow.

In addition, to ensure that SMU alarm ALM7[0] does not correspond to a real SRAM correctable error, the user may refer to the ESM MCU_FW_CHECK described in the Safety Manual.

MTU_TC.H016 MCI_FAULTSTS.OPERR[2] may be triggered at power-up in case LBIST is not run

After power-up and before initialization by the SSW the safety flip-flops in the SSH can indicate a fault since some internal registers are not initialized. As a consequence MCI_FAULTSTS.OPERR[2] could be set and result in an alarm.

This is not a real error. LBIST does initialize the internal registers and clears the error.

Recommendation

Alarms resulting from MCI_FAULTSTS.OPERR[2] should be ignored during start-up and cleared right after execution of the SSW in case LBIST was not run.

MTU_TC.H017 Behavior of MCI_ECCS register for SSH instances with DED - Documentation update

The MCI_ECCS register description in the MTU chapter of the AURIX™ TC3xx User's Manual is generic (MCI_ECCS (i=0-95)).

The behavior for SSH instances with ECC type "double bit error detection" (see symbol "DED" e.g. in table "SSH instances" in the product specific appendix to the TC3xx User's Manual) deviates since error correction is not implemented here.

Bit ECE (Error Correction Enable) is also implemented in ECCS registers of SSH instances with DED, and its reset value is 1_B.

Documentation update

To reflect this behavior of MCI_ECCS registers for SSH instances with ECC type “DED”, section “SRAM Error Detection & Correction (EDC/ECC)” in the MTU chapter shall be updated:

Following the sentence

- “DED codes can detect upto a double bit error, but cannot correct any error.”

this sentence shall be added

- “ECCS.ECE does exist and can be written and read for SSH with DED. However, it has no functionality.”

OCDS TC.H014 Avoiding failure of key exchange command due to over-write of COMDATA by firmware

Note: This problem is only relevant for tool development, not for application development.

After PORST the UNIQUE_CHIP_ID_32BIT is written to the COMDATA register by firmware (time point T1). Then, firmware evaluates whether a key exchange request (CMD_KEY_EXCHANGE) is contained inside of the COMDATA register at a time point (T2). If yes, firmware will expect the 8 further words (password) from the COMDATA. If no, firmware will write again the UNIQUE_CHIP_ID_32BIT value for external tools to identify the device.

If the key exchange request cannot arrive between time points T1 and T2, firmware will skip the unlock procedure and will not unlock the device. For example, the device is locked and the external tool writes the CMD_KEY_EXCHANGE value to COMDATA before T1. Then, this value is overwritten by firmware at T1. After this, firmware doesn't see the CMD_KEY_EXCHANGE value and skips the unlock procedure. The device stays locked.

Recommendation

The external tool shall write the CMD_KEY_EXCHANGE to the COMDATA register between T1 and T2. As different derivatives and firmware configurations may have different execution time, it is recommended to poll the

content of COMDATA after PORST until the UNIQUE_CHIP_ID_32BIT is available. Then, the external tool shall write the CMD_KEY_EXCHANGE immediately. In this way, the overwrite of key exchange request by firmware can be avoided.

When LBIST is activated during startup, the execution time stays the same after the PORST triggered by LBIST. Therefore, the end of LBIST should be detected by the external tool. This can be achieved by polling the device state via JTAG/DAP. During LBIST, the debug interface is disabled and no response can be received. After LBIST, the response can be received normally. This symptom can be utilized to determine whether LBIST is done. The details are described in the section “Halt after PORST with DAP” in the OCDS chapter of the device documentation.

OCDS_TC.H015 System or Application Reset while OCDS and lockstep monitoring are enabled

After a System or Application Reset the Lockstep Alarm ALMx[0] gets activated if all of the following conditions are met (x = index of CPU with checker core):

1. Lockstep monitoring is enabled by BMI.LSENAx = 1_B for CPUx, AND
2. Debug System is enabled (CBS_OSTATE.OEN = 1_B), AND
3. CPUx is halted (either in boot-halt state or stopped by debugger tool or in idle mode) when reset is triggered OR CPUx Performance Counters are enabled.

Recommendation

To avoid the unintended ALMx[0] under the conditions described above, either:

- Keep the debug system disabled. OR
- Ensure all CPUs that have lockstep monitoring enabled are out of halted state AND CPUx Performance Counters are disabled before executing a System or Application reset. OR
- Use PORST instead of a System or Application reset.

OCDS TC.H016 Release of application reset via OJCONF may fail

Note: This problem is only relevant for tool development, not for application development.

The OJCONF.OJC7 bit field can be used to send an application reset request to the SCU. The tool sets the bit to request an application reset and has to clear the bit to release the request otherwise the device will remain in reset state.

If JTAG is used in the above case and the frequency of JTAG is very low, there is a risk that the tool is not able to release the application reset request. If DAP is used, there is a low risk that the first release of reset request may fail but the second will always work.

Recommendation

It is recommended to run JTAG above 1 MHz and execute the following instructions back to back:

IO_SUPERVISOR + IO_SET_OJCONF (release) + IO_SUPERVISOR + IO_SET_OJCONF (release).

This double releasing ensures that the reset request is released reliably.

OCDS TC.H017 CIF not reset by application reset if OCDS is enabled

Note: This problem only has an effect during debugging and if the CIF module is used.

If OCDS is enabled, the CIF module will not be reset (initialised) on an application reset.

Recommendation

During debugging use power-on reset or disable OCDS before triggering the application reset to ensure the reset of the CIF module.

OCDS_TC.H018 Unexpected stop of Startup Software after system/application reset

Note: this problem is only relevant for tool development, not for application development.

As documented in the TriCore Architecture Manual, the settings in the Debug Status Register (DBGSR) are only cleared upon a debug or power-on reset. This may lead to unexpected behavior in the following scenario:

If CPU0 is in HALT mode, and a system or application reset is triggered, the Startup Software (SSW) starts execution on CPU0, but it is stopped again (due to the settings in DBGSR) before the SSW has finished the boot procedure.

Recommendation

The tool should switch the device from HALT to RUN mode via the DBGSR register.

Alternatively, a power-on reset may be performed instead of a system/application reset.

PMS_TC.H003 VDDPD voltage monitoring limits

The EVR pre-regulator (EVRPR) generates the internal VDDPD voltage. Its upper and lower threshold limits are monitored by the VDDPD secondary monitor, while the minimum VLVDRSTC voltage (LVD reset level) is monitored by the VDDPD detector with built-in reference.

The secondary voltage monitor's upper and lower voltage thresholds for the VDDPD channel may be adapted in software for better centering across the nominal set point with sufficient margin accounting for static regulation and dynamic response of the VDDPD internal voltage regulator.

Note: The PREOVVAL and PREUVVAL values of EB_H and C7_H, respectively, mentioned in column "Note/Test Conditions" for VDDMON in the Data Sheet are only examples used to characterize the VDDMON accuracy under the specified conditions and shall not be used for the configuration of the EVROVMON2.PREOVVAL and EVRUVMON2.PREUVVAL fields in an application.

Recommendation

- The over-voltage alarm threshold setting in EVROVMON2.PREOVVAL needs not to be modified. The register reset value 0xFE = 1.460 V is appropriate (as well as the next lower value 0xFD = 1.454 V).
- For the under-voltage alarm threshold setting in EVRUVMON2.PREUVVAL:
 - The register reset value 0xBC = 1.079 V (typical) may be kept. It matches the LVD reset level (VLVDRSTC) which is at 1.074 V (typical). In this case, the reset will occur concurrently with the alarm, therefore either the reset, or the alarm and the reset will be triggered.
 - The threshold value might be set higher to the value 0xC4 = 1.125 V (typical), in order for the software to have some time to react on the alarm before the reset occurs.

In future versions of the User's Manual, the part for the VDDPD voltage monitor in figure "Voltage Monitoring - VEVR SB, VDDM & VDDPD" in the PMS and PMSLE chapter will be updated accordingly:

- PREOVVAL range = 1.43 V - 1.48 V.
 - Register reset value: SMU alarm generated at PREOVVAL ~ 1.46 V.
- PREUVVAL range = 1.1 V - 1.15 V.
 - Register reset value: SMU alarm generated at PREUVVAL ~ 1.08 V.

PMS TC.H004 VEXTMON supply monitor undervoltage threshold setting for 5.4V

Parameter " V_{EXT} , V_{DDM} and V_{EVRSB} secondary supply monitor accuracy after trimming" (symbol V_{EXTMON}) is defined for different voltage monitoring thresholds (typ. 3.3V, 4.6V, 5.4V, 5.0V) - see column "Note/Test Condition" in table "Supply Monitors" in the Data Sheet.

For the undervoltage monitoring threshold of 5.4V, the value of **EB_H** (instead of EA_H) should be used in field EVRUVMON.SWDUVVAL and EVRUVMON2 fields VDDMUVVAL and SBUVVAL, as shown in the table below.

Table 25 VEXTMON - Update for monitoring threshold = 5.4V

Parameter	Symbol	Values			Unit	Note/ Test Condition
		Min.	Typ.	Max.		
V _{EXT} , V _{DDM} and V _{EVRSB} secondary supply monitor accuracy after trimming (Footnotes see Data Sheet)	V _{EXTMON} CC	5.3	5.4	5.5	V	SWDxxVAL, VDDMxxVAL & SBxxVAL monitoring threshold=5.4V=EB _H (UV) / EC _H (OV). For BGA packages: EVRMONFILT.SWDFL =1
		5.3	5.4	5.5	V	SWDxxVAL, VDDMxxVAL & SBxxVAL monitoring threshold=5.4V=EB _H (UV) / EC _H (OV). For QFP packages: EVRMONFILT.SWDFL =2

PMS_TC.H005 SCR clock in system standby mode - Documentation update

The following statement in the fourth paragraph of PMS and PMSLE chapters “Standby Controller (SCR) Interface” is incorrect:

“The 70 kHz stand-by clock source is the default SCR clock active in Standby Mode. The SCR clock source may be switched to the internal 20 MHz (derived from the 100 MHz back-up clock) clock source via SCRCLKSEL register bit thus enabling higher performance on the SCR subsystem.”

It shall be replaced by the following statement:

Correction

The 20 MHz stand-by clock source is the default SCR clock active in System Standby Mode enabling higher performance of the SCR subsystem. The SCR clock source may be switched to the internal low-power 70 kHz clock by the SCR subsystem via bit CMCON.OSCPD if bit PMSWCR4.SCRCLKSEL is set to 1_B.

PMS_TC.H008 Interaction of interrupt and power management system - Additional information

The description of steps to enter Idle, Sleep and Standby Mode in chapter “Power Management Overview” of the PMS and PMSLE chapters in the current TC3xx User’s Manual is not comprehensive in explaining the dependency on pending interrupts as well as received interrupts. Hence, more explanation is provided here.

For a CPU to enter Idle Mode, it must have no interrupts pending. If it is in Idle Mode it will stay in Idle Mode until one of the specified wake-up events occurs – one of these is to have a pending interrupt.

Any SRN targeting a specific CPU (i.e. TOS set to that CPU), which is enabled, i.e. has SRE set, and has received a trigger event, i.e. has SRR set (whether by a received trigger from a peripheral or a master using the SETR control bit in the SRN) is a pending interrupt. Thus, even if a peripheral is shut down by having its clocks gated off, if it has presented a trigger event to the IR, and the SRE bit for that SRN is set, there will be a pending interrupt to the specified CPU.

It is not necessary for the priority of the pending interrupt to allow it to be taken, nor is it necessary for the CPU to have interrupt servicing enabled. It is possible and valid for Idle Mode to be entered with interrupts disabled, and to only re-enable interrupt acceptance subsequent to resuming execution. Equally, the CPU’s priority may well dictate that the interrupt cannot be serviced immediately on re-enabling interrupts.

There may be some interrupts in a system that a CPU will be required to service and must exit Idle Mode (or Sleep Mode) or prevent entry to Idle Mode (or Sleep or Standby Mode) on their arrival. If one of these interrupts is raised prior to, or

just as Idle Mode, Sleep Mode or Standby Mode is requested then that mode will not be entered.

The description for the REQSLP field states

- “In Idle Mode or Sleep Mode, these bits are cleared in response to an interrupt for the CPU, or when bit 15 of the corresponding CPU Watchdog Timer register (bit WDTCPUsSR.TIM[15]) changes from 0 to 1.”

For clarity, this also means, if a write to PMCSRx.REQSLP occurs while the IR has a pending interrupt for CPUx the write data will be ignored and the REQSLP value will remain as 00_B “Run Mode”.

For the system to enter Sleep or Standby Mode by writing to PMCSRx.REQSLP (as opposed through an external low voltage condition), all CPUs must be in Idle Mode. Typically, first other CPUs will be brought into Idle Mode and then the master CPU will be the last to enter to Idle Mode as a transitional state of the request for the system mode Sleep or Standby. Consequently any pending interrupts for any CPU will prevent the entry into Sleep or Standby Mode.

Recommendation

To ensure the transition to a power save mode, for a CPU intended to enter Idle Mode or for a system entering Sleep or Standby mode, all interrupts that are not intended to cause Run Mode to be re-entered or retained, should either have the SRE bit cleared in the respective SRN or be guaranteed to have the SRR bit clear.

If modifying the SRE bit of an SRN, to ensure the new state is reflected in IR arbitration information conveyed to the PMS and CPUs, sufficient time for an arbitration must have elapsed. Hence, a subset of the synchronisation described in subsection “Changing the SRN configuration” of the IR chapter in the TC3xx User’s Manual is required.

After the last SRN (for CPUx) has been updated

- Read back the last SRN
- Read the LWSRx register

Clearing the SRR bit or disabling the source of the trigger can also be used if there are no timing hazards; i.e. no risk of a trigger being raised just before reconfiguring the peripheral (to not raise triggers), or no risk of an SRN that has had SRR cleared being set again while other SRNs are accessed. If the timing

behaviour of these interrupt sources allows them to be disabled at source or in the SRN these are also valid methods. So long as the SRE bit and SRR bit are not both set, there will not be a pending interrupt. If the SRR bits are cleared, after the last SRN is modified there also needs to be a synchronisation step for the IR outputs to reflect the update before the PMCSR_x is written.

Once there are no pending interrupts, request the power saving mode by writing to the respective PMCSR_x.

Note: There will still be several system clock cycles till the power saving mode is enabled by the PMS during which the CPU will continue to execute instructions.

To ensure a deterministic boundary for execution to end after the power saving mode request, the write to PMCSR_x should be followed by a DSYNC and a WAIT instruction.

PMS_TC.H009 Interaction of warm reset and standby mode transitions

Chapter “Power Management” in the PMS and PMSLE chapters of the TC3xx User’s Manual in general describes how the standby mode transitions are performed from the AURIX™ system point of view (see also figure “Power down modes and transitions”).

This application hint addresses the specific use cases

- when a standby request by VEXT ramp down is issued during warm reset, or
- when a warm reset is triggered when a standby mode transition is ongoing.

The PMS and PMSLE modules have a separate state machine operating independently from the rest of the AURIX™ system. The PMS and PMSLE modules and states are not affected by warm resets (e.g. application reset). Table “Effect of Reset on Device Functions” in the SCU chapter of the TC3xx User’s Manual shows how the AURIX™ modules are affected by different reset types. The PMS and PMSLE modules behave in the same way as the EVR module listed in this table.

Therefore standby mode entry is achieved even in the reset state of the AURIX™ system modes.

PSI5_TC.H001 No communication error in case of payload length mismatch

When the payload of a frame is higher than the set payload size PDLxy for channel x and slot y, then neither the CRC error nor any other error flag is reliably set in all cases.

When less data is received than the set payload size PDLxy, there are error flags (NBI) that can handle this scenario.

Recommendation

The payload data received should match the configured payload size PDLxy for channel x and slot y (register/field RCRAx.PDLy).

QSPI_TC.H008 Details of the Baud Rate and Phase Duration Control - Documentation update

To enhance readability, the last part of the second paragraph in the QSPI chapter “Details of the Baud Rate and Phase Duration Control”, starting with “Variations in the baud rates of the slaves ..”, shall be rephrased as shown below.

For further details see also the formulas in the chapter mentioned above and in the figures in chapter “Calculation of the Baud Rates and the Delays” in the User’s Manual.

Documentation update

Variations in the baud rates of slaves of one module are supported by the ECONz.Q and the ECONz.A/B/C bitfield settings allowing for a flexible bit time variation between the channels in one module.

RESET_TC.H006 Certain registers may have different reset values than documented in TC3xx User’s Manual - Documentation update

The following registers may show different reset values compared to those documented in the TC3xx User’s Manual or TC3xy appendix. During device

start-up, the initial hardware reset values of certain registers may be updated. Consequently, user software may read different values. Please refer to the table below for further details.

Note: The TC3xx User's Manual chapters and/or register bitfield descriptions may contain information in addition to reset values/tables.

*Note: The registers listed in the table apply to TC39x..TC35x and TC3Ex. Presence of CPU*_PCON1 registers depends on number of available CPUs.*

Table 26 TC3xx registers that may have different reset values than documented in TC3xx User's Manual

Register	Initial reset value	Reset value defined in User's Manual	Remark
P20_IOCRO	0x0010 0000	0x0000 0000 (HWCFG6 = tri-state)	TESTMODE pin is PU (input pull-up), even with HWCFG6 = tri-state, as described in Data Sheet.
EMEM_TILECONFIG	0x0000 0000	0x5555 5555	This is a write-only ("w") register. For tile mode information do not read EMEM_TILECONFIG; instead, read EMEM_TILESTATE.
SBCU_DBCN TL	0x0000 7002	0x0000 7003	Bit EO is "Status of BCU Debug Support Enable" and only set after reset when OCDS is enabled. This bit is controlled by Cerberus.

Table 26 TC3xx registers that may have different reset values than documented in TC3xx User's Manual (cont'd)

Register	Initial reset value	Reset value defined in User's Manual	Remark
CPU1_PCON1	0x0000 0001	0x0000 0000	Bit PCINV of PCON1 is set when CPU is in boot halt mode, it is cleared when CPU starts execution
CPU2_PCON1	0x0000 0001	0x0000 0000	
CPU3_PCON1	0x0000 0001	0x0000 0000	
CPU4_PCON1	0x0000 0001	0x0000 0000	
CPU5_PCON1	0x0000 0001	0x0000 0000	
HSSL0_MFLA GS	0xA000 0000	0x8000 0000	Bit TEI indicates the state of CTS (Clear To Send) signal from HSCT module. The default state of this bit is 1.
HF_OPERATI ON	0x0000 0X00	0x0000 0000	RES bits shall be ignored.
PMS_EVRSD CTRL0	0x3039 0001	0xF039 0001	LCK and UP bits are cleared.
PMS_EVRSD CTRL1	0x0669 0708	0x8669 0708	LCK bit is cleared.
PMS_EVRSD CTRL6	0x0023 1C94	0x8023 1C94	LCK bit is cleared.
PMS_EVRSD CTRL7	0x0000 00FE	0x8000 00FE	LCK bit is cleared.
PMS_EVRSD CTRL8	0x1121 048E	0x9121 048E	LCK bit is cleared.
PMS_EVRSD CTRL9	0x0000 0434	0x8000 0434	LCK bit is cleared.
PMS_EVRSD CTRL11	0x1207 0909	0x9207 0909	LCK bit is cleared.
PMS_EVRSD COEFF0	0x3508 73B6	0xB508 73B6	LCK bit is cleared.

Table 26 TC3xx registers that may have different reset values than documented in TC3xx User's Manual (cont'd)

Register	Initial reset value	Reset value defined in User's Manual	Remark
PMS_EVRSD COEFF1	0x2294 6C46	0xA294 6C46	LCK bit is cleared.
PMS_EVRSD COEFF6	0x0097 1802	0x8097 1802	LCK bit is cleared.
PMS_EVRSD COEFF7	0x0000 D8F7	0x8000 D8F7	LCK bit is cleared.
PMS_EVRSD COEFF8	0x0017 1002	0x8017 1002	LCK bit is cleared.
PMS_EVRSD COEFF9	0x0000 A0AF	0x8000 A0AF	LCK bit is cleared.
SCU_OSCCO N	0x0000 0258 for UCB_DFLASH. OSCCFG = 0;0x0XX0 XXX X otherwise	0x0000 0X1X	SCU_OSCCFG setting is recovered from UCB_DFLASH

SAFETY_TC.H001 Features intended for development only – Documentation update to Safety Manual

Certain features of the AURIX™ TC3xx microcontrollers are not considered in SEooC (Safety Element out of Context) development scope as they are intended to be used only during the system development phase. Consequently, in the productive stage of an Electrical Control Unit (ECU), these features shall not be used by the system integrator. They will be categorized in future revisions of the Safety Manual as "Development-Only" features.

The table below shows an extensive list of these features.

Table 27 AURIX™ TC3xx Features intended for Development-only

Functional Block	Functions	Function Name	Remarks
GTM	TRIGGER_Data_Generation	DTRACE	Interface to trigger tracing of internal GTM signals. Regarded as not being part of any application after development phase is finalized
MCMCAN	Receive	DEBUG_RX	Interface used for debugging purpose to receive DAP frame over CAN frame. Development-only feature as debugging is not part of the safety relevant application assumption
MCMCAN	Transmit	DEBUG_TX	Interface used for debugging purpose to transmit DAP frame over CAN frame. Development-only feature as debugging is not part of the safety relevant application assumption
SCU	Watchdog	WDTDebug Suspend	This function shall only be used during Debug-operation in order to avoid unintended alarms/resets
TRACE	Other interfaces	TRACE	This feature should be used only during development to document and analyze the run-time behavior of a software
DEBUG	all	DEBUG	Debug feature (OCDS, MCDS) shall only be activated and used during system development phase and shall be deactivated before release for production

Table 27 AURIX™ TC3xx Features intended for Development-only

Functional Block	Functions	Function Name	Remarks
CPU	OVERLAY	OVERLAY	Overlay is typically used for evaluation of SW calibration parameters. Once the latter is finalized, the feature shall be deactivated
CPU	Data Acquisition	OLDA	Online Data Acquisition feature shall only be used during SW evaluation phase
Firmware	Data Storage in EMEM	EMEM-Prolog	This feature is aimed to be used for calibration purposes. It shall be deactivated together with final storage of SW in PFLASH
CAN/LIN	Code Loading	BSL	This feature is only used for initial device programming. It is not needed anymore once the application software is stable

SAFETY_TC.H002 SM[HW]:CPU.PTAG:ERROR_DETECTION – Documentation update to Safety Manual

Section 6.97 “SM[HW]:CPU.PTAG:ERROR_DETECTION” in chapter “Safety Mechanisms” of the current version of the AURIX™ TC3xx Safety Manual contains an incorrect part marked **bold** in the sentence copied below:

Incorrect sentence

“The SRAM implements a DED ECC logic. This mechanism detects SBE and DBE during read operations. In case an DBE is detected or **ECE is disabled** an SBE is detected a critical uncorrectable error alarm is forwarded to the SMU.”

Corrected sentence

“The SRAM implements a DED ECC logic. This mechanism detects SBE and DBE during read operations. In case a DBE is detected or a SBE is detected a critical uncorrectable error alarm is forwarded to the SMU.”

Summary

The CPU.PTAG memory is protected by an error detection code ECC capable to detect both single and double bit errors. Single bit errors (SBE) will lead to an uncorrectable error alarm regardless of the ECE configuration.

CPU PTAG does not offer SBE error correction capabilities. Indeed, both SBEs and DBEs will trigger an uncorrectable critical error alarm.

The correct hardware implementation of the ECC of the CPU PTAG memory is described in section 4.2.3.3.2 “Monitoring Concept” of the Safety Manual. See the note copied below:

“NOTE: CPU.PTAG do not offer SBE error correction capabilities. SBE and DBE are detected and an uncorrectable error is generated as described in SM[HW]:CPU.PTAG:ERROR_DETECTION.”

Note: Absolute section numbers in the text above apply to V1.06 of the AURIX™ TC3xx Safety Manual.

**SAFETY_TC.H003 ESM[SW]:EDSADC:VAREF_PLAUSIBILITY and
ESM[SW]:EVADC:VAREF_PLAUSIBILITY – Additional information**

The safety mechanisms ESM[SW]:EDSADC:VAREF_PLAUSIBILITY and ESM[SW]:EVADC:VAREF_PLAUSIBILITY require the system integrator to implement a check of the reference voltages (V_{AREF} , V_{AGND}) of the EDSADC and EVADC of the AURIX™ TC3xx, respectively, either by an external monitor or by internally converting a known signal and comparing the result with the expected value.

Typically, when executing these safety mechanisms, two conversions take place and V_{AREF} comparison is done. Since only a low discharging is applied, an additional resistance of several tens of kOhms which could be caused by an external failure effect does not play that major role. This leads to the test being considered as passed.

However, when the application SW is switching to normal operating mode (e.g. 200 conversions every ms), the discharge of the VAREF input is significantly higher and a systematical failure will happen on all channels due to the increased additional resistance.

Recommendation:

The V_{AREF} plausibility check shall be performed under representative application conditions.

SAFETY_TC.H004 ESM[HW]:PMS:VEXT_VEVRSB_OVERVOLTAGE – Wording update

In the last paragraph of field “Description” in section 5.3 ESM[HW]:PMS:VEXT_VEVRSB_OVERVOLTAGE of the current version of the AURIX™ TC3xx Safety Manual, the word “could” will be replaced by the word “will” (marked in **bold** in the text below):

Current Description

“It is assumed that the system detects and disables the external voltage supplies VEXT and VEVRSB of the MCU in case of an over-voltage condition with the continuous monitoring of the external voltage supplies of the MCU.

The Over-voltage can be divided into 2 regions:

- Up to absolute maximum rating: Mechanisms are in a separate domain. Exceeding the operating conditions for longer than the specified time may lead to an increase of the micro-controller failure rate.
- Above absolute maximum rating: this is the reliability issue. In case internal circuitry is damaged, LBIST and HWBIST will detect it during start-up.
- If microcontroller is permanently damaged due to the exposure to the voltage level exceeding the specified maximum supply voltage, self-test (LBIST, HW BIST) could detect this fault during start-up.”

Modified Description

It is assumed that the system detects and disables the external voltage supplies VEXT and VEVRSB of the MCU in case of an over-voltage condition with the continuous monitoring of the external voltage supplies of the MCU.

The Over-voltage can be divided into 2 regions:

- Up to absolute maximum rating: Mechanisms are in a separate domain. Exceeding the operating conditions for longer than the specified time may lead to an increase of the micro-controller failure rate.
- Above absolute maximum rating: this is the reliability issue. In case internal circuitry is damaged, LBIST and HWBIST will detect it during start-up.
- If microcontroller is permanently damaged due to the exposure to the voltage level exceeding the specified maximum supply voltage, self-test (LBIST, HW BIST) **will** detect this fault during start-up.

Note: Absolute section numbers in the text above apply to V1.06 of the AURIX™ TC3xx Safety Manual.

SAFETY TC.H006 SM[HW]:PMS:VDD_MONITOR – Documentation update

The following sentence including an absolute value of the core supply voltage (V_{DD}) in section 6.349 “SM[HW]:PMS:VDD_MONITOR” of chapter “Safety Mechanisms” in the current version of the AURIX™ TC3xx Safety Manual

- Detects whether VDD (1.3V supply generated by EVR or from external) is within expected range.

shall be changed as listed below:

Updated sentence

- Detects whether the VDD supply voltage is within the expected range.

The typical value for V_{DD} is 1.25 V. See chapter “Electrical Specification” in the corresponding TC3xx device Data Sheet for absolute values and limits.

Note: Absolute section numbers in the text above apply to V1.06 of the AURIX™ TC3xx Safety Manual.

SAFETY_TC.H007 SM[HW]:CLOCK:PLL_LOSS_OF_LOCK_DETECTION – Documentation update

The term “VCO” in the following sentence included in section 6.43 “SM[HW]:CLOCK:PLL_LOSS_OF_LOCK_DETECTION” of chapter “Safety Mechanisms” in the current version of the AURIX™ TC3xx Safety Manual

- The PLL has a lock detection that supervises the VCO part of the PLL in order to differentiate between stable and unstable VCO circuit behavior.

shall be replaced by “**DCO**” as listed below:

Updated sentence

- The PLL has a lock detection that supervises the **DCO** part of the PLL in order to differentiate between stable and unstable **DCO** circuit behavior.

As described in chapter “Clocking System” of the TC3xx User’s Manual, the PLL implementation in the TC3xx devices has a DCO, it does not have a VCO.

Note: Absolute section numbers in the text above apply to V1.06 of the AURIX™ TC3xx Safety Manual.

SAFETY_TC.H008 Link between ESM[SW]:CONVCTRL:ALARM_CHECK and SM[HW]:CONVCTRL:PHASE_SYNC_ERR - Additional information

ESM[SW]:CONVCTRL:ALARM_CHECK is the SW measure to trigger the HW mechanism SM[HW]:CONVCTRL:PHASE_SYNC_ERR (see section “Safety Measures” in the CONVCTRL chapter of the TC3xx User’s Manual).

As of today, there is no link between these two mechanisms in the Safety Manual. To provide this information to system integrators, ESM[SW]:CONVCTRL:ALARM_CHECK (section 5.13 in the current version of the AURIX™ TC3xx Safety Manual) shall be added to the “**Tests**” field of SM[HW]:CONVCTRL:PHASE_SYNC_ERR (section 6.47 in Safety Manual), as shown below:

6.47 SM[HW]:CONVCTRL:PHASE_SYNC_ERR - Update to field “Tests”

Description

The Safety Mechanism supervises the operation of the Phase Synchronizer by monitoring the parity bit of its prescaler (PHSCFG.PHSDIV) and the counter value.

...

Tests

ESM[SW]:CONVCTRL:ALARM_CHECK

...

Note: Absolute section numbers in the text above apply to V1.06 of the AURIX™ TC3xx Safety Manual.

SAFETY_TC.H009 Reset Values for MC44, MC46 and MC47 FAULTSTS registers – Additional information

Note: This issue applies to AURIX™ TC3xx Safety Manual version v1.10 or previous versions. It is fixed in v1.11 and following.

Appendix A of the AURIX™ TC3xx Safety Manual (SM) provides reference values for SMU alarms and SSH internal status registers after device start-up.

This derivative specific listing includes in particular the FAULTSTS signatures for EMEM SSHs (index 44, 46, 47). In addition to the description in the SM, for certain configurations described below, MCi_FAULTSTS will show 0x1 instead of 0x601 after PORST:

- for MC44 on TC39x, TC37xEXT, TC35x, TC33xEXT
- for MC46 on TC37xEXT
- for MC47 on TC39x

For these devices, MCi_FAULTSTS will show 0x1 after PORST if global Flash read protection for either PFLASH and/or DFLASH is configured (HF_PROCONPF.RPRO and/or HF_PROCONDF.RPRO=1_B).

Recommendation

When implementing ESM[SW]:SYS:MCU_FW_CHECK and global Flash read protection is activated, check for 0x1 as pass criterion in MCI_FAULTSTS registers described above.

Existing implementations of ESM (without read protection) are still valid and respective safety claims on start-up are not affected.

SAFETY_TC.H011 SM[HW]:GTM:TOM_TOM_MONITORING_WITH_IOM – Additional information

Safety mechanism SM[HW]:GTM:TOM_TOM_MONITORING_WITH_IOM in the AURIX™ TC3xx Safety Manual describes how the usage of redundant ATOM/TOM channels in combination with the IOM enables the detection of faults on TX PWM generated by the GTM.

However, the description of this safety mechanisms omits to explicitly mention that the redundant ATOM/TOM channel shall be selected from different modules.

Indeed, if the mission and monitor ATOM/TOM channels are selected from the same module then SM[HW]:GTM:TOM_TOM_MONITORING_WITH_IOM would not be able to detect faults of the GTM logic (within the module) shared by both channels.

Also, FMEDA assumes that the redundant ATOM/TOM channels are selected from different modules.

Recommendation

To implement SM[HW]:GTM:TOM_TOM_MONITORING_WITH_IOM select the redundant ATOM/TOM channel from different ATOM/TOM modules.

Alternatives

If it is not possible to follow the recommendation above (e.g. because of lack of resources), it is recommended to implement alternative safety mechanisms instead (see also text module SAFETY_TC.001 for TC33x/TC32x):

Option 1

- Implement SM[HW]:GTM:TOM_TOM_MONITORING_WITH_IOM with ATOM channel and TOM channel (as redundancy) from different modules, respectively.

Considerations handling of FMEDA for systems using ATOM/TOM channels (Option 1) from the same module:

For systems where two ATOM/TOM channels from the same module are used in a redundant manner, the changes indicated in the following have to be made in the FMEDA to reflect the limitations in terms of coverage of SM[HW]:GTM:TOM_TOM_MONITORING_WITH_IOM:

- ESM[SW]:GTM:TOM_TIM_MONITORING and
- SM[HW]:GTM:TOM_TOM_MONITORING_WITH_IOM

has to be removed from columns “Safety Mechanism to Prevent Violation of Safety Goal” and “Safety Mechanism to Prevent Faults from Being Latent” in the FMEDA. The changes are to be implemented for the architectural elements present in **Table 28** and **Table 29** for the following reasons.:

- ESM[SW]:GTM:TOM_TIM_MONITORING is not applicable because it is not relevant in case of redundant ATOM/TOM channels with IOM use-case
- SM[HW]:GTM:TOM_TOM_MONITORING_WITH_IOM will not be able to detect faults from the shared logic. Below architectural element present in **Table 28** and **Table 29** are the shared logic between two ATOM or TOM channels used from the same module
- ESM[SW]:IR:ISR_MONITOR has to be kept as it is for the interrupt related failure modes that still can be detected by this ESM.

Table 28 FMEDA configuration changes for redundant ATOM channels from same ATOM module

Name	Sub-Part	Element Class	Function Name	Classification	Safety Mechanism to Prevent..	
					..Violation of Safety Goal	..Faults from Being Latent
GTM ATOM (mission)	MC_GTM_TC3xx. ATOMx	m	PWM_GEN	Single Point Fault	-	-

Table 29 FMEDA configuration changes for redundant TOM channels from same TOM module

Name	Sub-Part	Element Class	Function Name	Classification	Safety Mechanism to Prevent..	
					..Violation of Safety Goal	..Faults from Being Latent
GTM TOM (mission)	MC_GTM_TC3xx. TOMx	m	PWM_GEN	Single Point Fault	-	-

Option 2

- Use ESM[SW]:GTM:TOM_TIM_MONITORING instead of SM[HW]:GTM:TOM_TOM_MONITORING_WITH_IOM

SAFETY_TC.H013 ESM[SW]:SYS:MCU_FW_CHECK - Access to MC40 FAULTSTS register – Additional information

The FSI RAM is used to configure the PFLASH. For security related reason, the access to this RAM is restricted. Therefore, in order to avoid accesses to this RAM through its SSH, the MBIST Controller 40 (MC40) is not disclosed in the AURIX™ TC3xx Target Specification/User's Manual.

However, according to Appendix A of the Safety Manual, for SSH(40) register MC40_FAULTSTS must be compared to an expected value by ESM[SW]:SYS:MCU_FW_CHECK after reset.

Recommendation

When implementing ESM[SW]:SYS:MCU_FW_CHECK, the register address listed below has to be used to access the FAULTSTS register of MBIST Controller 40:

- MC40_FAULTSTS (0xF006 38F0)

SAFETY_TC.H014 EMEM monitoring – Documentation update

Section “Monitoring Concept” in the EMEM sub-chapter of “Architecture for Management of Faults” in the current version of the AURIX™ TC3xx Safety Manual contains the following statement:

- “Since EMEM is used for storing data for ADAS applications, the Application SW is responsible for periodically check(ing) the correct configuration...”

This is not fully correct.

Documentation update

Only a check **after** configuration is required, as described in ESM[SW]:EMEM:READ_CONFIGURATION.

SAFETY_TC.H015 SM[HW]:NVM:STARTUP_PROTECTION – Documentation update

The description of SM[HW]:NVM:STARTUP_PROTECTION in the current version of the AURIX™ TC3xx Safety Manual shall be updated as follows:

Documentation update

Description

After start-up, the SSW automatically sets SCU_STCON.STP=1_B for preventing unintentional changes by Application SW of start-up protected SFRs, which define MCU system characteristics. This monitors the STARTUP PROTECTION property on interconnect accesses to functional block configuration addresses (TriCore segment F). The SFR configuration addresses for which this protection applies are defined at specification time. An unintentional change by Application SW triggers an SRI0 bus error, and hence an SMU alarm.

SAFETY_TC.H016 ESM[SW]:CPU:SOFTERR_MONITOR - Documentation update

Note: This issue applies to AURIX™ TC3xx Safety Manual version v1.11 or previous versions. It is fixed in v1.12 and following.

In order to provide more clarity on how to implement the ESM[SW]:CPU:SOFTERR_MONITOR external safety mechanism, additional information shall be provided in the “Notes” field as shown in the following:

Documentation update

This ESM represents the coverage offered by system level measures implemented in the application such as:

1. System plausibility checks such as ESM[SW]::PLAUSIBILITY
2. Program flow monitoring such as ESM[SW]:SYS:SW_SUPERVISION
3. External / internal watchdog
4. CPU/Bus Trap handling
5. End-to-End safe communication protocols such as ESM[SW]::SAFE_COMMUNICATION

SAFETY_TC.H017 Safety Mechanisms requiring initialization - Documentation update

In chapter “Safety Mechanisms” of the AURIX™ TC3xx Safety Manual, safety mechanisms that need to be initialized by Application SW have a link in the “Init Conditions” field to a Safety Mechanism Configuration (SMC). This SMC provides a description of what has to be implemented to activate the respective safety mechanism (SM).

This is not valid for all safety mechanisms. Some of them have no SMC as “Init Conditions”, although they need to be activated.

Documentation update

Following is the list of safety mechanisms that have to be activated with the respective “Init Conditions”, in addition to the SMs that are already listed with a link to a SMC in field “Init Conditions” in the Safety Manual:

SM[HW]:CLOCK:ALIVE_MONITOR**Init conditions**

The application SW shall enable the clock alive monitoring by setting the corresponding bit in CCUCON3 register after PLLs have been set up and are running.

SM[HW]:CPU:TPS**Init conditions**

The application SW shall enable the temporal protection system (configure CPU_SYSCON.TPROTEN = 1_B).

SM[HW]:CPU:TPS_EXCEPTION_TIME_MONITOR**Init conditions**

The application SW shall enable the temporal protection system (configure CPU_SYSCON.TPROTEN = 1_B).

SM[HW]:CPU:CODE_MPU**Init conditions**

The application SW shall configure the Code MPU according to TriCore™ TC1.6.2 Core Architecture Manual Volume 1 V1.1 - Chapter 10 “Memory Protection System”.

SM[HW]:CPU:DATA_MPU

Init conditions

The application SW shall configure the Data MPU according to TriCore™ TC1.6.2 Core Architecture Manual Volume 1 V1.1 - Chapter 10 “Memory Protection System”.

SM[HW]:CPU:UM0

Init conditions

The application SW shall configure the CPU access privilege level control to User-0 Mode (CPU_PSW.IO = 00_B).

SM[HW]:CPU:UM1

Init conditions

The application SW shall configure the CPU access privilege level control to User-1 Mode (CPU_PSW.IO = 01_B).

SM[HW]:CPU:SV

Init conditions

The application SW shall configure the CPU access privilege level control to Supervisor Mode (CPU_PSW.IO = 10_B). (Default configuration).

SM[HW]:CPU:STI

Init conditions

The application SW shall configure the safe task identifier (CPU_PSW.S = 1_B).

SM[HW]:DMA:TIMESTAMP

Init conditions

The application SW shall enable the appendage of a DMA timestamp (configure DMA_ADICRc.STAMP = 1_B).

SM[HW]:EMEM:CONTROL_REDUNDANCY**Init conditions**

The application SW shall enable the EMEM module SRI control redundancy logic (EMEM_SCTRL.LSEN = 10_B).

SM[HW]:EMEM:READ_WRITE_MUX**Init conditions**

The application SW shall configure the mode of the EMEM tiles via EMEM_TILECONFIG and enable access to the EMEM tiles via EMEM_TILEECC and EMEM_TILECT.

SM[HW]:LMU:CONTROL_REDUNDANCY**Init conditions**

The application SW shall enable the LMU control redundancy logic (LMU_SCTRL.LSEN = 10_B).

SM[HW]:NVM.PFLASH:ERROR_CORRECTION**Init conditions**

The application SW shall enable the ECC error correction (CPUx_FLASHCON2.ECCCORDIS = 10_B).

Enabled after reset.

SM[HW]:NVM.PFLASH:ERROR_MANAGEMENT**Init conditions**

The application SW shall enable address buffer recording (CPUx_FLASHCON2.RECDIS = 10_B).

Enabled after reset.

SM[HW]:NVM.PFLASH:FLASHCON_MONITOR**Init conditions**

The application SW shall initialize CPUx_FLASHCON2.

SM[HW]:SPU:REDUNDANCY_SCC**Init conditions**

SM[HW]:SPU:REDUNDANCY_SCC is enabled when either of SM[HW]:SPU:PARTIAL_REDUNDANCY or SM[HW]:SPU:REDUNDANCY are enabled.

SM[HW]:SCU:EMERGENCY_STOP**Init conditions**

By default after reset, the Synchronous mode is selected; in this mode, the application SW shall enable (via EMSR.ENON = 1_B) the setting of the Emergency stop flag (EMSR.EMSF) on an inactive-to-active level transition of the port input.

Alternatively, the application SW can:

- Select the Asynchronous mode (EMSR.MODE = 1); in this mode the occurrence of an active level at the port input immediately activates the emergency stop signal.
- Configure Alarm(s) in SMU to trigger an Emergency Stop

SM[HW]:SMU:RT**Init conditions**

The application SW shall enable the Recovery Timers (RT_y, where y = 0,1) via RTC.RTyE = 1_B.

Recovery Timers (RT_y, where y = 0,1) are enabled after Application Reset to service the WDT timeout alarms.

SM[HW]:SMU:FSP_MONITOR**Init conditions**

FSP Monitor is enabled after Power-on Reset. The application SW shall ensure that the FSP is in the Fault Free State (SMU_ReleaseFSP()) before entering the RUN state with the SMU_Start() command.

SM[HW]:PMS:VDDM_MONITOR**Init conditions**

SMC[SW]:PMS:Vx_MONITOR_CFG

SCR_TC.H009 RAM ECC Alarms in Standby Mode

During Standby mode, every ECC error in the RAMs of the Standby Controller (SCR) can be detected but the respective alarm signal is not propagated and not triggered by the SMU (ALM6[19], ALM6[20] and ALM6[21]).

Note: If not in Standby mode, alarm signals for ECC errors from the SCR RAMs are propagated and triggered by the SMU.

Recommendation

ECC errors from the RAMs of SCR can be checked by the application software via bit SCRECC of PMS register PMSWCR2 (Standby and Wake-up Control Register).

SCR_TC.H010 HRESET command erroneously sets RRF flag

Note: This problem is only relevant for tool development, not for application development.

The HRESET command (to reset the SCR including its OCDS) erroneously sets the RRF flag (which signals received data to the FW).

Recommendation

With the following three additional commands (a-c) after an HRESET, the issues with the HRESET command can be solved:

- Execute HRESET
 - a) Execute HSTATE to remove reset bit from shift register.
 - b) Perform JTAG tool reset to remove flag RRF (receive register flag).
 - c) Execute HCOMRST to remove flag TRF (transmit register flag).

SCR_TC.H011 Hang-up when warm PORST is activated during Debug Monitor Mode

Note: This problem is only relevant for debugging.

When a debugger is connected and the device is in Monitor Mode (MMODE), the activation of a warm PORST will result in a hang-up of the SCR controller.

Recommendation

Perform an LVD reset (power off/on) to terminate this situation.

SCR_TC.H012 Reaction in case of XRAM ECC Error

When the double-bit ECC reset is enabled via bit ECCRSTEN in register SCR_RSTCON, and a RAM double-bit ECC error is detected, bit RSTST.ECCRST in register SCR_RSTST is set, but no reset is performed.

Recommendation

The reset of the SCR module in case of a double-bit ECC error must be performed via software.

The following steps need to be done:

- Enable the double-bit ECC reset by setting bit ECCRSTEN in register SCR_RSTCON to 1_B.
- Enable the RAM ECC Error for NMI generation by setting bit NMIRAMECC in register SCR_NMICON to 1_B.

When a RAM double-bit ECC error is detected, an NMI to the TriCore is generated, and bit RSTST.ECCRST in register SCR_RSTST is set.

The TriCore software first has to check the cause of the NMI wakeup by checking register SCR_RSTST. If bit ECCRST is set, a double-bit ECC error has occurred. In this case, do the following steps:

- Fill the XRAM memory with 0.
- Check whether an ECC error has occurred.
- If no ECC error has occurred after filling the XRAM with 0, then:
 - Reload the contents of the XRAM.

- Perform a reset of the SCR module: Set bit SCRSTREQ in register PMSWCR4 to 1_B.

SCR_TC.H013 External clock input to RTC - Documentation update

The following note will be added to the description of register RTC_CON in TC3xx User's Manuals V1.1.0 and higher:

Note: If the application changes back from external RTC oscillator to PCLK AND at the same time, the SCR is waking up (from 70kHz to PCLK), then the RTC clock is for 3 cycles at 70kHz, before changing to PCLK.

SCR_TC.H014 Details on WDT pre-warning period

The pre-warning interrupt request (FNMIWDT) of the SCR Watchdog Timer (WDT) means that a WDT overflow has just occurred, and in 32 cycles of the SCR WDT clock there will be a reaction to this overflow – a reset of the SCR.

After this pre-warning interrupt it is not possible to stop the WDT, as it has already overflowed, and it is not possible to stop this reaction (reset).

SCR_TC.H015 Page number of WCAN_MASK_ID*_CTRL registers in WUF Configuration Registers Address Map - Documentation correction

In table “WUF Configuration Registers Address Map” in the WCAN sub-chapter of the SCR chapter in the AURIX™ TC3xx User's Manual, the page number for registers

- WCAN_MASK_ID0_CTRL .. WCAN_MASK_ID3_CTRL

is erroneously documented as 3 instead of 2.

*Note: The page number 2 for the WCAN_MASK_ID*_CTRL registers is correctly documented in table “Register Overview - WCAN (sorted by Name)” and in the header of the corresponding register description.*

Correction

The part with the corrected page number for the WCAN_MASK_ID*_CTRL registers in table “WUF Configuration Registers Address Map” is shown in the following table.

Table 30 WUF Configuration Registers Address Map - Correction of page number for WCAN_MASK_ID*_CTRL registers

Register	Addr.	Page	SCR Reset Value	Full Name of Register
WCAN_MASK_ID0_CTRL	B4 _H	2	00 _H	Message Identifier Acceptance Mask Register 0
WCAN_MASK_ID1_CTRL	B5 _H	2	00 _H	Message Identifier Acceptance Mask Register 1
WCAN_MASK_ID2_CTRL	B6 _H	2	00 _H	Message Identifier Acceptance Mask Register 2
WCAN_MASK_ID3_CTRL	B7 _H	2	00 _H	Message Identifier Acceptance Mask Register 3

SCU_TC.H016 RSTSTAT reset values - documentation update

Table “Reset Values of RSTSTAT” in the SCU chapter of the current version of the User’s Manual is missing the scenario for “LVD Reset”. In addition, the reset value for “Cold PowerOn Reset” needs to be modified as shown in the following table:

Table 31 Reset Values of RSTSTAT - Update

Reset Type	Reset Value	Note
Cold PowerOn Reset	0XX1 0000 _H	
LVD Reset	1001 0000 _H	

Details:

For more detailed information about the reset triggers please refer to table “Voltage Monitoring” in the PMS chapter. Following information can be found there:

- Cold PowerOn Reset:
 - As the table shows, bit PORST is always set with the corresponding reset source (SWD, EVR33 or EVRC). Therefore the “Cold PowerOn Reset” value is 0XX1 0000_H.
- LVD Reset:
 - Bit STBYR is only set when the corresponding voltage drops below the LVD voltage limit. Bit PORST is set on LVD reset as well. Therefore the “LVD Reset” value is 1001 0000_H.
 - Bits SWD, EVR33 and EVRC are not set in this case, because after LVD reset the system has an initial ramp-up which will not set these bits.

SCU_TC.H019 Connection on ERU input E_REQ7(5)

Table “Connections of SCU” in the TC37x and TC37xEXT specific Appendix to the AURIX™ TC3xx User’s Manual includes the following connection

- SCU:E_REQ7(5) from GTM:SCU_TRIG(3)

As TOM3 is not present in the GTM implementation in TC37x and TC37xEXT, this connection is not functional in the TC37x and TC37xEXT and therefore should not be used.

SCU_TC.H020 Digital filter on ESRx pins - Documentation update

As described in the SCU and PMS chapters of the TC3xx User's Manual, the input signals ESR0 / ESR1 can be filtered. The filter for ESRx is enabled via bit PMSWCR0.ESRxDFEN = 1_B (default after reset).

If the digital filter is enabled then pulses less than 30 ns will not result in a trigger.

For pulses longer than 100 ns, the following dependency on f_{SPB} should be noted:

Note: Pulses longer than 100 ns will always result in a trigger for $f_{SPB} \geq 20$ MHz in RUN mode.

SCU_TC.H021 LBIST execution affected by TCK/DAP0 state

The TCK/DAP0 pad includes an internal pull down (marked "PD2" in column "Buffer Type" in table "System I/O of the Data Sheet).

If TCK/DAP0 is pulled up by an external device, LBIST execution will be stalled.

Recommendation

TCK/DAP0 pad shall be left open or pulled down if no tool is connected.

SCU_TC.H022 Effect of LBIST execution on SRAMs - Additional information

In sub-chapter "LBIST Support" in the SCU chapter of the TC3xx User's Manual, the section starting with:

"A successfully finished LBIST procedure is indicated by the LBISTCTRL0.LBISTDONE bit.."

shall be extended in future revisions of the SCU chapter as shown below:

Additional information

A successfully finished LBIST procedure is indicated by the LBISTCTRL0.LBISTDONE bit. Value of LBISTCTRL0.LBISTDONE bit is not

affected by the System or Application reset (it preserves its value). In case of warm or cold power-on reset, it resets LBISTDONE bit to 0, and soon after, if LBIST is configured to start, it will get its new result value.

Note: SRAM redundancy registers are part of the scan chain and hence corrupted by LBIST. Therefore, SRAMs contents are not reliable after LBIST and shall be initialized after LBIST, prior to usage.

DLMU SRAM with standby capability can be used instead to store information such as the LBIST execution count.

SCU_TC.H023 Behavior of bit RSTSTAT.PORST after wake-up from standby mode

After cold-power on (power up from no power supply), bit RSTSTAT.PORST is always set independent of PORST pad level (pulled high or low by user).

After wake-up from standby, bit RSTSTAT.PORST indicates if the PORST pad was asserted after the wake-up trigger.

Recommendation

If the user expects that bit RSTSTAT.PORST is always set after wake-up from standby, the PORST pad should be kept low externally until all supplies are in operating condition.

SDMMC_TC.H001 Idle State of SDMMC0_CLK

The idle level of the card clock output SDMMC0_CLK is high while the card clock is not enabled (bit CLK_CTRL.SD_CLK_EN = 0_B).

SDMMC_TC.H002 SDIO Card Interrupt Sequence - Figure update

Figure “SDIO Card Interrupt Sequence” in the SDMMC chapter of the current version of the TC3xx User’s Manual is wrong. The correct sequence is shown in the following **Figure 13**.

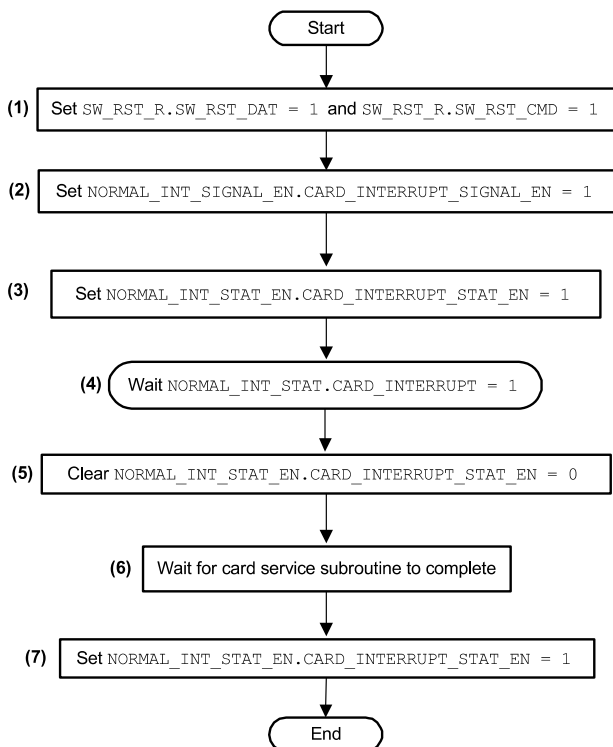


Figure 13 SDIO Card Interrupt Sequence

SENT_TC.H006 Parameter V_{ILD} on pads used as SENT inputs

Some port pins may have restrictions when used as SENT inputs, depending on the number of active neighbor pins (on the pad frame) and their output driver setting.

In the implementation of the SENT module and product integration within Infineon Technologies products there are never negative values for V_{ILD} , so V_{ILDmin} is 0 mV. Considering the same tolerance as the SENT standard V_{ILDmax} is 100 mV.

Note: All SENT port pins not listed in the tables below have no restrictions on their application usage as SENT inputs.

Table 32 SENT input pads and considered neighbors for TC37x and TC37xEXT

Considered left neighbors		SENT input		Considered right neighbors	
		Pad	Channel		
P02.6	P02.7	P02.8	0C	P02.9	P02.10
P00.0	P00.1	P00.2	1B	P00.3	P00.4
P02.5	P02.6	P02.7	1C	P02.8	P02.9
P02.4	P02.5	P02.6	2C	P02.7	P02.8
P02.3	P02.4	P02.5	3C	P02.6	P02.7
P15.0	P15.1	P15.2	10D	P15.3	P15.4
P15.2	P15.3	P15.4	11D	P15.5	P15.6
P02.2	P02.3	P02.4	12B	P02.5	P02.6
P02.1	P02.2	P02.3	13B	P02.4	P02.5
P02.0	P02.1	P02.2	14B	P02.3	P02.4

Note: The table above is sorted by SENT channel numbers in ascending order. The same sorting is also used in the tables below.

The following tables summarize the results of the V_{ILD} measurements of the SENT input pads potentially exceeding the V_{ILD} limits with different neighbor (2N/4N) and different edge strength/driver strength configurations.

- **VILD(DIST4N):** V_{ILD} measurements with four neighbor pads (two on the left and two on the right hand side of the SENT input) used in output mode alongside the SENT input pad on the pad frame.
- **VILD(DIST2N):** V_{ILD} measurements with two neighbor pads (one on the left and one on the right hand side of the SENT input) used in output mode alongside the SENT input pad on the pad frame.

Table 33 Effect of Driver Settings Fss, Sms, Sm on SENT inputs for TC37x and TC37xEXT

SENT Channel			Neighbors: Fast pads configured as Fss, others Sms/Sm	
Name	Number	Pin	VILD(DIST4N)	VILD(DIST2N)
SENT:SENT0C	0C	P02.8	x	OK
SENT:SENT1B	1B	P00.2	x (TC37xEXT) OK (TC37x)	OK
SENT:SENT1C	1C	P02.7	x	OK
SENT:SENT2C	2C	P02.6	x	x (TC37xEXT) OK (TC37x)
SENT:SENT3C	3C	P02.5	x	OK
SENT:SENT10D	10D	P15.2	x (TC37xEXT) OK (TC37x)	OK
SENT:SENT11D	11D	P15.4	x	OK
SENT:SENT12B	12B	P02.4	x	OK
SENT:SENT13B	13B	P02.3	x	x (TC37xEXT) OK (TC37x)
SENT:SENT14B	14B	P02.2	x	OK

Table 34 Effect of Driver Settings Fsm, Fm, Sms, Sm on SENT inputs for TC37x and TC37xEXT

SENT Channel			Neighbors: Fast pads configured as Fsm or Fm, others Sms/Sm	
Name	Number	Pin	VILD(DIST4N)	VILD(DIST2N)
SENT:SENT0C	0C	P02.8	OK	OK
SENT:SENT1B	1B	P00.2	OK	OK
SENT:SENT1C	1C	P02.7	OK	OK
SENT:SENT2C	2C	P02.6	OK	OK

Table 34 Effect of Driver Settings Fsm, Fm, Sms, Sm on SENT inputs for TC37x and TC37xEXT (cont'd)

SENT Channel			Neighbors: Fast pads configured as Fsm or Fm, others Sms/Sm	
Name	Number	Pin	VILD(DIST4N)	VILD(DIST2N)
SENT:SENT3C	3C	P02.5	OK	OK
SENT:SENT10D	10D	P15.2	OK	OK
SENT:SENT11D	11D	P15.4	OK	OK
SENT:SENT12B	12B	P02.4	OK	OK
SENT:SENT13B	13B	P02.3	OK	OK
SENT:SENT14B	14B	P02.2	OK	OK

Table 35 Abbreviations used for pad configuration

Symbol	Pad type	Driver Strength / Edge Mode
Fss	Fast	strong driver, sharp edge
Fsm	Fast	strong driver, medium edge
Fm	Fast	medium driver
Sms	Slow	medium driver, sharp edge
Sm	Slow	medium driver

Recommendation

From the tables above, following is the conclusion based on the measured V_{ILD} values for each pad in different configurations:

Table 36 Conclusion for SENT application usage

Symbol	Conclusion for SENT application usage
OK	V_{ILD} is below the standard threshold (100mV) and hence pin can be used in the mentioned configuration.
x	<p>V_{ILD} is above the standard threshold (100mV) and hence pin cannot be used in the mentioned configuration.</p> <p>Following are possible alternatives to use the SENT pad (marked as “OK” in the tables above):</p> <ul style="list-style-type: none"> • Configure the neighboring pads have to weaker edge mode / driver strength (Fsm or Fm instead of Fss), • Use SENT input with 2N neighbors instead of 4N.

SENT_TC.H007 Range for divider value DIV - Documentation correction

In section “Baud Rate Generation” and in the description of register CFDRx in the SENT chapter of the TC3xx User’s Manual, the range for the divider value DIV is documented as

- $DIV = [2200, 49100]$

The upper limit of this range is incorrect.

Documentation correction

The correct range that can be used for the divider value DIV is

- $DIV = [2200, 52428]$

SMU_TC.H010 Clearing individual SMU flags: use only 32-bit writes

The SMU registers shall only be written via 32-bit word accesses (i.e. ST.W instruction), as mentioned in table “Registers Overview” of the SMU chapter in the User’s Manual.

If any other instruction such as LDMST or SWAPMSK.W is used to modify only a few bits in the 32-bit register, then this may have the effect of modifying/clearing unintended bits.

Recommendation (Examples in C Language)

- **Example 1:** To clear status flag SF2 in register AG0, use:
 - `SMU_AG0.U = 0x0000 0004;`
- **Example 2:** To clear status flags EF2 in register RMEF and RMSTS, use:
 - `SMU_RMEF.U = 0xFFFF FFFB;`
 - `SMU_RMSTS.U = 0xFFFF FFFB;`

Here the `<REGISTER>.U` implies writing to the register as an unsigned integer, which normally results in a compiler translation into an `ST.W` instruction.

Safety Considerations

As long as software uses only 32-bit writes to the SMU registers, there is no risk of malfunction.

In case the software does not use 32-bit writes (and for example uses bit-wise operations such as LDMST instructions instead) – then potentially unintended flags may be written and modified in the SMU registers. Depending on the application, this may potentially have an impact on safety and/or diagnostics.

Note: The SMU reaction itself (e.g. alarm action triggering) is not affected even if the software unintentionally clears additional bits by not using a 32-bit write as recommended.

SMU_TC.H012 Handling of SMU alarms ALM7[1] and ALM7[0]

The FSI RAM is used to configure the PFLASH. For security related reason, the access to this RAM is restricted. Therefore, in order to avoid accesses to this RAM through its SSH, the MBIST Controller 40 is not disclosed in the AURIX TC3xx Target Specification/User's Manual.

However, the SMU alarms ALM7[1] and ALM7[0] are set intentionally after PORST and system reset and shall be cleared by the application SW (cf. ESM[SW]:SYS:MCU_FW_CHECK in Safety Manual v1.0).

Also, in order to clear the SMU alarms ALM7[1] and ALM7[0], it is necessary to clear the alarms within this MC40.

Recommendation

Therefore, the following register addresses have to be written to clear the FSI RAM Fault Status and ECC Detection Register:

MCi_FAULTSTS (i=40, 0xF00638F0) = (16-bit write) 0x0

MCi_ECCD (i=40, 0xF0063810) = (16-bit write) 0x0

SMU_TC.H013 Increased Fault Detection for SMU Bus Interface (SMU_CLC Register)

Transient faults can possibly affect the SMU_CLC register and lead to disabling the SMU_core. This unintended switching off of SMU_core cannot be detected if the FSP protocol is not used at all or used in FSP bi-stable mode.

Recommendation

In order to increase the capability of the microcontroller to detect such faults it is recommended to:

- **Option 1:** Use FSP Dynamic dual-rail or Time-switching protocol only, don't use FSP bi-stable protocol.
- **Option 2:** In case FSP protocol is not used at all or Recommendation Option 1 is not possible, the [Application SW] shall read periodically, once per FTTI, the SMU_CLC register to react on unintended disabled SMU.

SMU_TC.H015 Calculation of the minimum active fault state time TFSP_FS - Additional information

In Figure "Reference clocks for FSP timings" in the SMU chapter of the TC3xx User's Manual, the "&" symbol in the formula for the minimum active fault state time TFSP_FS designates "field concatenation":

TFSP_FS =

TSMU_FS *(SMU_FSP.TFSP_HIGH[] & SMU_FSP.TFSP_LOW [] + 1)

Note: Field TFSP_LOW is hardcoded to 0x3FFF in register SMU_FSP. So if SMU_FSP.TFSP_HIGH is 0x1, then SMU_FSP.TFSP_HIGH[] & SMU_FSP.TFSP_LOW[] = 0x7FFF.

SRI_TC.H001 Using LDMST and SWAPMSK.W instructions on SRI mapped Peripheral Registers (range 0xF800 0000-0xFFFF FFFF)

The LDMST and SWAPMSK.W instructions in the AURIX™ microcontrollers are intended to provide atomicity as well as bit-wise operations to a targeted memory location or peripheral register. They are also referred to as Read-Modify-Write (RMW) instructions.

The bit-manipulation functionality is intended to provide software a mechanism to write to individual bits in a register, without affecting other bits. The bits to be written can be selected via a mask in the instruction. Please refer to the TriCore Architecture Manual for further information about these instructions and their formats.

Restrictions for SRI mapped Peripherals

The bit-manipulation functionality is supported only on registers accessed via the SPB bus, and is not supported on the SRI mapped peripheral range (i.e. address range 0xF800 0000 to 0xFFFF FFFF, including (if available) DMU, LMU, EBU, DAM, SRI Crossbar, SPU, CPUx SFRs and CSFRs, AGBT, miniMCDS, ...); see table “On Chip Bus Address Map of Segment 15” in chapter “Memory Map”.

On the SRI mapped peripherals, usage of these instructions always results in all the bits of a register being written, and not just specific individual bits.

Note: The instructions are still executed atomically on the bus – i.e the SRI is locked between the READ and the WRITE transaction.

SSW_TC.H001 Security hardening measure for the startup behavior

In order to increase the robustness of the debug protection mechanism against malicious attacks, it is now strongly suggested to always apply another layer of protection in combination with it.

Recommendation

On top of the debug protection mechanism, enabled via UCB_DBG through the HF_PRONCONDBG.DBGIFLCK bit using a 256-bit password, user shall set the global PFLASH or DFLASH read protection.

Both protections can be enabled individually or together. It is not mandatory to set both protections at the same time.

In most cases PFLASH will be the preferred option since standard drivers for DFLASH (e.g. for EEPROM emulation) do not support DFLASH protection.

In order to enable the global PFLASH read protection, HF_PROCONPF.RPRO has to be set to 1 inside the UCB_PFLASH_ORIG/COPY.

In order to enable the global DFLASH read protection, HF_PROCONDF.RPRO has to be set to 1 inside the UCB_DFLASH_ORIG/COPY.

Be aware that the global read protection will apply also a write protection over the entire PFLASH or DFLASH memory respectively.

The enabled read protection is always effective for the startup hardening. For the Flash read access by CPUs it has only an effect in case the device is not booting from internal Flash.

In case a software update is needed, the write protection, inherited as side effect from the global read protection, can be temporarily disabled executing the "Disable Protection" command sequence.

The PFLASH write protection is also contained in the same UCB_PFLASH_ORIG/COPY, so this leads to have only one password (different from the Debug password) to disable write and read protection mechanisms at the same time.

If the user removes the global PFLASH read protection this will remove also the PFLASH write protection at the same time.

Same for the DFLASH write protection, which is included in the UCB_DFLASH_ORIG/COPY. Another single password is used to disable write and read protection over Data Flash 0 at the same time. Data Flash 1 and HSM PFLASH sectors are protected with another security mechanism via "exclusive protection".

The disabled protection is valid until the next reset or executing the "Resume Protection" command sequence.

For further details please refer to AP32399 “TC3xx debug protection (with HSM)” or to chapter “Non Volatile Memory (NVM) Subsystem” in the AURIX™ TC3xx User's Manual.

STM_TC.H004 Access to STM registers while STMDIV = 0

If accesses to STM kernel registers are performed while field STMDIV = 0_H in CCU Clock Control register CCUCON0 (i.e. clock f_{STM} is stopped),

- the SPB bus gets locked after the first access until a timeout (defined in BCU Control register field SBCU_CON.TOUT) occurs;
- after the second access the STM slave will answer with RTY (retry) until the STM is clocked again with STMDIV > 0_H.

Recommendation

Do not access any STM kernel register while CCUCON0.STMDIV = 0_H.